SPANSION™ Flash Memory

Data Sheet

September 2003

This document specifies SPANSION™ memory products that are now offered by both Advanced Micro Devices and Fujitsu. Although the document is marked with the name of the company that originally developed the specification, these products will be offered to customers of both AMD and Fujitsu.

Continuity of Specifications

There is no change to this datasheet as a result of offering the device as a SPANSION™ product. Future routine revisions will occur when appropriate, and changes will be noted in a revision summary.

Continuity of Ordering Part Numbers

AMD and Fujitsu continue to support existing part numbers beginning with "Am" and "MBM". To order these products, please use only the Ordering Part Numbers listed in this document.

For More Information

Please contact your local AMD or Fujitsu sales office for additional information about SPANSION™ memory solutions.

FLASH MEMORY

CMOS

16M (2M × 8/1M × 16) BIT Dual Operation

MBM29DL16XTE/BE70/90

■ FEATURES

- **0.23 μm Process Technology**
- **Simultaneous Read/Write operations (dual bank)**
  Multiple devices available with different bank sizes
  (Refer to "MBM29DL16XTE/BE Device Bank Divisions Table" in ■GENERAL DESCRIPTION)
  Host system can program or erase in one bank, then immediately and simultaneously read from the other bank
  Zero latency between read and write operations
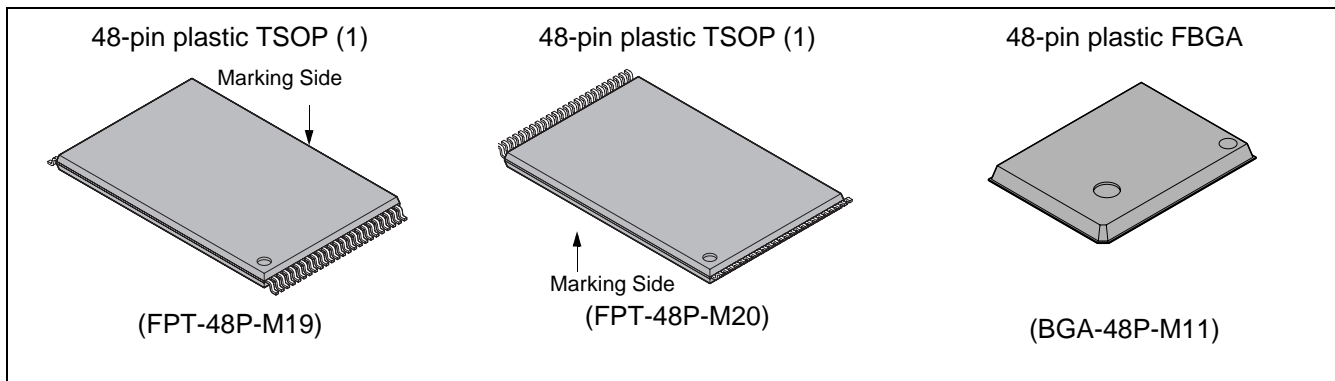 Read-while-erase
  Read-while-program

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■ PRODUCT LINE UP

Part No.	MBM29DL16XTE/BE70	MBM29DL16XTE/BE90
Address Access Time (Max)	70 ns	90 ns
$\overline{CE}$ Access Time (Max)	70 ns	90 ns
$\overline{OE}$ Access Time (Max)	30 ns	35 ns
Power Supply Voltage	3.0 V $^{+0.6 V}_{-0.3 V}$	

■ PACKAGES

48-pin plastic TSOP (1)

Marking Side

(FPT-48P-M19)

48-pin plastic TSOP (1)

Marking Side

(FPT-48P-M20)

48-pin plastic FBGA

(BGA-48P-M11)

FUJITSU

(Continued)

- **Single 3.0 V read, program, and erase**
  Minimizes system level power requirements
- **Compatible with JEDEC-standard commands**
  Uses same software commands as E²PROMs
- **Compatible with JEDEC-standard world-wide pinouts**
  48-pin TSOP(1) (Package suffix: TN – Normal Bend Type, TR – Reversed Bend Type)
  48-pin FBGA (Package suffix: PBT)
- **Minimum 100,000 program/erase cycles**
- **High performance**
  70 ns maximum access time
- **Sector erase architecture**
  Eight 4K word and thirty one 32K word sectors in word mode
  Eight 8K byte and thirty one 64K byte sectors in byte mode
  Any combination of sectors can be concurrently erased. Also supports full chip erase.
- **Boot Code Sector Architecture**
  T = Top sector
  B = Bottom sector
- **HiddenROM region**
  64K byte of HiddenROM, accessible through a new "HiddenROM Enable" command sequence
  Factory serialized and protected to provide a secure electronic serial number (ESN)
- **$\overline{\text{WP}}$/ACC input pin**
  At V_{IL}, allows protection of boot sectors, regardless of sector group protection/unprotection status
  At V_{ACC}, increases program performance
- **Embedded Erase™* Algorithms**
  Automatically pre-programs and erases the chip or any sector
- **Embedded Program™* Algorithms**
  Automatically writes and verifies data at specified address
- **$\overline{\text{Data}}$ Polling and Toggle Bit feature for detection of program or erase cycle completion**
- **Ready/Busy output (RY/$\overline{\text{BY}}$)**
  Hardware method for detection of program or erase cycle completion
- **Automatic sleep mode**
  When addresses remain stable, automatically switch themselves to low power mode.
- **Low V$_{CC}$ write inhibit $\leq$ 2.5 V**
- **Program Suspend/Resume**
  Suspends the program operation to allow a read in another sector with in the same device
- **Erase Suspend/Resume**
  Suspends the erase operation to allow a read data and/or program in another sector within the same device
- **Sector group protection**
  Hardware method disables any combination of sector groups from program or erase operations
- **Sector Group Protection Set function by Extended sector group protection command**
- **Fast Programming Function by Extended Command**
- **Temporary sector group unprotection**
  Temporary sector group unprotection via the $\overline{\text{RESET}}$ pin.
- **In accordance with CFI (Common Flash Memory Interface)**

*: Embedded Erase™ and Embedded Program™ are trademarks of Advanced Micro Devices, Inc.

■ GENERAL DESCRIPTION

The MBM29DL16XTE/BE are a 16M-bit, 3.0 V-only Flash memory organized as 2M bytes of 8 bits each or 1M words of 16 bits each. The MBM29DL16XTE/BE are offered in a 48-pin TSOP(1) and 48-pin FBGA Package. These devices are designed to be programmed in-system with the standard system 3.0 V V_{CC} supply. 12.0 V V_{PP} and 5.0 V V_{CC} are not required for write or erase operations. The devices can also be reprogrammed in standard EPROM programmers.

MBM29DL16XTE/BE are organized into two banks, Bank 1 and Bank 2, which are considered to be two separate memory arrays for operations. It is the Fujitsu's standard 3 V only Flash memories with the additional capability of allowing a normal non-delayed read access from a non-busy bank of the array while an embedded write (either a program or an erase) operation is simultaneously taking place on the other bank.

In the MBM29DL16XTE/BE, a new design concept is implemented, so called "Sliding Bank Architecture". Under this concept, the MBM29DL16XTE/BE can be produced a series of devices with different Bank 1/Bank 2 size combinations; 0.5 Mb/15.5 Mb, 2 Mb/14 Mb, 4 Mb/12 Mb, 8 Mb/8 Mb.

The standard MBM29DL16XTE/BE offer access times 70 ns and 90 ns, allowing operation of high-speed microprocessors without wait states. To eliminate bus contention the devices have separate chip enable ($\overline{CE}$), write enable ($\overline{WE}$), and output enable ($\overline{OE}$) controls.

The MBM29DL16XTE/BE are pin and command set compatible with JEDEC standard E^{2}PROMs. Commands are written to the command register using standard microprocessor write timings. Register contents serve as input to an internal state-machine which controls the erase and programming circuitry. Write cycles also internally latch addresses and data needed for the programming and erase operations. Reading data out of the devices is similar to reading from 5.0 V and 12.0 V Flash or EPROM devices.

The MBM29DL16XTE/BE are programmed by executing the program command sequence. This will invoke the Embedded Program Algorithm which is an internal algorithm that automatically times the program pulse widths and verifies proper cell margin. Typically, each sector can be programmed and verified in about 0.5 seconds. Erase is accomplished by executing the erase command sequence. This will invoke the Embedded Erase Algorithm which is an internal algorithm that automatically preprograms the array if it is not already programmed before executing the erase operation. During erase, the devices automatically time the erase pulse widths and verify proper cell margin.

A sector is typically erased and verified in 1.0 second. (If already completely preprogrammed.)

The devices also feature a sector erase architecture. The sector mode allows each sector to be erased and reprogrammed without affecting other sectors. The MBM29DL16XTE/BE are erased when shipped from the factory.

The devices feature single 3.0 V power supply operation for both read and write functions. Internally generated and regulated voltages are provided for the program and erase operations. A low V_{CC} detector automatically inhibits write operations on the loss of power. The end of program or erase is detected by $\overline{Data}$ Polling of DQ$_7$, by the Toggle Bit feature on DQ$_6$, or the RY/$\overline{BY}$ output pin. Once the end of a program or erase cycle has been completed, the devices internally reset to the read mode.

Fujitsu's Flash technology combines years of EPROM and E^{2}PROM experience to produce the highest levels of quality, reliability, and cost effectiveness. The MBM29DL16XTE/BE memories electrically erase the entire chip or all bits within a sector simultaneously via Fowler-Nordhiem tunneling. The bytes/words are programmed one byte/word at a time using the EPROM programming mechanism of hot electron injection.

MBM29DL16XTE/BE Device Bank Divisions Table

Device Part Number	Organization	Bank 1		Bank 2	
		Megabits	Sector Sizes	Megabits	Sector Sizes
MBM29DL161TE/BE	$\times 8/\times 16$	0.5 Mbit	Eight 8K byte/4K word	15.5 Mbit	Thirty-one 64K byte/32K word
MBM29DL162TE/BE		2 Mbit	Eight 8K byte/4K word, three 64K byte/32K word	14 Mbit	Twenty-eight 64K byte/32K word
MBM29DL163TE/BE		4 Mbit	Eight 8K byte/4K word, seven 64K byte/32K word	12 Mbit	Twenty-four 64K byte/32K word
MBM29DL164TE/BE		8 Mbit	Eight 8K byte/4K word, fifteen 64K byte/32K word	8 Mbit	Sixteen 64K byte/32K word

■ PIN ASSIGNMENTS

TSOP(1)

(Marking Side)

Normal Bend

Left side pins (1–24):

Pin	Signal
1	A_{15}
2	A_{14}
3	A_{13}
4	A_{12}
5	A_{11}
6	A_{10}
7	A_9
8	A_8
9	A_{19}
10	N.C.
11	$\overline{WE}$
12	$\overline{RESET}$
13	N.C.
14	$\overline{WP}/ACC$
15	$RY/\overline{BY}$
16	A_{18}
17	A_{17}
18	A_7
19	A_6
20	A_5
21	A_4
22	A_3
23	A_2
24	A_1

Right side pins (48–25):

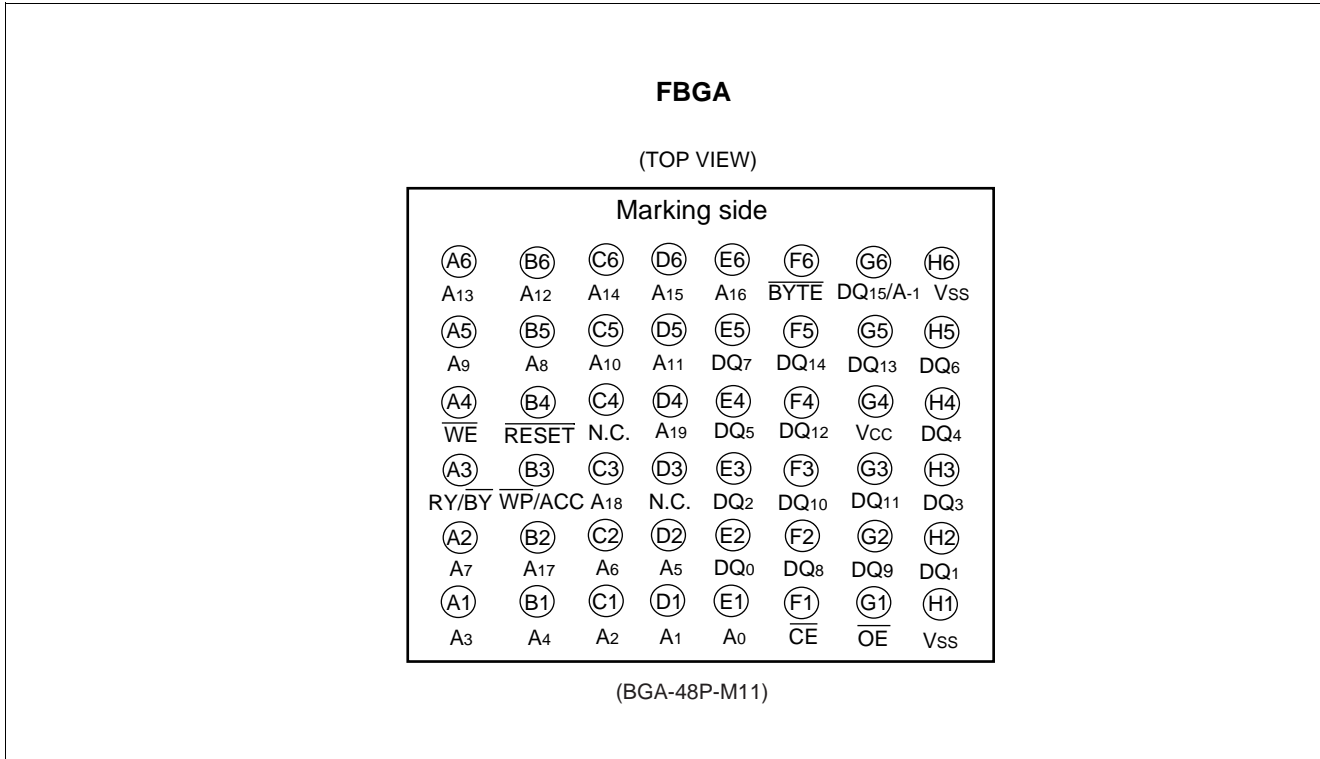| Pin	Signal
48	A_{16}
47	$\overline{BYTE}$
46	V_{SS}
45	DQ_{15}/A_{-1}
44	DQ_7
43	DQ_{14}
42	DQ_6
41	DQ_{13}
40	DQ_5
39	DQ_{12}
38	DQ_4
37	V_{CC}
36	DQ_{11}
35	DQ_3
34	DQ_{10}
33	DQ_2
32	DQ_9
31	DQ_1
30	DQ_8
29	DQ_0
28	$\overline{OE}$
27	V_{SS}
26	$\overline{CE}$
25	A_0

(FPT-48P-M19)

(Marking Side)

Reverse Bend

Left side pins (24–1):

Pin	Signal
24	A_1
23	A_2
22	A_3
21	A_4
20	A_5
19	A_6
18	A_7
17	A_{17}
16	A_{18}
15	$RY/\overline{BY}$
14	$\overline{WP}/ACC$
13	N.C.
12	$\overline{RESET}$
11	$\overline{WE}$
10	N.C.
9	A_{19}
8	A_8
7	A_9
6	A_{10}
5	A_{11}
4	A_{12}
3	A_{13}
2	A_{14}
1	A_{15}

Right side pins (25–48):

Pin	Signal
25	A_0
26	$\overline{CE}$
27	V_{SS}
28	$\overline{OE}$
29	DQ_0
30	DQ_8
31	DQ_1
32	DQ_9
33	DQ_2
34	DQ_{10}
35	DQ_3
36	DQ_{11}
37	V_{CC}
38	DQ_4
39	DQ_{12}
40	DQ_5
41	DQ_{13}
42	DQ_6
43	DQ_{14}
44	DQ_7
45	DQ_{15}/A_{-1}
46	V_{SS}
47	$\overline{BYTE}$
48	A_{16}

(FPT-48P-M20)

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FBGA

(TOP VIEW)

Marking side

(A6) A$_{13}$	(B6) A$_{12}$	(C6) A$_{14}$	(D6) A$_{15}$	(E6) A$_{16}$	(F6) $\overline{BYTE}$	(G6) DQ$_{15}$/A$_{-1}$	(H6) V$_{SS}$
(A5) A$_9$	(B5) A$_8$	(C5) A$_{10}$	(D5) A$_{11}$	(E5) DQ$_7$	(F5) DQ$_{14}$	(G5) DQ$_{13}$	(H5) DQ$_6$
(A4) $\overline{WE}$	(B4) $\overline{RESET}$	(C4) N.C.	(D4) A$_{19}$	(E4) DQ$_5$	(F4) DQ$_{12}$	(G4) V$_{CC}$	(H4) DQ$_4$
(A3) RY/$\overline{BY}$	(B3) $\overline{WP}$/ACC	(C3) A$_{18}$	(D3) N.C.	(E3) DQ$_2$	(F3) DQ$_{10}$	(G3) DQ$_{11}$	(H3) DQ$_3$
(A2) A$_7$	(B2) A$_{17}$	(C2) A$_6$	(D2) A$_5$	(E2) DQ$_0$	(F2) DQ$_8$	(G2) DQ$_9$	(H2) DQ$_1$
(A1) A$_3$	(B1) A$_4$	(C1) A$_2$	(D1) A$_1$	(E1) A$_0$	(F1) $\overline{CE}$	(G1) $\overline{OE}$	(H1) V$_{SS}$

(BGA-48P-M11)

■ PIN DESCRIPTIONS

Pin Name	Function	Pin Name	Function
A$_{19}$ to A$_0$, A$_{-1}$	Address Input	RY/$\overline{BY}$	Ready/Busy Output
DQ$_{15}$ to DQ$_0$	Data Input/Output	$\overline{BYTE}$	Selects 8-bit or 16-bit mode
$\overline{CE}$	Chip Enable	$\overline{WP}$/ACC	Hardware Write Protection/ Program Acceleration
$\overline{OE}$	Output Enable	V$_{SS}$	Device Ground
$\overline{WE}$	Write Enable	V$_{CC}$	Device Power Supply
$\overline{RESET}$	Hardware Reset Pin/ Temporary Sector Group Unprotection	N.C.	No Internal Connection

■ BLOCK DIAGRAM
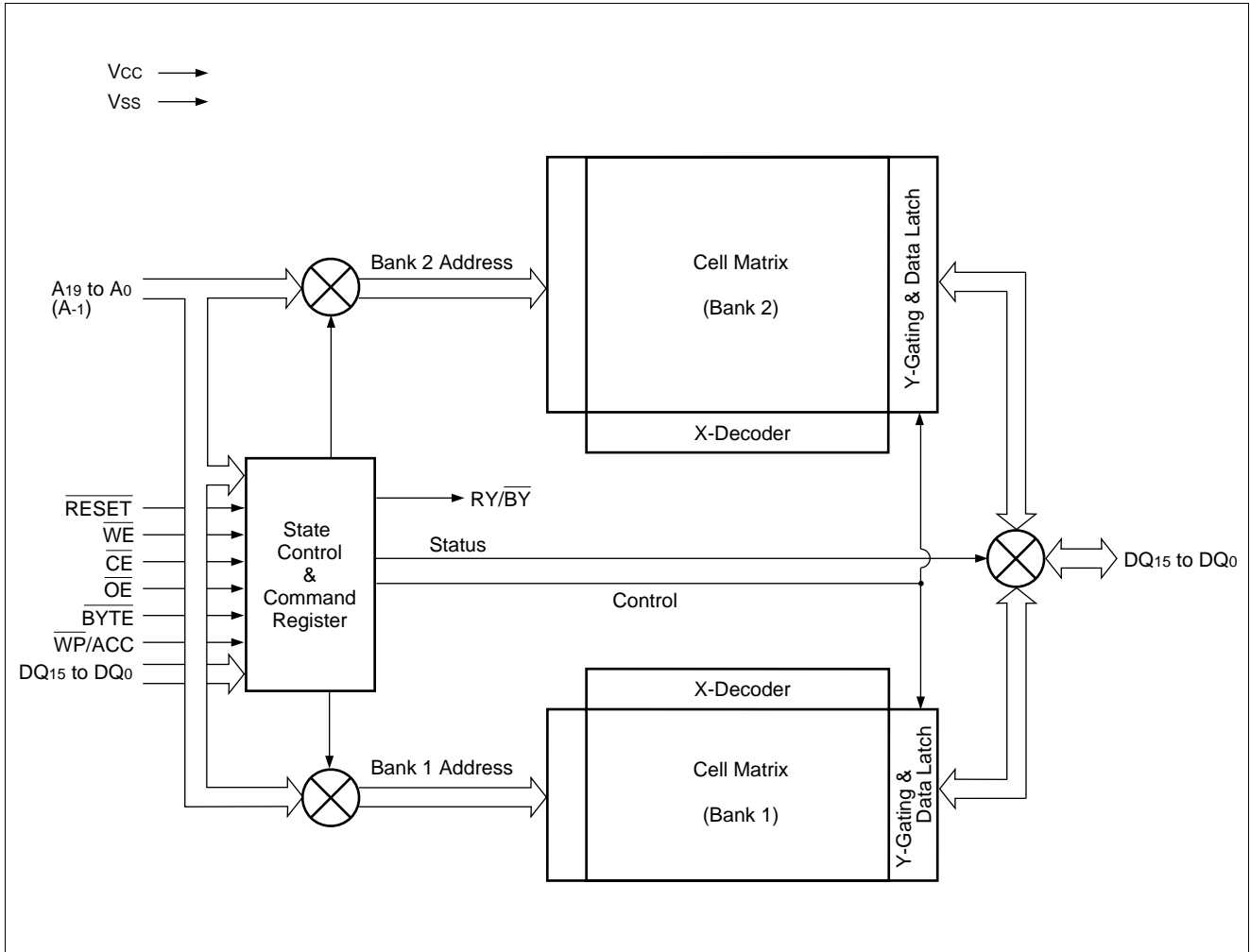
■ LOGIC SYMBOL
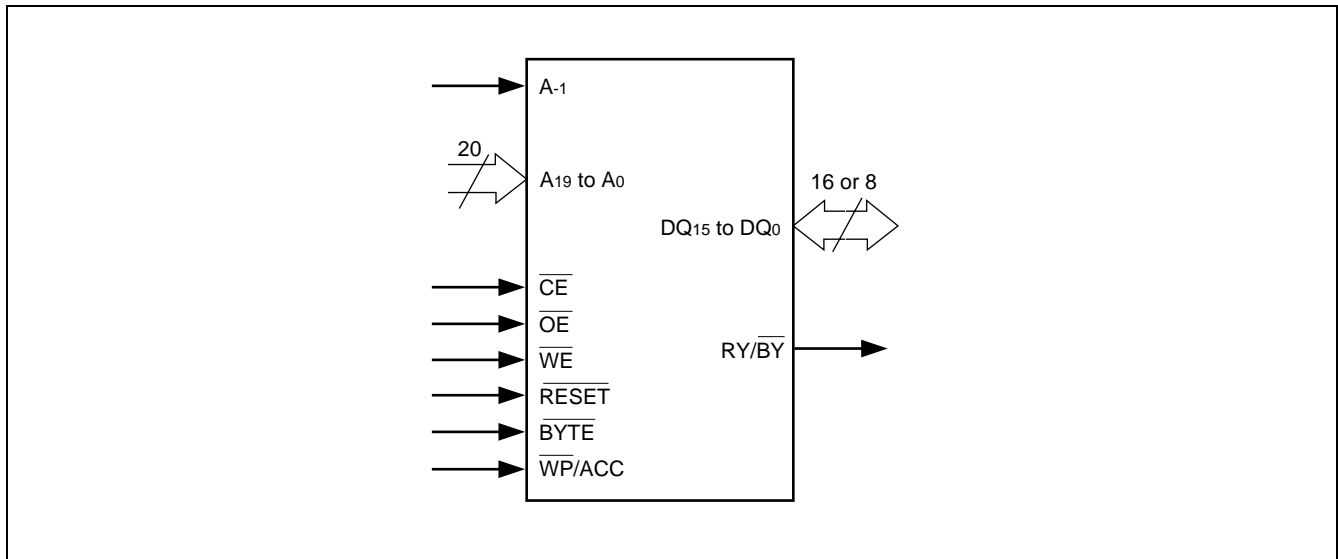
■ DEVICE BUS OPERATION

MBM29DL16XTE/BE User Bus Operations Table ($\overline{BYTE}$ = V_{IH})

Operation	$\overline{CE}$	$\overline{OE}$	$\overline{WE}$	A_0	A_1	A_6	A_9	DQ_{15} to DQ_0	$\overline{RESET}$	$\overline{WP}/ACC$
Auto-Select Manufacturer Code*[1]	L	L	H	L	L	L	V_{ID}	Code	H	X
Auto-Select Device Code*[1]	L	L	H	H	L	L	V_{ID}	Code	H	X
Read*[3]	L	L	H	A_0	A_1	A_6	A_9	D_{OUT}	H	X
Standby	H	X	X	X	X	X	X	High-Z	H	X
Output Disable	L	H	H	X	X	X	X	High-Z	H	X
Write (Program/Erase)	L	H	L	A_0	A_1	A_6	A_9	D_{IN}	H	X
Enable Sector Group Protection*[2], *[4]	L	V_{ID}	⌐_	L	H	L	V_{ID}	X	H	X
Verify Sector Group Protection*[2], *[4]	L	L	H	L	H	L	V_{ID}	Code	H	X
Temporary Sector Group Unprotection*[5]	X	X	X	X	X	X	X	X	V_{ID}	X
Reset (Hardware) / Standby	X	X	X	X	X	X	X	High-Z	L	X
Boot Block Sector Write Protection	X	X	X	X	X	X	X	X	X	L

Legend: L = V_{IL}, H = V_{IH}, X = V_{IL} or V_{IH}, ⌐_ = Pulse input. See ■DC CHARACTERISTICS for voltage levels.

*1: Manufacturer and device codes are accessed via a command register write sequence. See "MBM29DL16XTE/
   BE Command Definitions Table".
*2: Refer to "Sector Group Protection" in ■FUNCTIONAL DESCRIPTION.
*3: $\overline{WE}$ can be V_{IL} if $\overline{OE}$ is V_{IL}, $\overline{OE}$ at V_{IH} initiates the write operations.
*4: V_{CC} = +2.7 V to +3.6 V
*5: Also used for the extended sector group protection.

MBM29DL16XTE/BE User Bus Operations Table ($\overline{BYTE}$ = V_{IL})

Operation	$\overline{CE}$	$\overline{OE}$	$\overline{WE}$	DQ_{15}/A_{-1}	A_0	A_1	A_6	A_9	DQ_7 to DQ_0	$\overline{RESET}$	$\overline{WP}/ACC$
Auto-Select Manufacturer Code*[1]	L	L	H	L	L	L	L	V_{ID}	Code	H	X
Auto-Select Device Code*[1]	L	L	H	L	H	L	L	V_{ID}	Code	H	X
Read*[3]	L	L	H	A_{-1}	A_0	A_1	A_6	A_9	D_{OUT}	H	X
Standby	H	X	X	X	X	X	X	X	High-Z	H	X
Output Disable	L	H	H	X	X	X	X	X	High-Z	H	X
Write (Program/Erase)	L	H	L	A_{-1}	A_0	A_1	A_6	A_9	D_{IN}	H	X
Enable Sector Group Protection*[2], *[4]	L	V_{ID}	⌐_	L	L	H	L	V_{ID}	X	H	X
Verify Sector Group Protection*[2], *[4]	L	L	H	L	L	H	L	V_{ID}	Code	H	X
Temporary Sector Group Unprotection*[5]	X	X	X	X	X	X	X	X	X	V_{ID}	X
Reset (Hardware) / Standby	X	X	X	X	X	X	X	X	High-Z	L	X
Boot Block Sector Write Protection	X	X	X	X	X	X	X	X	X	X	L

Legend: L = V_{IL}, H = V_{IH}, X = V_{IL} or V_{IH}, ⌐_ = Pulse input. See ■DC CHARACTERISTICS for voltage levels.

*1: Manufacturer and device codes are accessed via a command register write sequence. See "MBM29DL16XTE/
   BE Command Definitions Table".
*2: Refer to "Sector Group Protection" in ■FUNCTIONAL DESCRIPTION.
*3: $\overline{WE}$ can be V_{IL} if $\overline{OE}$ is V_{IL}, $\overline{OE}$ at V_{IH} initiates the write operations.
*4: V_{CC} = +2.7 V to +3.6 V
*5: Also used for the extended sector group protection.

MBM29DL16XTE/BE Command Definitions Table

Command Sequence		Bus Write Cycles Req'd	First Bus Write Cycle Addr.	Data	Second Bus Write Cycle Addr.	Data	Third Bus Write Cycle Addr.	Data	Fourth Bus Read/Write Cycle Addr.	Data	Fifth Bus Write Cycle Addr.	Data	Sixth Bus Write Cycle Addr.	Data
Read/Reset*1	Word	1	XXXh	F0h	—	—	—	—	—	—	—	—	—	—
	Byte													
Read/Reset*1	Word	3	555h	AAh	2AAh	55h	555h	F0h	RA*7	RD*7	—	—	—	—
	Byte		AAAh		555h		AAAh							
Autoselect	Word	3	555h	AAh	2AAh	55h	(BA)555h	90h	IA*7	ID*7	—	—	—	—
	Byte		AAAh		555h		(BA)AAAh							
Program	Word	4	555h	AAh	2AAh	55h	555h	A0h	PA	PD	—	—	—	—
	Byte		AAAh		555h		AAAh							
Program Suspend		1	BA	B0h	—	—	—	—	—	—	—	—	—	—
Program Resume		1	BA	30h	—	—	—	—	—	—	—	—	—	—
Chip Erase	Word	6	555h	AAh	2AAh	55h	555h	80h	555h	AAh	2AAh	55h	555h	10h
	Byte		AAAh		555h		AAAh		AAAh		555h		AAAh	
Sector Erase	Word	6	555h	AAh	2AAh	55h	555h	80h	555h	AAh	2AAh	55h	SA	30h
	Byte		AAAh		555h		AAAh		AAAh		555h			
Erase Suspend		1	BA	B0h	—	—	—	—	—	—	—	—	—	—
Erase Resume		1	BA	30h	—	—	—	—	—	—	—	—	—	—
Set to Fast Mode	Word	3	555h	AAh	2AAh	55h	555h	20h	—	—	—	—	—	—
	Byte		AAAh		555h		AAAh							
Fast Program*2	Word	2	XXXh	A0h	PA	PD	—	—	—	—	—	—	—	—
	Byte													
Reset from Fast Mode*2	Word	2	BA	90h	XXXh	*6 F0h	—	—	—	—	—	—	—	—
	Byte													
Extended Sector Group Protection*3	Word	3	XXXh	60h	SPA	60h	SPA	40h	SPA*7	SD*7	—	—	—	—
	Byte													
Query *4	Word	1	(BA)55h	98h	—	—	—	—	—	—	—	—	—	—
	Byte		(BA)AAh											
HiddenROM Entry	Word	3	555h	AAh	2AAh	55h	555h	88h	—	—	—	—	—	—
	Byte		AAAh		555h		AAAh							
HiddenROM Program*5	Word	4	555h	AAh	2AAh	55h	555h	A0h	PA (HRA)	PD	—	—	—	—
	Byte		AAAh		555h		AAAh							
HiddenROM Erase*5	Word	6	555h	AAh	2AAh	55h	555h	80h	555h	AAh	2AAh	55h	HRA	30h
	Byte		AAAh		555h		AAAh		AAAh		555h			
HiddenROM Exit*5	Word	4	555h	AAh	2AAh	55h	(HRBA)555h	90h	XXXh	00h	—	—	—	—
	Byte		AAAh		555h		(HRBA)AAAh							

Notes:
- Address bits A_{19} to A_{11} = X = "H" or "L" for all address commands except or Program Address (PA), Sector Address (SA), and Bank Address (BA).
- Bus operations are defined in "MBM29DL16XTE/BE User Bus Operations Tables ($\overline{BYTE}$ = V_{IH} and $\overline{BYTE}$ = V_{IL})".
- RA: Address of the memory location to be read

  IA : Autoselect read address that sets both the bank address specified at (A_{19}, A_{18}, A_{17}, A_{16}, A_{15}) and all the other A_6, A_1, A_0, (A_{-1}).

  PA: Address of the memory location to be programmed

  Addresses are latched on the falling edge of the write pulse.

  SA: Address of the sector to be erased. The combination of A_{19}, A_{18}, A_{17}, A_{16}, A_{15}, A_{14}, A_{13}, and A_{12} will uniquely select any sector.

  BA: Bank Address (A_{19} to A_{15})
- RD: Data read from location RA during read operation.

  ID : Device code/manufacture code for the address located by IA.

  PD: Data to be programmed at location PA. Data is latched on the rising edge of write pulse.
- SPA: Sector group address to be protected. Set sector group address (SGA) and (A_6, A_1, A_0) = (0, 1, 0).

  SD: Sector group protection verify data. Output 01h at protected sector group addresses and output 00h at unprotected sector group addresses.
- HRA: Address of the HiddenROM area

  29DL16XTE (Top Boot Type) Word Mode: 0F8000h to 0FFFFFh

  Byte Mode: 1F0000h to 1FFFFFh

  29DL16XBE (Bottom Boot Type) Word Mode: 000000h to 007FFFh

  Byte Mode: 000000h to 00FFFFh
- HRBA: Bank Address of the HiddenROM area

  29DL16XTE (Top Boot Type) :A_{19} = A_{18}= A_{17} = A_{16} = A_{15} = V_{IH}

  29DL16XBE (Bottom Boot Type) :A_{19} = A_{18}= A_{17} = A_{16} = A_{15} = V_{IL}
- The system should generate the following address patterns:

  Word Mode: 555h or 2AAh to addresses A_{10} to A_0

  Byte Mode: AAAh or 555h to addresses A_{10} to A_0 and A_{-1}
- Both Read/Reset commands are functionally equivalent, resetting the device to the read mode.
- Command combinations not described in Command Definitions table are illegal.

*1: Both of these reset commands are equivalent.

*2: This command is valid during Fast Mode.

*3: This command is valid while $\overline{RESET}$ = V_{ID} (except during HiddenROM MODE).

*4: The valid addresses are A_6 to A_0.

*5: This command is valid during HiddenROM mode.

*6: The data "00h" is also acceptable.

*7: The fourth bus cycle is only for read.

MBM29DL161TE/BE Sector Group Protection Verify Autoselect Codes Table

Type		A_{19} to A_{12}	A_6	A_1	A_0	A_{-1}*1	Code (HEX)
Manufacture's Code	Byte	BA*3	V_{IL}	V_{IL}	V_{IL}	V_{IL}	04h
	Word					X	0004h
Device Code — MBM29DL161TE	Byte	BA*3	V_{IL}	V_{IL}	V_{IH}	V_{IL}	36h
	Word					X	2236h
Device Code — MBM29DL161BE	Byte	BA*3	V_{IL}	V_{IL}	V_{IH}	V_{IL}	39h
	Word					X	2239h
Sector Group Protection	Byte	Sector Group Addresses	V_{IL}	V_{IH}	V_{IL}	V_{IL}	01h*2
	Word					X	0001h*2

*1: A_{-1} is for Byte mode. At Byte mode, DQ_{14} to DQ_8 are High-Z and DQ_{15} is A_{-1}, the lowest address.

*2: Outputs 01h at protected sector group addresses and outputs 00h at unprotected sector group addresses.

*3: When V_{ID} is applied to A_9, both Bank1 and Bank2 are put into Autoselect mode, which makes simultaneous operation unable to be executed. Consequently, specifying the bank address is not required. However, the bank address needs to be indicated when Autoselect mode is read out at command mode, because then it enables to activate simultaneous operation.

Extended Autoselect Code Table

Type		Code	DQ_{15}	DQ_{14}	DQ_{13}	DQ_{12}	DQ_{11}	DQ_{10}	DQ_9	DQ_8	DQ_7	DQ_6	DQ_5	DQ_4	DQ_3	DQ_2	DQ_1	DQ_0
Manufacturer's Code	(B)*	04h	A_{-1}	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	0	0	0	0	0	1	0	0
	(W)	0004h	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0
Device Code — MBM29DL161TE	(B)*	36h	A_{-1}	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	0	0	1	1	0	1	1	0
	(W)	2236h	0	0	1	0	0	0	1	0	0	0	1	1	0	1	1	0
Device Code — MBM29DL161BE	(B)*	39h	A_{-1}	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	0	0	1	1	1	0	0	1
	(W)	2239h	0	0	1	0	0	0	1	0	0	0	1	1	1	0	0	1
Sector Group Protection	(B)*	01h	A_{-1}	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	0	0	0	0	0	0	0	1
	(W)	0001h	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1

(B) : Byte mode
(W) : Word mode
HI-Z : High-Z

*: At Byte mode, DQ_{14} to DQ_8 are High-Z and DQ_{15} is A_{-1}, the lowest address.

MBM29DL162TE/BE Sector Group Protection Verify Autoselect Codes Table

Type		A$_{19}$ to A$_{12}$	A$_6$	A$_1$	A$_0$	A$_{-1}$*1	Code (HEX)
Manufacture's Code	Byte	BA*3	V$_{IL}$	V$_{IL}$	V$_{IL}$	V$_{IL}$	04h
	Word					X	0004h
Device Code	MBM29DL162TE Byte	BA*3	V$_{IL}$	V$_{IL}$	V$_{IH}$	V$_{IL}$	2Dh
	MBM29DL162TE Word					X	222Dh
	MBM29DL162BE Byte	BA*3	V$_{IL}$	V$_{IL}$	V$_{IH}$	V$_{IL}$	2Eh
	MBM29DL162BE Word					X	222Eh
Sector Group Protection	Byte	Sector Group Addresses	V$_{IL}$	V$_{IH}$	V$_{IL}$	V$_{IL}$	01h*2
	Word					X	0001h*2

*1 : A$_{-1}$ is for Byte mode. At Byte mode, DQ$_{14}$ to DQ$_8$ are High-Z and DQ$_{15}$ is A$_{-1}$, the lowest address.

*2 : Outputs 01h at protected sector group addresses and outputs 00h at unprotected sector group addresses.

*3 : When V$_{ID}$ is applied to A$_9$, both Bank 1 and Bank 2 are put into Autoselect mode, which makes simultaneous operation unable to be executed. Consequently, specifying the bank address is not required. However, the bank address needs to be indicated when Autoselect mode is read out at command mode, because then it enables to activate simultaneous operation.

Extended Autoselect Code Table

Type		Code	DQ$_{15}$	DQ$_{14}$	DQ$_{13}$	DQ$_{12}$	DQ$_{11}$	DQ$_{10}$	DQ$_9$	DQ$_8$	DQ$_7$	DQ$_6$	DQ$_5$	DQ$_4$	DQ$_3$	DQ$_2$	DQ$_1$	DQ$_0$
Manufacturer's Code	(B)*	04h	A$_{-1}$	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	0	0	0	0	0	1	0	0
	(W)	0004h	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0
Device Code	MBM29DL162TE (B)*	2Dh	A$_{-1}$	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	0	0	1	0	1	1	0	1
	MBM29DL162TE (W)	222Dh	0	0	1	0	0	0	1	0	0	0	1	0	1	1	0	1
	MBM29DL162BE (B)*	2Eh	A$_{-1}$	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	0	0	1	0	1	1	1	0
	MBM29DL162BE (W)	222Eh	0	0	1	0	0	0	1	0	0	0	1	0	1	1	1	0
Sector Group Protection	(B)*	01h	A$_{-1}$	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	0	0	0	0	0	0	0	1
	(W)	0001h	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1

(B) : Byte mode
(W) : Word mode
HI-Z : High-Z

* : At Byte mode, DQ$_{14}$ to DQ$_8$ are High-Z and DQ$_{15}$ is A$_{-1}$, the lowest address.

MBM29DL163TE/BE Sector Group Protection Verify Autoselect Codes Table

Type		A_{19} to A_{12}	A_6	A_1	A_0	A_{-1}[1]	Code (HEX)
Manufacture's Code	Byte	BA[3]	V_{IL}	V_{IL}	V_{IL}	V_{IL}	04h
	Word	BA[3]	V_{IL}	V_{IL}	V_{IL}	X	0004h
Device Code — MBM29DL163TE	Byte	BA[3]	V_{IL}	V_{IL}	V_{IH}	V_{IL}	28h
	Word	BA[3]	V_{IL}	V_{IL}	V_{IH}	X	2228h
Device Code — MBM29DL163BE	Byte	BA[3]	V_{IL}	V_{IL}	V_{IH}	V_{IL}	2Bh
	Word	BA[3]	V_{IL}	V_{IL}	V_{IH}	X	222Bh
Sector Group Protection	Byte	Sector Group Addresses	V_{IL}	V_{IH}	V_{IL}	V_{IL}	01h[2]
	Word	Sector Group Addresses	V_{IL}	V_{IH}	V_{IL}	X	0001h[2]

[1] : A_{-1} is for Byte mode. At Byte mode, DQ_{14} to DQ_8 are High-Z and DQ_{15} is A_{-1}, the lowest address.

[2] : Outputs 01h at protected sector group addresses and outputs 00h at unprotected sector group addresses.

[3] : When V_{ID} is applied to A_9, both Bank 1 and Bank 2 are put into Autoselect mode, which makes simultaneous operation unable to be executed. Consequently, specifying the bank address is not required. However, the bank address needs to be indicated when Autoselect mode is read out at command mode, because then it enables to activate simultaneous operation.

Extended Autoselect Code Table

Type		Code	DQ_{15}	DQ_{14}	DQ_{13}	DQ_{12}	DQ_{11}	DQ_{10}	DQ_9	DQ_8	DQ_7	DQ_6	DQ_5	DQ_4	DQ_3	DQ_2	DQ_1	DQ_0
Manufacturer's Code	(B)*	04h	A_{-1}	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	0	0	0	0	0	1	0	0
	(W)	0004h	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0
Device Code — MBM29DL163TE	(B)*	28h	A_{-1}	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	0	0	1	0	1	0	0	0
	(W)	2228h	0	0	1	0	0	0	1	0	0	0	1	0	1	0	0	0
Device Code — MBM29DL163BE	(B)*	2Bh	A_{-1}	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	0	0	1	0	1	0	1	1
	(W)	222Bh	0	0	1	0	0	0	1	0	0	0	1	0	1	0	1	1
Sector Group Protection	(B)*	01h	A_{-1}	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	0	0	0	0	0	0	0	1
	(W)	0001h	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1

(B)   : Byte mode
(W)   : Word mode
HI-Z : High-Z

* : At Byte mode, DQ_{14} to DQ_8 are High-Z and DQ_{15} is A_{-1}, the lowest address.

MBM29DL164TE/BE Sector Group Protection Verify Autoselect Codes Table

Type			A_{19} to A_{12}	A_6	A_1	A_0	A_{-1}*1	Code (HEX)
Manufacture's Code		Byte	BA*3	V_{IL}	V_{IL}	V_{IL}	V_{IL}	04h
		Word					X	0004h
Device Code	MBM29DL164TE	Byte	BA*3	V_{IL}	V_{IL}	V_{IH}	V_{IL}	33h
		Word					X	2233h
	MBM29DL164BE	Byte	BA*3	V_{IL}	V_{IL}	V_{IH}	V_{IL}	35h
		Word					X	2235h
Sector Group Protection		Byte	Sector Group Addresses	V_{IL}	V_{IH}	V_{IL}	V_{IL}	01h*2
		Word					X	0001h*2

*1 : A_{-1} is for Byte mode. At Byte mode, DQ_{14} to DQ_8 are High-Z and DQ_{15} is A_{-1}, the lowest address.

*2 : Outputs 01h at protected sector group addresses and outputs 00h at unprotected sector group addresses.

*3 : When V_{ID} is applied to A_9, both Bank 1 and Bank 2 are put into Autoselect mode, which makes simultaneous operation unable to be executed. Consequently, specifying the bank address is not required. However, the bank address needs to be indicated when Autoselect mode is read out at command mode, because then it enables to activate simultaneous operation.

Expanded Autoselect Code Table

Type			Code	DQ_{15}	DQ_{14}	DQ_{13}	DQ_{12}	DQ_{11}	DQ_{10}	DQ_9	DQ_8	DQ_7	DQ_6	DQ_5	DQ_4	DQ_3	DQ_2	DQ_1	DQ_0
Manufacturer's Code		(B)*	04h	A_{-1}	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	0	0	0	0	0	1	0	0
		(W)	0004h	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0
Device Code	MBM29DL164TE	(B)*	33h	A_{-1}	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	0	0	1	1	0	0	1	1
		(W)	2233h	0	0	1	0	0	0	1	0	0	0	1	1	0	0	1	1
	MBM29DL164BE	(B)*	35h	A_{-1}	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	0	0	1	1	0	1	0	1
		(W)	2235h	0	0	1	0	0	0	1	0	0	0	1	1	0	1	0	1
Sector Group Protection		(B)*	01h	A_{-1}	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	HI-Z	0	0	0	0	0	0	0	1
		(W)	0001h	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1

(B)   : Byte mode
(W)   : Word mode
HI-Z : High-Z

* : At Byte mode, DQ_{14} to DQ_8 are High-Z and DQ_{15} is A_{-1}, the lowest address.

■ FLEXIBLE SECTOR-ERASE ARCHITECTURE

Sector Address Table (MBM29DL161TE)

Bank	Sector	Sector Address Bank Address A19	A18	A17	A16	A15	A14	A13	A12	Sector Size (Kbytes/ Kwords)	(×8) Address Range	(×16) Address Range
Bank 2	SA0	0	0	0	0	0	X	X	X	64/32	000000h to 00FFFFh	000000h to 007FFFh
	SA1	0	0	0	0	1	X	X	X	64/32	010000h to 01FFFFh	008000h to 00FFFFh
	SA2	0	0	0	1	0	X	X	X	64/32	020000h to 02FFFFh	010000h to 017FFFh
	SA3	0	0	0	1	1	X	X	X	64/32	030000h to 03FFFFh	018000h to 01FFFFh
	SA4	0	0	1	0	0	X	X	X	64/32	040000h to 04FFFFh	020000h to 027FFFh
	SA5	0	0	1	0	1	X	X	X	64/32	050000h to 05FFFFh	028000h to 02FFFFh
	SA6	0	0	1	1	0	X	X	X	64/32	060000h to 06FFFFh	030000h to 037FFFh
	SA7	0	0	1	1	1	X	X	X	64/32	070000h to 07FFFFh	038000h to 03FFFFh
	SA8	0	1	0	0	0	X	X	X	64/32	080000h to 08FFFFh	040000h to 047FFFh
	SA9	0	1	0	0	1	X	X	X	64/32	090000h to 09FFFFh	048000h to 04FFFFh
	SA10	0	1	0	1	0	X	X	X	64/32	0A0000h to 0AFFFFh	050000h to 057FFFh
	SA11	0	1	0	1	1	X	X	X	64/32	0B0000h to 0BFFFFh	058000h to 05FFFFh
	SA12	0	1	1	0	0	X	X	X	64/32	0C0000h to 0CFFFFh	060000h to 067FFFh
	SA13	0	1	1	0	1	X	X	X	64/32	0D0000h to 0DFFFFh	068000h to 06FFFFh
	SA14	0	1	1	1	0	X	X	X	64/32	0E0000h to 0EFFFFh	070000h to 077FFFh
	SA15	0	1	1	1	1	X	X	X	64/32	0F0000h to 0FFFFFh	078000h to 07FFFFh
	SA16	1	0	0	0	0	X	X	X	64/32	100000h to 10FFFFh	080000h to 087FFFh
	SA17	1	0	0	0	1	X	X	X	64/32	110000h to 11FFFFh	088000h to 08FFFFh
	SA18	1	0	0	1	0	X	X	X	64/32	120000h to 12FFFFh	090000h to 097FFFh
	SA19	1	0	0	1	1	X	X	X	64/32	130000h to 13FFFFh	098000h to 09FFFFh
	SA20	1	0	1	0	0	X	X	X	64/32	140000h to 14FFFFh	0A0000h to 0A7FFFh
	SA21	1	0	1	0	1	X	X	X	64/32	150000h to 15FFFFh	0A8000h to 0AFFFFh
	SA22	1	0	1	1	0	X	X	X	64/32	160000h to 16FFFFh	0B0000h to 0B7FFFh
	SA23	1	0	1	1	1	X	X	X	64/32	170000h to 17FFFFh	0B8000h to 0BFFFFh
	SA24	1	1	0	0	0	X	X	X	64/32	180000h to 18FFFFh	0C0000h to 0C7FFFh
	SA25	1	1	0	0	1	X	X	X	64/32	190000h to 19FFFFh	0C8000h to 0CFFFFh
	SA26	1	1	0	1	0	X	X	X	64/32	1A0000h to 1AFFFFh	0D0000h to 0D7FFFh
	SA27	1	1	0	1	1	X	X	X	64/32	1B0000h to 1BFFFFh	0D8000h to 0DFFFFh
	SA28	1	1	1	0	0	X	X	X	64/32	1C0000h to 1CFFFFh	0E0000h to 0E7FFFh
	SA29	1	1	1	0	1	X	X	X	64/32	1D0000h to 1DFFFFh	0E8000h to 0EFFFFh
	SA30	1	1	1	1	0	X	X	X	64/32	1E0000h to 1EFFFFh	0F0000h to 0F7FFFh
Bank 1	SA31	1	1	1	1	1	0	0	0	8/4	1F0000h to 1F1FFFh	0F8000h to 0F8FFFh
	SA32	1	1	1	1	1	0	0	1	8/4	1F2000h to 1F3FFFh	0F9000h to 0F9FFFh
	SA33	1	1	1	1	1	0	1	0	8/4	1F4000h to 1F5FFFh	0FA000h to 0FAFFFh
	SA34	1	1	1	1	1	0	1	1	8/4	1F6000h to 1F7FFFh	0FB000h to 0FBFFFh
	SA35	1	1	1	1	1	1	0	0	8/4	1F8000h to 1F9FFFh	0FC000h to 0FCFFFh
	SA36	1	1	1	1	1	1	0	1	8/4	1FA000h to 1FBFFFh	0FD000h to 0FDFFFh
	SA37	1	1	1	1	1	1	1	0	8/4	1FC000h to 1FDFFFh	0FE000h to 0FEFFFh
	SA38	1	1	1	1	1	1	1	1	8/4	1FE000h to 1FFFFFh	0FF000h to 0FFFFFh

Note: The address range is A19: A-1 if in byte mode ($\overline{BYTE}$ = VIL).
The address range is A19: A0 if in word mode ($\overline{BYTE}$ = VIH)

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Sector Address Table (MBM29DL161BE)

Bank	Sector	Sector Address								Sector Size (Kbytes/ Kwords)	(×8) Address Range	(×16) Address Range
		Bank Address										
		A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}			
Bank 2	SA38	1	1	1	1	1	X	X	X	64/32	1F0000h to 1FFFFFh	0F8000h to 0FFFFFh
	SA37	1	1	1	1	0	X	X	X	64/32	1E0000h to 1EFFFFh	0F0000h to 0F7FFFh
	SA36	1	1	1	0	1	X	X	X	64/32	1D0000h to 1DFFFFh	0E8000h to 0EFFFFh
	SA35	1	1	1	0	0	X	X	X	64/32	1C0000h to 1CFFFFh	0E0000h to 0E7FFFh
	SA34	1	1	0	1	1	X	X	X	64/32	1B0000h to 1BFFFFh	0D8000h to 0DFFFFh
	SA33	1	1	0	1	0	X	X	X	64/32	1A0000h to 1AFFFFh	0D0000h to 0D7FFFh
	SA32	1	1	0	0	1	X	X	X	64/32	190000h to 19FFFFh	0C8000h to 0CFFFFh
	SA31	1	1	0	0	0	X	X	X	64/32	180000h to 18FFFFh	0C0000h to 0C7FFFh
	SA30	1	0	1	1	1	X	X	X	64/32	170000h to 17FFFFh	0B8000h to 0BFFFFh
	SA29	1	0	1	1	0	X	X	X	64/32	160000h to 16FFFFh	0B0000h to 0B7FFFh
	SA28	1	0	1	0	1	X	X	X	64/32	150000h to 15FFFFh	0A8000h to 0AFFFFh
	SA27	1	0	1	0	0	X	X	X	64/32	140000h to 14FFFFh	0A0000h to 0A7FFFh
	SA26	1	0	0	1	1	X	X	X	64/32	130000h to 13FFFFh	098000h to 09FFFFh
	SA25	1	0	0	1	0	X	X	X	64/32	120000h to 12FFFFh	090000h to 097FFFh
	SA24	1	0	0	0	X	X	X	X	64/32	110000h to 11FFFFh	088000h to 08FFFFh
	SA23	1	0	0	0	0	X	X	X	64/32	100000h to 10FFFFh	080000h to 087FFFh
	SA22	0	1	1	1	1	X	X	X	64/32	0F0000h to 0FFFFFh	078000h to 07FFFFh
	SA21	0	1	1	1	0	X	X	X	64/32	0E0000h to 0EFFFFh	070000h to 077FFFh
	SA20	0	1	1	0	1	X	X	X	64/32	0D0000h to 0DFFFFh	068000h to 06FFFFh
	SA19	0	1	1	0	0	X	X	X	64/32	0C0000h to 0CFFFFh	060000h to 067FFFh
	SA18	0	1	0	1	1	X	X	X	64/32	0B0000h to 0BFFFFh	058000h to 05FFFFh
	SA17	0	1	0	1	0	X	X	X	64/32	0A0000h to 0AFFFFh	050000h to 057FFFh
	SA16	0	1	0	0	1	X	X	X	64/32	090000h to 09FFFFh	048000h to 04FFFFh
	SA15	0	1	0	0	0	X	X	X	64/32	080000h to 08FFFFh	040000h to 047FFFh
	SA14	0	0	1	1	1	X	X	X	64/32	070000h to 07FFFFh	038000h to 03FFFFh
	SA13	0	0	1	1	0	X	X	X	64/32	060000h to 06FFFFh	030000h to 037FFFh
	SA12	0	0	1	0	1	X	X	X	64/32	050000h to 05FFFFh	028000h to 02FFFFh
	SA11	0	0	1	0	0	X	X	X	64/32	040000h to 04FFFFh	020000h to 027FFFh
	SA10	0	0	0	1	1	X	X	X	64/32	030000h to 03FFFFh	018000h to 01FFFFh
	SA9	0	0	0	1	0	X	X	X	64/32	020000h to 02FFFFh	010000h to 017FFFh
	SA8	0	0	0	0	1	X	X	X	64/32	010000h to 01FFFFh	008000h to 00FFFFh
Bank 1	SA7	0	0	0	0	0	1	1	1	8/4	00E000h to 00FFFFh	007000h to 007FFFh
	SA6	0	0	0	0	0	1	1	0	8/4	00C000h to 00DFFFh	006000h to 006FFFh
	SA5	0	0	0	0	0	1	0	1	8/4	00A000h to 00BFFFh	005000h to 005FFFh
	SA4	0	0	0	0	0	1	0	0	8/4	008000h to 009FFFh	004000h to 004FFFh
	SA3	0	0	0	0	0	0	1	1	8/4	006000h to 007FFFh	003000h to 003FFFh
	SA2	0	0	0	0	0	0	1	0	8/4	004000h to 005FFFh	002000h to 002FFFh
	SA1	0	0	0	0	0	0	0	1	8/4	002000h to 003FFFh	001000h to 001FFFh
	SA0	0	0	0	0	0	0	0	0	8/4	000000h to 001FFFh	000000h to 000FFFh

Note: The address range is A_{19} : A_{-1} if in byte mode ($\overline{BYTE}$ = V_{IL}).
The address range is A_{19} : A_0 if in word mode ($\overline{BYTE}$ = V_{IH}).

Sector Address Table (MBM29DL162TE)

Bank	Sector	Sector Address Bank Address A19	A18	A17	A16	A15	A14	A13	A12	Sector Size (Kbytes/ Kwords)	(×8) Address Range	(×16) Address Range
Bank 2	SA0	0	0	0	0	0	X	X	X	64/32	000000h to 00FFFFh	000000h to 007FFFh
	SA1	0	0	0	0	1	X	X	X	64/32	010000h to 01FFFFh	008000h to 00FFFFh
	SA2	0	0	0	1	0	X	X	X	64/32	020000h to 02FFFFh	010000h to 017FFFh
	SA3	0	0	0	1	1	X	X	X	64/32	030000h to 03FFFFh	018000h to 01FFFFh
	SA4	0	0	1	0	0	X	X	X	64/32	040000h to 04FFFFh	020000h to 027FFFh
	SA5	0	0	1	0	1	X	X	X	64/32	050000h to 05FFFFh	028000h to 02FFFFh
	SA6	0	0	1	1	0	X	X	X	64/32	060000h to 06FFFFh	030000h to 037FFFh
	SA7	0	0	1	1	1	X	X	X	64/32	070000h to 07FFFFh	038000h to 03FFFFh
	SA8	0	1	0	0	0	X	X	X	64/32	080000h to 08FFFFh	040000h to 047FFFh
	SA9	0	1	0	0	1	X	X	X	64/32	090000h to 09FFFFh	048000h to 04FFFFh
	SA10	0	1	0	1	0	X	X	X	64/32	0A0000h to 0AFFFFh	050000h to 057FFFh
	SA11	0	1	0	1	1	X	X	X	64/32	0B0000h to 0BFFFFh	058000h to 05FFFFh
	SA12	0	1	1	0	0	X	X	X	64/32	0C0000h to 0CFFFFh	060000h to 067FFFh
	SA13	0	1	1	0	1	X	X	X	64/32	0D0000h to 0DFFFFh	068000h to 06FFFFh
	SA14	0	1	1	1	0	X	X	X	64/32	0E0000h to 0EFFFFh	070000h to 077FFFh
	SA15	0	1	1	1	1	X	X	X	64/32	0F0000h to 0FFFFFh	078000h to 07FFFFh
	SA16	1	0	0	0	0	X	X	X	64/32	100000h to 10FFFFh	080000h to 087FFFh
	SA17	1	0	0	0	1	X	X	X	64/32	110000h to 11FFFFh	088000h to 08FFFFh
	SA18	1	0	0	1	0	X	X	X	64/32	120000h to 12FFFFh	090000h to 097FFFh
	SA19	1	0	0	1	1	X	X	X	64/32	130000h to 13FFFFh	098000h to 09FFFFh
	SA20	1	0	1	0	0	X	X	X	64/32	140000h to 14FFFFh	0A0000h to 0A7FFFh
	SA21	1	0	1	0	1	X	X	X	64/32	150000h to 15FFFFh	0A8000h to 0AFFFFh
	SA22	1	0	1	1	0	X	X	X	64/32	160000h to 16FFFFh	0B0000h to 0B7FFFh
	SA23	1	0	1	1	1	X	X	X	64/32	170000h to 17FFFFh	0B8000h to 0BFFFFh
	SA24	1	1	0	0	0	X	X	X	64/32	180000h to 18FFFFh	0C0000h to 0C7FFFh
	SA25	1	1	0	0	1	X	X	X	64/32	190000h to 19FFFFh	0C8000h to 0CFFFFh
	SA26	1	1	0	1	0	X	X	X	64/32	1A0000h to 1AFFFFh	0D0000h to 0D7FFFh
	SA27	1	1	0	1	1	X	X	X	64/32	1B0000h to 1BFFFFh	0D8000h to 0DFFFFh
Bank 1	SA28	1	1	1	0	0	X	X	X	64/32	1C0000h to 1CFFFFh	0E0000h to 0E7FFFh
	SA29	1	1	1	0	1	X	X	X	64/32	1D0000h to 1DFFFFh	0E8000h to 0EFFFFh
	SA30	1	1	1	1	0	X	X	X	64/32	1E0000h to 1EFFFFh	0F0000h to 0F7FFFh
	SA31	1	1	1	1	1	0	0	0	8/4	1F0000h to 1F1FFFh	0F8000h to 0F8FFFh
	SA32	1	1	1	1	1	0	0	1	8/4	1F2000h to 1F3FFFh	0F9000h to 0F9FFFh
	SA33	1	1	1	1	1	0	1	0	8/4	1F4000h to 1F5FFFh	0FA000h to 0FAFFFh
	SA34	1	1	1	1	1	0	1	1	8/4	1F6000h to 1F7FFFh	0FB000h to 0FBFFFh
	SA35	1	1	1	1	1	1	0	0	8/4	1F8000h to 1F9FFFh	0FC000h to 0FCFFFh
	SA36	1	1	1	1	1	1	0	1	8/4	1FA000h to 1FBFFFh	0FD000h to 0FDFFFh
	SA37	1	1	1	1	1	1	1	0	8/4	1FC000h to 1FDFFFh	0FE000h to 0FEFFFh
	SA38	1	1	1	1	1	1	1	1	8/4	1FE000h to 1FFFFFh	0FF000h to 0FFFFFh

Note: The address range is A_{19}: A_{-1} if in byte mode ($\overline{BYTE}$ = V_{IL}).
The address range is A_{19}: A_0 if in word mode ($\overline{BYTE}$ = V_{IH})

Sector Address Table (MBM29DL162BE)

Bank	Sector	Sector Address Bank Address A19	A18	A17	A16	A15	A14	A13	A12	Sector Size (Kbytes/Kwords)	(×8) Address Range	(×16) Address Range
Bank 2	SA38	1	1	1	1	1	X	X	X	64/32	1F0000h to 1FFFFFh	0F8000h to 0FFFFFh
	SA37	1	1	1	1	0	X	X	X	64/32	1E0000h to 1EFFFFh	0F0000h to 0F7FFFh
	SA36	1	1	1	0	1	X	X	X	64/32	1D0000h to 1DFFFFh	0E8000h to 0EFFFFh
	SA35	1	1	1	0	0	X	X	X	64/32	1C0000h to 1CFFFFh	0E0000h to 0E7FFFh
	SA34	1	1	0	1	1	X	X	X	64/32	1B0000h to 1BFFFFh	0D8000h to 0DFFFFh
	SA33	1	1	0	1	0	X	X	X	64/32	1A0000h to 1AFFFFh	0D0000h to 0D7FFFh
	SA32	1	1	0	0	1	X	X	X	64/32	190000h to 19FFFFh	0C8000h to 0CFFFFh
	SA31	1	1	0	0	0	X	X	X	64/32	180000h to 18FFFFh	0C0000h to 0C7FFFh
	SA30	1	0	1	1	1	X	X	X	64/32	170000h to 17FFFFh	0B8000h to 0BFFFFh
	SA29	1	0	1	1	0	X	X	X	64/32	160000h to 16FFFFh	0B0000h to 0B7FFFh
	SA28	1	0	1	0	1	X	X	X	64/32	150000h to 15FFFFh	0A8000h to 0AFFFFh
	SA27	1	0	1	0	0	X	X	X	64/32	140000h to 14FFFFh	0A0000h to 0A7FFFh
	SA26	1	0	0	1	1	X	X	X	64/32	130000h to 13FFFFh	098000h to 09FFFFh
	SA25	1	0	0	1	0	X	X	X	64/32	120000h to 12FFFFh	090000h to 097FFFh
	SA24	1	0	0	0	X	X	X	X	64/32	110000h to 11FFFFh	088000h to 08FFFFh
	SA23	1	0	0	0	0	X	X	X	64/32	100000h to 10FFFFh	080000h to 087FFFh
	SA22	0	1	1	1	1	X	X	X	64/32	0F0000h to 0FFFFFh	078000h to 07FFFFh
	SA21	0	1	1	1	0	X	X	X	64/32	0E0000h to 0EFFFFh	070000h to 077FFFh
	SA20	0	1	1	0	1	X	X	X	64/32	0D0000h to 0DFFFFh	068000h to 06FFFFh
	SA19	0	1	1	0	0	X	X	X	64/32	0C0000h to 0CFFFFh	060000h to 067FFFh
	SA18	0	1	0	1	1	X	X	X	64/32	0B0000h to 0BFFFFh	058000h to 05FFFFh
	SA17	0	1	0	1	0	X	X	X	64/32	0A0000h to 0AFFFFh	050000h to 057FFFh
	SA16	0	1	0	0	1	X	X	X	64/32	090000h to 09FFFFh	048000h to 04FFFFh
	SA15	0	1	0	0	0	X	X	X	64/32	080000h to 08FFFFh	040000h to 047FFFh
	SA14	0	0	1	1	1	X	X	X	64/32	070000h to 07FFFFh	038000h to 03FFFFh
	SA13	0	0	1	1	0	X	X	X	64/32	060000h to 06FFFFh	030000h to 037FFFh
	SA12	0	0	1	0	1	X	X	X	64/32	050000h to 05FFFFh	028000h to 02FFFFh
	SA11	0	0	1	0	0	X	X	X	64/32	040000h to 04FFFFh	020000h to 027FFFh
Bank 1	SA10	0	0	0	1	1	X	X	X	64/32	030000h to 03FFFFh	018000h to 01FFFFh
	SA9	0	0	0	1	0	X	X	X	64/32	020000h to 02FFFFh	010000h to 017FFFh
	SA8	0	0	0	0	1	X	X	X	64/32	010000h to 01FFFFh	008000h to 00FFFFh
	SA7	0	0	0	0	0	1	1	1	8/4	00E000h to 00FFFFh	007000h to 007FFFh
	SA6	0	0	0	0	0	1	1	0	8/4	00C000h to 00DFFFh	006000h to 006FFFh
	SA5	0	0	0	0	0	1	0	1	8/4	00A000h to 00BFFFh	005000h to 005FFFh
	SA4	0	0	0	0	0	1	0	0	8/4	008000h to 009FFFh	004000h to 004FFFh
	SA3	0	0	0	0	0	0	1	1	8/4	006000h to 007FFFh	003000h to 003FFFh
	SA2	0	0	0	0	0	0	1	0	8/4	004000h to 005FFFh	002000h to 002FFFh
	SA1	0	0	0	0	0	0	0	1	8/4	002000h to 003FFFh	001000h to 001FFFh
	SA0	0	0	0	0	0	0	0	0	8/4	000000h to 001FFFh	000000h to 000FFFh

Note: The address range is A_{19}: A_{-1} if in byte mode ($\overline{BYTE}$ = V_{IL}).
The address range is A_{19}: A_0 if in word mode ($\overline{BYTE}$ = V_{IH}).

Sector Address Table (MBM29DL163TE)

Bank	Sector	Sector Address								Sector Size (Kbytes/ Kwords)	(×8) Address Range	(×16) Address Range
		Bank Address										
		A$_{19}$	A$_{18}$	A$_{17}$	A$_{16}$	A$_{15}$	A$_{14}$	A$_{13}$	A$_{12}$			
Bank 2	SA0	0	0	0	0	0	X	X	X	64/32	000000h to 00FFFFh	000000h to 007FFFh
	SA1	0	0	0	0	1	X	X	X	64/32	010000h to 01FFFFh	008000h to 00FFFFh
	SA2	0	0	0	1	0	X	X	X	64/32	020000h to 02FFFFh	010000h to 017FFFh
	SA3	0	0	0	1	1	X	X	X	64/32	030000h to 03FFFFh	018000h to 01FFFFh
	SA4	0	0	1	0	0	X	X	X	64/32	040000h to 04FFFFh	020000h to 027FFFh
	SA5	0	0	1	0	1	X	X	X	64/32	050000h to 05FFFFh	028000h to 02FFFFh
	SA6	0	0	1	1	0	X	X	X	64/32	060000h to 06FFFFh	030000h to 037FFFh
	SA7	0	0	1	1	1	X	X	X	64/32	070000h to 07FFFFh	038000h to 03FFFFh
	SA8	0	1	0	0	0	X	X	X	64/32	080000h to 08FFFFh	040000h to 047FFFh
	SA9	0	1	0	0	1	X	X	X	64/32	090000h to 09FFFFh	048000h to 04FFFFh
	SA10	0	1	0	1	0	X	X	X	64/32	0A0000h to 0AFFFFh	050000h to 057FFFh
	SA11	0	1	0	1	1	X	X	X	64/32	0B0000h to 0BFFFFh	058000h to 05FFFFh
	SA12	0	1	1	0	0	X	X	X	64/32	0C0000h to 0CFFFFh	060000h to 067FFFh
	SA13	0	1	1	0	1	X	X	X	64/32	0D0000h to 0DFFFFh	068000h to 06FFFFh
	SA14	0	1	1	1	0	X	X	X	64/32	0E0000h to 0EFFFFh	070000h to 077FFFh
	SA15	0	1	1	1	1	X	X	X	64/32	0F0000h to 0FFFFFh	078000h to 07FFFFh
	SA16	1	0	0	0	0	X	X	X	64/32	100000h to 10FFFFh	080000h to 087FFFh
	SA17	1	0	0	0	1	X	X	X	64/32	110000h to 11FFFFh	088000h to 08FFFFh
	SA18	1	0	0	1	0	X	X	X	64/32	120000h to 12FFFFh	090000h to 097FFFh
	SA19	1	0	0	1	1	X	X	X	64/32	130000h to 13FFFFh	098000h to 09FFFFh
	SA20	1	0	1	0	0	X	X	X	64/32	140000h to 14FFFFh	0A0000h to 0A7FFFh
	SA21	1	0	1	0	1	X	X	X	64/32	150000h to 15FFFFh	0A8000h to 0AFFFFh
	SA22	1	0	1	1	0	X	X	X	64/32	160000h to 16FFFFh	0B0000h to 0B7FFFh
	SA23	1	0	1	1	1	X	X	X	64/32	170000h to 17FFFFh	0B8000h to 0BFFFFh
Bank 1	SA24	1	1	0	0	0	X	X	X	64/32	180000h to 18FFFFh	0C0000h to 0C7FFFh
	SA25	1	1	0	0	1	X	X	X	64/32	190000h to 19FFFFh	0C8000h to 0CFFFFh
	SA26	1	1	0	1	0	X	X	X	64/32	1A0000h to 1AFFFFh	0D0000h to 0D7FFFh
	SA27	1	1	0	1	1	X	X	X	64/32	1B0000h to 1BFFFFh	0D8000h to 0DFFFFh
	SA28	1	1	1	0	0	X	X	X	64/32	1C0000h to 1CFFFFh	0E0000h to 0E7FFFh
	SA29	1	1	1	0	1	X	X	X	64/32	1D0000h to 1DFFFFh	0E8000h to 0EFFFFh
	SA30	1	1	1	1	0	X	X	X	64/32	1E0000h to 1EFFFFh	0F0000h to 0F7FFFh
	SA31	1	1	1	1	1	0	0	0	8/4	1F0000h to 1F1FFFh	0F8000h to 0F8FFFh
	SA32	1	1	1	1	1	0	0	1	8/4	1F2000h to 1F3FFFh	0F9000h to 0F9FFFh
	SA33	1	1	1	1	1	0	1	0	8/4	1F4000h to 1F5FFFh	0FA000h to 0FAFFFh
	SA34	1	1	1	1	1	0	1	1	8/4	1F6000h to 1F7FFFh	0FB000h to 0FBFFFh
	SA35	1	1	1	1	1	1	0	0	8/4	1F8000h to 1F9FFFh	0FC000h to 0FCFFFh
	SA36	1	1	1	1	1	1	0	1	8/4	1FA000h to 1FBFFFh	0FD000h to 0FDFFFh
	SA37	1	1	1	1	1	1	1	0	8/4	1FC000h to 1FDFFFh	0FE000h to 0FEFFFh
	SA38	1	1	1	1	1	1	1	1	8/4	1FE000h to 1FFFFFh	0FF000h to 0FFFFFh

Note: The address range is A$_{19}$: A$_{-1}$ if in byte mode ($\overline{BYTE}$ = V$_{IL}$).
The address range is A$_{19}$: A$_0$ if in word mode ($\overline{BYTE}$ = V$_{IH}$)

Sector Address Table (MBM29DL163BE)

Bank	Sector	Sector Address Bank Address A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	Sector Size (Kbytes/Kwords)	(×8) Address Range	(×16) Address Range
Bank 2	SA38	1	1	1	1	1	X	X	X	64/32	1F0000h to 1FFFFFh	0F8000h to 0FFFFFh
	SA37	1	1	1	1	0	X	X	X	64/32	1E0000h to 1EFFFFh	0F0000h to 0F7FFFh
	SA36	1	1	1	0	1	X	X	X	64/32	1D0000h to 1DFFFFh	0E8000h to 0EFFFFh
	SA35	1	1	1	0	0	X	X	X	64/32	1C0000h to 1CFFFFh	0E0000h to 0E7FFFh
	SA34	1	1	0	1	1	X	X	X	64/32	1B0000h to 1BFFFFh	0D8000h to 0DFFFFh
	SA33	1	1	0	1	0	X	X	X	64/32	1A0000h to 1AFFFFh	0D0000h to 0D7FFFh
	SA32	1	1	0	0	1	X	X	X	64/32	190000h to 19FFFFh	0C8000h to 0CFFFFh
	SA31	1	1	0	0	0	X	X	X	64/32	180000h to 18FFFFh	0C0000h to 0C7FFFh
	SA30	1	0	1	1	1	X	X	X	64/32	170000h to 17FFFFh	0B8000h to 0BFFFFh
	SA29	1	0	1	1	0	X	X	X	64/32	160000h to 16FFFFh	0B0000h to 0B7FFFh
	SA28	1	0	1	0	1	X	X	X	64/32	150000h to 15FFFFh	0A8000h to 0AFFFFh
	SA27	1	0	1	0	0	X	X	X	64/32	140000h to 14FFFFh	0A0000h to 0A7FFFh
	SA26	1	0	0	1	1	X	X	X	64/32	130000h to 13FFFFh	098000h to 09FFFFh
	SA25	1	0	0	1	0	X	X	X	64/32	120000h to 12FFFFh	090000h to 097FFFh
	SA24	1	0	0	0	X	X	X	X	64/32	110000h to 11FFFFh	088000h to 08FFFFh
	SA23	1	0	0	0	0	X	X	X	64/32	100000h to 10FFFFh	080000h to 087FFFh
	SA22	0	1	1	1	1	X	X	X	64/32	0F0000h to 0FFFFFh	078000h to 07FFFFh
	SA21	0	1	1	1	0	X	X	X	64/32	0E0000h to 0EFFFFh	070000h to 077FFFh
	SA20	0	1	1	0	1	X	X	X	64/32	0D0000h to 0DFFFFh	068000h to 06FFFFh
	SA19	0	1	1	0	0	X	X	X	64/32	0C0000h to 0CFFFFh	060000h to 067FFFh
	SA18	0	1	0	1	1	X	X	X	64/32	0B0000h to 0BFFFFh	058000h to 05FFFFh
	SA17	0	1	0	1	0	X	X	X	64/32	0A0000h to 0AFFFFh	050000h to 057FFFh
	SA16	0	1	0	0	1	X	X	X	64/32	090000h to 09FFFFh	048000h to 04FFFFh
	SA15	0	1	0	0	0	X	X	X	64/32	080000h to 08FFFFh	040000h to 047FFFh
Bank 1	SA14	0	0	1	1	1	X	X	X	64/32	070000h to 07FFFFh	038000h to 03FFFFh
	SA13	0	0	1	1	0	X	X	X	64/32	060000h to 06FFFFh	030000h to 037FFFh
	SA12	0	0	1	0	1	X	X	X	64/32	050000h to 05FFFFh	028000h to 02FFFFh
	SA11	0	0	1	0	0	X	X	X	64/32	040000h to 04FFFFh	020000h to 027FFFh
	SA10	0	0	0	1	1	X	X	X	64/32	030000h to 03FFFFh	018000h to 01FFFFh
	SA9	0	0	0	1	0	X	X	X	64/32	020000h to 02FFFFh	010000h to 017FFFh
	SA8	0	0	0	0	1	X	X	X	64/32	010000h to 01FFFFh	008000h to 00FFFFh
	SA7	0	0	0	0	0	1	1	1	8/4	00E000h to 00FFFFh	007000h to 007FFFh
	SA6	0	0	0	0	0	1	1	0	8/4	00C000h to 00DFFFh	006000h to 006FFFh
	SA5	0	0	0	0	0	1	0	1	8/4	00A000h to 00BFFFh	005000h to 005FFFh
	SA4	0	0	0	0	0	1	0	0	8/4	008000h to 009FFFh	004000h to 004FFFh
	SA3	0	0	0	0	0	0	1	1	8/4	006000h to 007FFFh	003000h to 003FFFh
	SA2	0	0	0	0	0	0	1	0	8/4	004000h to 005FFFh	002000h to 002FFFh
	SA1	0	0	0	0	0	0	0	1	8/4	002000h to 003FFFh	001000h to 001FFFh
	SA0	0	0	0	0	0	0	0	0	8/4	000000h to 001FFFh	000000h to 000FFFh

Note: The address range is A_{19}: A_{-1} if in byte mode ($\overline{BYTE}$ = V_{IL}).
The address range is A_{19}: A_0 if in word mode ($\overline{BYTE}$ = V_{IH}).

Sector Address Table (MBM29DL164TE)

| Bank | Sector | Sector Address | | | | | | | | Sector Size (Kbytes/Kwords) | (×8) Address Range | (×16) Address Range |
| | | Bank Address | | | | | | | | | |
		A19	A18	A17	A16	A15	A14	A13	A12			
Bank 2	SA0	0	0	0	0	0	X	X	X	64/32	000000h to 00FFFFh	000000h to 007FFFh
	SA1	0	0	0	0	1	X	X	X	64/32	010000h to 01FFFFh	008000h to 00FFFFh
	SA2	0	0	0	1	0	X	X	X	64/32	020000h to 02FFFFh	010000h to 017FFFh
	SA3	0	0	0	1	1	X	X	X	64/32	030000h to 03FFFFh	018000h to 01FFFFh
	SA4	0	0	1	0	0	X	X	X	64/32	040000h to 04FFFFh	020000h to 027FFFh
	SA5	0	0	1	0	1	X	X	X	64/32	050000h to 05FFFFh	028000h to 02FFFFh
	SA6	0	0	1	1	0	X	X	X	64/32	060000h to 06FFFFh	030000h to 037FFFh
	SA7	0	0	1	1	1	X	X	X	64/32	070000h to 07FFFFh	038000h to 03FFFFh
	SA8	0	1	0	0	0	X	X	X	64/32	080000h to 08FFFFh	040000h to 047FFFh
	SA9	0	1	0	0	1	X	X	X	64/32	090000h to 09FFFFh	048000h to 04FFFFh
	SA10	0	1	0	1	0	X	X	X	64/32	0A0000h to 0AFFFFh	050000h to 057FFFh
	SA11	0	1	0	1	1	X	X	X	64/32	0B0000h to 0BFFFFh	058000h to 05FFFFh
	SA12	0	1	1	0	0	X	X	X	64/32	0C0000h to 0CFFFFh	060000h to 067FFFh
	SA13	0	1	1	0	1	X	X	X	64/32	0D0000h to 0DFFFFh	068000h to 06FFFFh
	SA14	0	1	1	1	0	X	X	X	64/32	0E0000h to 0EFFFFh	070000h to 077FFFh
	SA15	0	1	1	1	1	X	X	X	64/32	0F0000h to 0FFFFFh	078000h to 07FFFFh
Bank 1	SA16	1	0	0	0	0	X	X	X	64/32	100000h to 10FFFFh	080000h to 087FFFh
	SA17	1	0	0	0	1	X	X	X	64/32	110000h to 11FFFFh	088000h to 08FFFFh
	SA18	1	0	0	1	0	X	X	X	64/32	120000h to 12FFFFh	090000h to 097FFFh
	SA19	1	0	0	1	1	X	X	X	64/32	130000h to 13FFFFh	098000h to 09FFFFh
	SA20	1	0	1	0	0	X	X	X	64/32	140000h to 14FFFFh	0A0000h to 0A7FFFh
	SA21	1	0	1	0	1	X	X	X	64/32	150000h to 15FFFFh	0A8000h to 0AFFFFh
	SA22	1	0	1	1	0	X	X	X	64/32	160000h to 16FFFFh	0B0000h to 0B7FFFh
	SA23	1	0	1	1	1	X	X	X	64/32	170000h to 17FFFFh	0B8000h to 0BFFFFh
	SA24	1	1	0	0	0	X	X	X	64/32	180000h to 18FFFFh	0C0000h to 0C7FFFh
	SA25	1	1	0	0	1	X	X	X	64/32	190000h to 19FFFFh	0C8000h to 0CFFFFh
	SA26	1	1	0	1	0	X	X	X	64/32	1A0000h to 1AFFFFh	0D0000h to 0D7FFFh
	SA27	1	1	0	1	1	X	X	X	64/32	1B0000h to 1BFFFFh	0D8000h to 0DFFFFh
	SA28	1	1	1	0	0	X	X	X	64/32	1C0000h to 1CFFFFh	0E0000h to 0E7FFFh
	SA29	1	1	1	0	1	X	X	X	64/32	1D0000h to 1DFFFFh	0E8000h to 0EFFFFh
	SA30	1	1	1	1	0	X	X	X	64/32	1E0000h to 1EFFFFh	0F0000h to 0F7FFFh
	SA31	1	1	1	1	1	0	0	0	8/4	1F0000h to 1F1FFFh	0F8000h to 0F8FFFh
	SA32	1	1	1	1	1	0	0	1	8/4	1F2000h to 1F3FFFh	0F9000h to 0F9FFFh
	SA33	1	1	1	1	1	0	1	0	8/4	1F4000h to 1F5FFFh	0FA000h to 0FAFFFh
	SA34	1	1	1	1	1	0	1	1	8/4	1F6000h to 1F7FFFh	0FB000h to 0FBFFFh
	SA35	1	1	1	1	1	1	0	0	8/4	1F8000h to 1F9FFFh	0FC000h to 0FCFFFh
	SA36	1	1	1	1	1	1	0	1	8/4	1FA000h to 1FBFFFh	0FD000h to 0FDFFFh
	SA37	1	1	1	1	1	1	1	0	8/4	1FC000h to 1FDFFFh	0FE000h to 0FEFFFh
	SA38	1	1	1	1	1	1	1	1	8/4	1FE000h to 1FFFFFh	0FF000h to 0FFFFFh

Note: The address range is A19: A-1 if in byte mode ($\overline{BYTE}$ = VIL).
The address range is A19: A0 if in word mode ($\overline{BYTE}$ = VIH)

Sector Address Table (MBM29DL164BE)

Bank	Sector	A19	A18	A17	A16	A15	A14	A13	A12	Sector Size (Kbytes/Kwords)	(×8) Address Range	(×16) Address Range
Bank 2	SA38	1	1	1	1	1	X	X	X	64/32	1F0000h to 1FFFFFh	0F8000h to 0FFFFFh
	SA37	1	1	1	1	0	X	X	X	64/32	1E0000h to 1EFFFFh	0F0000h to 0F7FFFh
	SA36	1	1	1	0	1	X	X	X	64/32	1D0000h to 1DFFFFh	0E8000h to 0EFFFFh
	SA35	1	1	1	0	0	X	X	X	64/32	1C0000h to 1CFFFFh	0E0000h to 0E7FFFh
	SA34	1	1	0	1	1	X	X	X	64/32	1B0000h to 1BFFFFh	0D8000h to 0DFFFFh
	SA33	1	1	0	1	0	X	X	X	64/32	1A0000h to 1AFFFFh	0D0000h to 0D7FFFh
	SA32	1	1	0	0	1	X	X	X	64/32	190000h to 19FFFFh	0C8000h to 0CFFFFh
	SA31	1	1	0	0	0	X	X	X	64/32	180000h to 18FFFFh	0C0000h to 0C7FFFh
	SA30	1	0	1	1	1	X	X	X	64/32	170000h to 17FFFFh	0B8000h to 0BFFFFh
	SA29	1	0	1	1	0	X	X	X	64/32	160000h to 16FFFFh	0B0000h to 0B7FFFh
	SA28	1	0	1	0	1	X	X	X	64/32	150000h to 15FFFFh	0A8000h to 0AFFFFh
	SA27	1	0	1	0	0	X	X	X	64/32	140000h to 14FFFFh	0A0000h to 0A7FFFh
	SA26	1	0	0	1	1	X	X	X	64/32	130000h to 13FFFFh	098000h to 09FFFFh
	SA25	1	0	0	1	0	X	X	X	64/32	120000h to 12FFFFh	090000h to 097FFFh
	SA24	1	0	0	0	X	X	X	X	64/32	110000h to 11FFFFh	088000h to 08FFFFh
	SA23	1	0	0	0	0	X	X	X	64/32	100000h to 10FFFFh	080000h to 087FFFh
Bank 1	SA22	0	1	1	1	1	X	X	X	64/32	0F0000h to 0FFFFFh	078000h to 07FFFFh
	SA21	0	1	1	1	0	X	X	X	64/32	0E0000h to 0EFFFFh	070000h to 077FFFh
	SA20	0	1	1	0	1	X	X	X	64/32	0D0000h to 0DFFFFh	068000h to 06FFFFh
	SA19	0	1	1	0	0	X	X	X	64/32	0C0000h to 0CFFFFh	060000h to 067FFFh
	SA18	0	1	0	1	1	X	X	X	64/32	0B0000h to 0BFFFFh	058000h to 05FFFFh
	SA17	0	1	0	1	0	X	X	X	64/32	0A0000h to 0AFFFFh	050000h to 057FFFh
	SA16	0	1	0	0	1	X	X	X	64/32	090000h to 09FFFFh	048000h to 04FFFFh
	SA15	0	1	0	0	0	X	X	X	64/32	080000h to 08FFFFh	040000h to 047FFFh
	SA14	0	0	1	1	1	X	X	X	64/32	070000h to 07FFFFh	038000h to 03FFFFh
	SA13	0	0	1	1	0	X	X	X	64/32	060000h to 06FFFFh	030000h to 037FFFh
	SA12	0	0	1	0	1	X	X	X	64/32	050000h to 05FFFFh	028000h to 02FFFFh
	SA11	0	0	1	0	0	X	X	X	64/32	040000h to 04FFFFh	020000h to 027FFFh
	SA10	0	0	0	1	1	X	X	X	64/32	030000h to 03FFFFh	018000h to 01FFFFh
	SA9	0	0	0	1	0	X	X	X	64/32	020000h to 02FFFFh	010000h to 017FFFh
	SA8	0	0	0	0	1	X	X	X	64/32	010000h to 01FFFFh	008000h to 00FFFFh
	SA7	0	0	0	0	0	1	1	1	8/4	00E000h to 00FFFFh	007000h to 007FFFh
	SA6	0	0	0	0	0	1	1	0	8/4	00C000h to 00DFFFh	006000h to 006FFFh
	SA5	0	0	0	0	0	1	0	1	8/4	00A000h to 00BFFFh	005000h to 005FFFh
	SA4	0	0	0	0	0	1	0	0	8/4	008000h to 009FFFh	004000h to 004FFFh
	SA3	0	0	0	0	0	0	1	1	8/4	006000h to 007FFFh	003000h to 003FFFh
	SA2	0	0	0	0	0	0	1	0	8/4	004000h to 005FFFh	002000h to 002FFFh
	SA1	0	0	0	0	0	0	0	1	8/4	002000h to 003FFFh	001000h to 001FFFh
	SA0	0	0	0	0	0	0	0	0	8/4	000000h to 001FFFh	000000h to 000FFFh

Note: The address range is A_{19} : A_{-1} if in byte mode ($\overline{BYTE} = V_{IL}$).
The address range is A_{19} : A_0 if in word mode ($\overline{BYTE} = V_{IH}$).

Sector Group Addresses Table (MBM29DL16XTE)
(Top Boot Block)

Sector Group	A$_{19}$	A$_{18}$	A$_{17}$	A$_{16}$	A$_{15}$	A$_{14}$	A$_{13}$	A$_{12}$	Sectors
SGA0	0	0	0	0	0	X	X	X	SA0
SGA1	0	0	0	0	1	X	X	X	SA1 to SA3
	0	0	0	1	0	X	X	X	
	0	0	0	1	1	X	X	X	
SGA2	0	0	1	X	X	X	X	X	SA4 to SA7
SGA3	0	1	0	X	X	X	X	X	SA8 to SA11
SGA4	0	1	1	X	X	X	X	X	SA12 to SA15
SGA5	1	0	0	X	X	X	X	X	SA16 to SA19
SGA6	1	0	1	X	X	X	X	X	SA20 to SA23
SGA7	1	1	0	X	X	X	X	X	SA24 to SA27
SGA8	1	1	1	0	0	X	X	X	SA28 to SA30
	1	1	1	0	1	X	X	X	
	1	1	1	1	0	X	X	X	
SGA9	1	1	1	1	1	0	0	0	SA31
SGA10	1	1	1	1	1	0	0	1	SA32
SGA11	1	1	1	1	1	0	1	0	SA33
SGA12	1	1	1	1	1	0	1	1	SA34
SGA13	1	1	1	1	1	1	0	0	SA35
SGA14	1	1	1	1	1	1	0	1	SA36
SGA15	1	1	1	1	1	1	1	0	SA37
SGA16	1	1	1	1	1	1	1	1	SA38

Sector Group Addresses Table (MBM29DL16XBE)
(Bottom Boot Block)

Sector Group	A_{19}	A_{18}	A_{17}	A_{16}	A_{15}	A_{14}	A_{13}	A_{12}	Sectors
SGA0	0	0	0	0	0	0	0	0	SA0
SGA1	0	0	0	0	0	0	0	1	SA1
SGA2	0	0	0	0	0	0	1	0	SA2
SGA3	0	0	0	0	0	0	1	1	SA3
SGA4	0	0	0	0	0	1	0	0	SA4
SGA5	0	0	0	0	0	1	0	1	SA5
SGA6	0	0	0	0	0	1	1	0	SA6
SGA7	0	0	0	0	0	1	1	1	SA7
SGA8	0	0	0	0	1	X	X	X	SA8 to SA10
	0	0	0	1	0	X	X	X	
	0	0	0	1	1	X	X	X	
SGA9	0	0	1	X	X	X	X	X	SA11 to SA14
SGA10	0	1	0	X	X	X	X	X	SA15 to SA18
SGA11	0	1	1	X	X	X	X	X	SA19 to SA22
SGA12	1	0	0	X	X	X	X	X	SA23 to SA26
SGA13	1	0	1	X	X	X	X	X	SA27 to SA30
SGA14	1	1	0	X	X	X	X	X	SA31 to SA34
SGA15	1	1	1	0	0	X	X	X	SA35 to SA37
	1	1	1	0	1	X	X	X	
	1	1	1	1	0	X	X	X	
SGA16	1	1	1	1	1	X	X	X	SA38

Common Flash Memory Interface Code Table

Description	A_6 to A_0	DQ_{15} to DQ_0
Query-unique ASCII string "QRY"	10h 11h 12h	0051h 0052h 0059h
Primary OEM Command Set 02h: AMD/FJ standard type	13h 14h	0002h 0000h
Address for Primary Extended Table	15h 16h	0040h 0000h
Alternate OEM Command Set (00h = not applicable)	17h 18h	0000h 0000h
Address for Alternate OEM Extended Table	19h 1Ah	0000h 0000h
V_{CC} Min (write/erase) DQ_7 to DQ_4: 1 V, DQ_3 to DQ_0: 100 mV	1Bh	0027h
V_{CC} Max (write/erase) DQ_7 to DQ_4: 1 V, DQ_3 to DQ_0: 100 mV	1Ch	0036h
V_{PP} Min voltage	1Dh	0000h
V_{PP} Max voltage	1Eh	0000h
Typical timeout per single byte/word write 2^N μs	1Fh	0004h
Typical timeout for Min size buffer write 2^N μs	20h	0000h
Typical timeout per individual sector erase 2^N ms	21h	000Ah
Typical timeout for full chip erase 2^N ms	22h	0000h
Max timeout for byte/word write 2^N times typical	23h	0005h
Max timeout for buffer write 2^N times typical	24h	0000h
Max timeout per individual sector erase 2^N times typical	25h	0004h
Max timeout for full chip erase 2^N times typical	26h	0000h
Device Size = 2^N byte	27h	0015h
Flash Device Interface description 02h : ×8/×16	28h 29h	0002h 0000h
Max. number of bytes in multi-byte write = 2^N	2Ah 2Bh	0000h 0000h
Number of Erase Block Regions within device	2Ch	0002h
Erase Block Region 1 Information bit 15 to bit 0 : y = number of sectors bit 31 to bit 16 : z = size (z×256 bytes)	2Dh 2Eh 2Fh 30h	0007h 0000h 0020h 0000h

Description	A_6 to A_0	DQ_{15} to DQ_0
Erase Block Region 2 Information bit 15 to bit 0 : y = number of sectors bit 31 to bit 16 : z = size (z×256 bytes)	31h 32h 33h 34h	001Eh 0000h 0000h 0001h
Query-unique ASCII string "PRI"	40h 41h 42h	0050h 0052h 0049h
Major version number, ASCII	43h	0031h
Minor version number, ASCII	44h	0032h
Address Sensitive Unlock 00h = Required	45h	0000h
Erase Suspend 02h = To Read & Write	46h	0002h
Sector Protection 00h = Not Supported X = Number of sectors in per group	47h	0001h
Sector Temporary Unprotection 01h = Supported	48h	0001h
Sector Protection Algorithm	49h	0004h
Number of Sector for Bank 2 00h = Not Supported 1Fh = MBM29DL161TE 1Ch = MBM29DL162TE 18h = MBM29DL163TE 10h = MBM29DL164TE 1Fh = MBM29DL161BE 1Ch = MBM29DL162BE 18h = MBM29DL163BE 10h = MBM29DL164BE	4Ah	00XXh
Burst Mode Type 00h = Not Supported	4Bh	0000h
Page Mode Type 00h = Not Supported	4Ch	0000h
V_{ACC} (Acceleration) Supply Minimum DQ_7 to DQ_4: 1 V, DQ_3 to DQ_0: 100 mV	4Dh	0085h
V_{ACC} (Acceleration) Supply Maximum DQ_7 to DQ_4: 1 V, DQ_3 to DQ_0: 100 mV	4Eh	0095h
Boot Type 02h = MBM29DL16XBE 03h = MBM29DL16XTE	4Fh	00XXh
Program Suspend 01h = Supported	50h	0001h

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■ **FUNCTIONAL DESCRIPTION**

• **Simultaneous Operation**

MBM29DL16XTE/BE have feature, which is capability of reading data from one bank of memory while a program or erase operation is in progress in the other bank of memory (simultaneous operation), in addition to the conventional features (read, program, erase, erase-suspend read, and erase-suspend program). The bank selection can be selected by bank address (A_{19} to A_{15}) with zero latency.

The MBM29DL161TE/BE have two banks which contain
　　Bank 1 (8KB × 8 sectors) and Bank 2 (64KB × 31 sectors).

The MBM29DL162TE/BE have two banks which contain
　　Bank 1 (8KB × 8 sectors, 64KB × 3 sectors) and Bank 2 (64KB × 28 sectors).

The MBM29DL163TE/BE have two banks which contain
　　Bank 1 (8KB × 8 sectors, 64KB × 7 sectors) and Bank 2 (64KB × 24 sectors).

The MBM29DL164TE/BE have two banks which contain
　　Bank 1 (8KB × 8 sectors, 64KB × 15 sectors) and Bank 2 (64KB × 16 sectors).

The simultaneous operation can not execute multi-function mode in the same bank. "Simultaneous Operation Table" shows combination to be possible for simultaneous operation. (Refer to "(8) Bank-to-bank Read/Write Timing Diagram" in ■TIMING DIAGRAM.)

Simultaneous Operation Table

Case	Bank 1 Status	Bank 2 Status
1	Read mode	Read mode
2	Read mode	Autoselect mode
3	Read mode	Program mode
4	Read mode	Erase mode *
5	Autoselect mode	Read mode
6	Program mode	Read mode
7	Erase mode *	Read mode

*: By writing erase suspend command on the bank address of sector being erased, the erase operation becomes suspended so that it enables reading from or programming the remaining sectors.

• **Read Mode**

The MBM29DL16XTE/BE have two control functions which must be satisfied in order to obtain data at the outputs. $\overline{CE}$ is the power control and should be used for a device selection. $\overline{OE}$ is the output control and should be used to gate data to the output pins if a device is selected.

Address access time (t_{ACC}) is equal to the delay from stable addresses to valid output data. The chip enable access time (t_{CE}) is the delay from stable addresses and stable $\overline{CE}$ to valid data at the output pins. The output enable access time (t_{OE}) is the delay from the falling edge of $\overline{OE}$ to valid data at the output pins. (Assuming the addresses have been stable for at least t_{ACC}-t_{OE} time.) When reading out a data without changing addresses after power-up, it is necessary to input hardware reset or to change $\overline{CE}$ pin from "H" to "L".

• Standby Mode

There are two ways to implement the standby mode on the MBM29DL16XTE/BE devices, one using both the $\overline{CE}$ and $\overline{RESET}$ pins; the other via the $\overline{RESET}$ pin only.

When using both pins, a CMOS standby mode is achieved with $\overline{CE}$ and $\overline{RESET}$ inputs both held at $V_{CC} \pm 0.3$ V. Under this condition the current consumed is less than 5 μA max. During Embedded Algorithm operation, V_{CC} active current (I_{CC2}) is required even $\overline{CE}$ = "H". The device can be read with standard access time (t_{CE}) from either of these standby modes.

When using the $\overline{RESET}$ pin only, a CMOS standby mode is achieved with $\overline{RESET}$ input held at $V_{SS} \pm 0.3$ V ($\overline{CE}$ = "H" or "L"). Under this condition the current is consumed is less than 5 μA max. Once the $\overline{RESET}$ pin is taken high, the device requires t_{RH} of wake up time before outputs are valid for read access.

In the standby mode the outputs are in the high impedance state, independent of the $\overline{OE}$ input.

• Automatic Sleep Mode

There is a function called automatic sleep mode to restrain power consumption during read-out of MBM29DL16XTE/BE data. This mode can be used effectively with an application requested low power consumption such as handy terminals.

To activate this mode, MBM29DL16XTE/BE automatically switch themselves to low power mode when MBM29DL16XTE/BE addresses remain stably during access fine of 150 ns. It is not necessary to control $\overline{CE}$, $\overline{WE}$, and $\overline{OE}$ on the mode. Under the mode, the current consumed is typically 1 μA (CMOS Level).

During simultaneous operation, V_{CC} active current (I_{CC2}) is required.

Since the data are latched during this mode, the data are read-out continuously. If the addresses are changed, the mode is canceled automatically and MBM29DL16XTE/BE read-out the data for changed addresses.

• Output Disable

With the $\overline{OE}$ input at a logic high level (V_{IH}), output from the devices are disabled. This will cause the output pins to be in a high impedance state.

• Autoselect

The autoselect mode allows the reading out of a binary code from the devices and will identify its manufacturer and type. This mode is intended for use by programming equipment for the purpose of automatically matching the devices to be programmed with its corresponding programming algorithm. This mode is functional over the entire temperature range of the devices.
To activate this mode, the programming equipment must force V_{ID} (11.5 V to 12.5 V) on address pin A_9. Two identifier bytes may then be sequenced from the devices outputs by toggling address A_0 from V_{IL} to V_{IH}. All addresses are DON'T CARES except A_6, A_1 A_0, and (A_{-1}). (See "MBM29DL16XTE/BE User Bus Operations Tables ($\overline{BYTE}$ = V_{IH} and $\overline{BYTE}$ = V_{IL})" in ■DEVICE BUS OPERATION.)
The manufacturer and device codes may also be read via the command register, for instances when the MBM29DL16XTE/BE are erased or programmed in a system without access to high voltage on the A_9 pin. The command sequence is illustrated in "MBM29DL16XTE/BE Command Definitions Table" in ■DEVICE BUS OPERATION. (Refer to "Autoselect Command" in ■COMMAND DEFINITIONS.)
Word 0 (A_0 = V_{IL}) represents the manufacturer's code (Fujitsu = 04h) and word 1 (A_0 = V_{IH}) represents the device identifier code (MBM29DL161TE = 36h and MBM29DL161BE = 39h for $\times$8 mode; MBM29DL161TE = 2236h and MBM29DL161BE = 2239h for $\times$16 mode), (MBM29DL162TE = 2Dh and MBM29DL162BE = 2Eh for $\times$8 mode; MBM29DL162TE = 222Dh and MBM29DL162BE = 222Eh for $\times$16 mode), (MBM29DL163TE = 28h and MBM29DL163BE = 2Bh for $\times$8 mode; MBM29DL163TE = 2228h and MBM29DL163BE = 222Bh for $\times$16 mode),

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(MBM29DL164TE = 33h and MBM29DL164BE = 35h for ×8 mode; MBM29DL164TE = 2233h and MBM29DL164BE = 2235h for ×16 mode). These two bytes/words are given in "MBM29DL16XTE/BE Sector Group Protection Verify Autoselect Codes Tables" and "Expanded Autoselect Code Tables" in ■DEVICE BUS OPERATION. All identifiers for manufactures and device will exhibit odd parity with DQ_7 defined as the parity bit. In order to read the proper device codes when executing the autoselect, A_1 must be V_{IL}. (See "MBM29DL16XTE/BE Sector Group Protection Verify Autoselect Codes Tables" and "Expanded Autoselect Code Tables" in ■DEVICE BUS OPERATION.)

In case of applying V_{ID} on A_9, since both Bank 1 and Bank 2 enter Autoselect mode, the simultenous operation cannot be executed.

• Write

Device erasure and programming are accomplished via the command register. The contents of the register serve as inputs to the internal state machine. The state machine outputs dictate the function of the device.

The command register itself does not occupy any addressable memory location. The register is a latch used to store the commands, along with the address and data information needed to execute the command. The command register is written by bringing $\overline{WE}$ to V_{IL}, while $\overline{CE}$ is at V_{IL} and $\overline{OE}$ is at V_{IH}. Addresses are latched on the falling edge of $\overline{WE}$ or $\overline{CE}$, whichever happens later; while data is latched on the rising edge of $\overline{WE}$ or $\overline{CE}$, whichever happens first. Standard microprocessor write timings are used.

Refer to "AC Characteristics" in ■ELECTRICAL CHARACTERISTICS and ■TIMING DIAGRAM.

• Sector Group Protection

The MBM29DL16XTE/BE feature hardware sector group protection. This feature will disable both program and erase operations in any combination of 17 sector groups of memory. (See "Sector Group Addresses Tables (MBM29DL16XTE/BE)" in ■FLEXIBLE SECTOR-ERASE ARCHITECTURE). The sector group protection feature is enabled using programming equipment at the user's site. The device is shipped with all sector groups unprotected.

To activate this mode, the programming equipment must force V_{ID} on address pin A_9 and control pin $\overline{OE}$, (suggest V_{ID} = 11.5 V), $\overline{CE}$ = V_{IL} and A_0 = A_6 = V_{IL}, A_1 = V_{IH}. The sector group addresses (A_{19}, A_{18}, A_{17}, A_{16}, A_{15}, A_{14}, A_{13}, and A_{12}) should be set to the sector to be protected. "Sector Address Tables (MBM29DL161TE/BE, MBM29DL162TE/BE, MBM29DL163TE/BE, MBM29DL164TE/BE)" in ■FLEXIBLE SECTOR-ERASE ARCHITECTURE define the sector address for each of the thirty nine (39) individual sectors, and "Sector Group Addresses Tables (MBM29DL16XTE/BE)" in ■FLEXIBLE SECTOR-ERASE ARCHITECTURE define the sector group address for each of the seventeen (17) individual group sectors. Programming of the protection circuitry begins on the falling edge of the $\overline{WE}$ pulse and is terminated with the rising edge of the same. Sector group addresses must be held constant during the $\overline{WE}$ pulse. See "(15) AC Waveforms for Sector Group Protection" in ■TIMING DIAGRAM and "(5) Sector Group Protection Algorithm" in ■FLOW CHART for sector group protection waveforms and algorithm.

To verify programming of the protection circuitry, the programming equipment must force V_{ID} on address pin A_9 with $\overline{CE}$ and $\overline{OE}$ at V_{IL} and $\overline{WE}$ at V_{IH}. Scanning the sector group addresses (A_{19}, A_{18}, A_{17}, A_{16}, A_{15}, A_{14}, A_{13}, and A_{12}) while (A_6, A_1, A_0) = (0, 1, 0) will produce a logical "1" code at device output DQ_0 for a protected sector. Otherwise the device will produce "0" for unprotected sector. In this mode, the lower order addresses, except for A_6, A_1, and A_0 are DON'T CARES. Address locations with A_1 = V_{IL} are reserved for Autoselect manufacturer and device codes. A_{-1} requires to apply to V_{IL} on byte mode.

It is also possible to determine if a sector group is protected in the system by writing an Autoselect command. Performing a read operation at the address location XX02h, where the higher order addresses (A_{19}, A_{18}, A_{17}, A_{16}, A_{15}, A_{14}, A_{13}, and A_{12}) are the desired sector group address will produce a logical "1" at DQ_0 for a protected sector

group. See "MBM29DL16XTE/BE Sector Group Protection Verify Autoselect Codes Tables" and "Expanded Autoselect Code Tables" in ■DEVICE BUS OPERATION for Autoselect codes.

• Temporary Sector Group Unprotection

This feature allows temporary unprotection of previously protected sector groups of the MBM29DL16XTE/BE devices in order to change data. The Sector Group Unprotection mode is activated by setting the $\overline{\text{RESET}}$ pin to high voltage (V_{ID}). During this mode, formerly protected sector groups can be programmed or erased by selecting the sector group addresses. Once the V_{ID} is taken away from the $\overline{\text{RESET}}$ pin, all the previously protected sector groups will be protected again. Refer to "(16) Temporary Sector Group Unprotection Timing Diagram" in ■TIMING DIAGRAM and "(6) Temporary Sector Group Protection Algorithm" in ■FLOW CHART.

• RESET

Hardware Reset

The MBM29DL16XTE/BE devices may be reset by driving the $\overline{\text{RESET}}$ pin to V_{IL}. The $\overline{\text{RESET}}$ pin has a pulse requirement and has to be kept low (V_{IL}) for at least "t_{RP}" in order to properly reset the internal state machine. Any operation in the process of being executed will be terminated and the internal state machine will be reset to the read mode "t_{READY}" after the $\overline{\text{RESET}}$ pin is driven low. Furthermore, once the $\overline{\text{RESET}}$ pin goes high, the devices require an additional "t_{RH}" before it will allow read access. When the $\overline{\text{RESET}}$ pin is low, the devices will be in the standby mode for the duration of the pulse and all the data output pins will be tri-stated. If a hardware reset occurs during a program or erase operation, the data at that particular location will be corrupted. Please note that the RY/$\overline{\text{BY}}$ output signal should be ignored during the $\overline{\text{RESET}}$ pulse. See "(11) $\overline{\text{RESET}}$, RY/$\overline{\text{BY}}$ Timing Diagram" in ■TIMING DIAGRAM for the timing diagram. Refer to Temporary Sector Group Unprotection for additional functionality.

• Byte/Word Configuration

The $\overline{\text{BYTE}}$ pin selects the byte (8-bit) mode or word (16-bit) mode for the MBM29DL16XTE/BE devices. When this pin is driven high, the devices operate in the word (16-bit) mode.The data is read and programmed at DQ_{15} to DQ_0. When this pin is driven low, the devices operate in byte (8-bit) mode. Under this mode, the DQ_{15}/A_{-1} pin becomes the lowest address bit and DQ_{14} to DQ_8 bits are tri-stated. Refer to "(12) Timing Diagram for Word Mode Configuration", "(13) Timing Diagram for Byte Mode Configuration" and "(14) $\overline{\text{BYTE}}$ Timing Diagram for Write Operations" in ■TIMING DIAGRAM.

• Boot Block Sector Protection

The Write Protect function provides a hardware method of protecting certain boot sectors without using V_{ID}. This function is one of two provided by the $\overline{\text{WP}}$/ACC pin.

If the system asserts V_{IL} on the $\overline{\text{WP}}$/ACC pin, the device disables program and erase functions in the two "outermost" 8K byte boot sectors (MBM29DL16XTE: SA37 and SA38, MBM29DL16XBE: SA0 and SA1) independently of whether those sectors were protected or unprotected using the method described in "Sector Group Protection". The two outermost 8K byte boot sectors are the two sectors containing the lowest addresses in a bottom-boot-configured device, or the two sectors containing the highest addresses in a top-boot-congfigured device.

If the system asserts V_{IH} on the $\overline{\text{WP}}$/ACC pin, the device reverts to whether the two outermost 8K byte boot sectors were last set to be protected or unprotected. That is, sector group protection or unprotection for these two sectors depends on whether they were last protected or unprotected using the method described in "Sector Group Protection".

• Accelerated Program Operation

MBM29DL16XTE/BE offer accelerated program operation which enables the programming in high speed. If the system asserts V_{ACC} to the $\overline{WP}$/ACC pin, the device automatically enters the acceleration mode and the time required for program operation will reduce to about 60%. This function is primarily intended to allow high speed program, so caution is needed as the sector group will temporarily be unprotected.

The system would use a fact program command sequence when programming during acceleration mode. Set command to fast mode and reset command from fast mode are not necessary. When the device enters the acceleration mode,   the device automatically set to fast mode. Therefore, the pressent sequence could be used for programming and detection of completion during acceleration mode.

Removing V_{ACC} from the $\overline{WP}$/ACC pin returns the device to normal operation. Do not remove V_{ACC} from $\overline{WP}$/ACC pin while programming. See "(18) Accelerated Program Timing Diagram" in ■TIMING DIAGRAM.

Erase operation at Acceleration mode is strictly prohibited.

■ **COMMAND DEFINITIONS**

Device operations are selected by writing specific address and data sequences into the command register. Writing incorrect address and data values or writing them in the improper sequence will reset the devices to the read mode. Some commands are required Bank Address (BA) input. When command sequences are inputed to bank being read, the commands have priority than reading. "MBM29DL16XTE/BE Command Definitions Table" in ■DEVICE BUS OPERATION defines the valid register command sequences. Note that the Erase Suspend (B0h) and Erase Resume (30h) commands are valid only while the Sector Erase operation is in progress. Moreover both Read/Reset commands are functionally equivalent, resetting the device to the read mode. Please note that commands are always written at DQ_7 to DQ_0 and DQ_{15} to DQ_8 bits are ignored.

• **Read/Reset Command**

In order to return from Autoselect mode or Exceeded Timing Limits ($DQ_5 = 1$) to Read/Reset mode, the Read/Reset operation is initiated by writing the Read/Reset command sequence into the command register. Microprocessor read cycles retrieve array data from the memory. The devices remain enabled for reads until the command register contents are altered.

The devices will automatically power-up in the Read/Reset state. In this case, a command sequence is not required to read data. Standard microprocessor read cycles will retrieve array data. This default value ensures that no spurious alteration of the memory content occurs during the power transition. Refer to "2. AC Characteristics • Read Only Operations Characteristics" in ■ELECTRICAL CHARACTERISTICS and ■TIMING DIAGRAM.

• **Autoselect Command**

Flash memories are intended for use in applications where the local CPU alters memory contents. As such, manufacture and device codes must be accessible while the devices reside in the target system. PROM programmers typically access the signature codes by raising A_9 to a high voltage. However, multiplexing high voltage onto the address lines is not generally desired system design practice.

The device contains an Autoselect command operation to supplement traditional PROM programming methodology. The operation is initiated by writing the Autoselect command sequence into the command register.

The Autoselect command sequence is initiated by first writing two unlock cycles. This is followed by a third write cycle that contains the bank address (BA) and the Autoselect command. Then the manufacture and device codes can be read from the bank, and an actual data of memory cell can be read from the another bank.

Following the command write, a read cycle from address (BA)00h retrieves the manufacture code of 04h. A read cycle from address (BA)01h for ×16((BA)02h for ×8) returns the device code (MBM29DL161TE = 36h and MBM29DL161BE = 39h for ×8 mode; MBM29DL161TE = 2236h and MBM29DL161BE = 2239h for ×16 mode), (MBM29DL162TE = 2Dh and MBM29DL162BE = 2Eh for ×8 mode; MBM29DL162TE = 222Dh and MBM29DL162BE = 222Eh for ×16 mode), (MBM29DL163TE = 28h and MBM29DL163BE = 2Bh for ×8 mode; MBM29DL163TE = 2228h and MBM29DL163BE = 222Bh for ×16 mode), (MBM29DL164TE = 33h and MBM29DL164BE = 35h for ×8 mode; MBM29DL164TE = 2233h and MBM29DL164BE = 2235h for ×16 mode). (See "MBM29DL16XTE/BE Sector Group Protection Verify Autoselect Codes Tables" and "Expanded Autoselect Code Tables" in ■DEVICE BUS OPERATION.)

All manufacturer and device codes will exhibit odd parity with DQ_7 defined as the parity bit. Sector state (protection or unprotection) will be informed by address (BA)02h for ×16 ((BA)04h for ×8). Scanning the sector group addresses (A_{19}, A_{18}, A_{17}, A_{16}, A_{15}, A_{14}, A_{13}, and A_{12}) while (A_6, A_1, A_0) = (0, 1, 0) will produce a logical "1" at device output DQ_0 for a protected sector group. The programming verification should be performed by verify sector group protection on the protected sector. (See "MBM29DL16XTE/BE User Bus Operations Tables ($\overline{BYTE}$ = V_{IH} and $\overline{BYTE}$ = V_{IL})" in ■DEVICE BUS OPERATION.)

The manufacture and device codes can be allowed reading from selected bank. To read the manufacture and device codes and sector group protection status from non-selected bank, it is necessary to write Read/Reset command sequence into the register and then Autoselect command should be written into the bank to be read.

If the software (program code) for Autoselect command is stored into the Flash memory, the device and manufacture codes should be read from the other bank where is not contain the software.

To terminate the operation, it is necessary to write the Read/Reset command sequence into the register, and also to write the Autoselect command during the operation, execute it after writing Read/Reset command sequence.

• Byte/Word Programming

The devices are programmed on a byte-by-byte (or word-by-word) basis. Programming is a four bus cycle operation. There are two "unlock" write cycles. These are followed by the program set-up command and data write cycles. Addresses are latched on the falling edge of $\overline{CE}$ or $\overline{WE}$, whichever happens later and the data is latched on the rising edge of $\overline{CE}$ or $\overline{WE}$, whichever happens first. The rising edge of $\overline{CE}$ or $\overline{WE}$ (whichever happens first) begins programming. Upon executing the Embedded Program Algorithm command sequence, the system is not required to provide further controls or timings. The device will automatically provide adequate internally generated program pulses and verify the programmed cell margin.

The system can determine the status of the program operation by using DQ_7 ($\overline{Data}$ Polling), DQ_6 (Toggle Bit), or $RY/\overline{BY}$. The $\overline{Data}$ Polling and Toggle Bit must be performed at the memory location which is being programmed.

The automatic programming operation is completed when the data on DQ_7 is equivalent to data written to this bit at which time the devices return to the read mode and addresses are no longer latched. (See "Hardware Sequence Flags Table".) Therefore, the devices require that a valid address to the devices be supplied by the system at this particular instance of time. Hence, $\overline{Data}$ Polling must be performed at the memory location which is being programmed.

Any commands written to the chip during this period will be ignored. If hardware reset occurs during the programming operation, it is impossible to guarantee the data are being written.

Programming is allowed in any sequence and across sector boundaries. Beware that a data "0" cannot be programmed back to a "1". Attempting to do so may either hang up the device or result in an apparent success according to the data polling algorithm but a read from Read/Reset mode will show that the data is still "0". Only erase operations can convert "0"s to "1"s.

"(1) Embedded Program™ Algorithm" in ■FLOW CHART illustrates the Embedded Program™ Algorithm using typical command strings and bus operations.

• Program Suspend/Resume

The Program Suspend command allows the system to interrupt a program operation so that data can be read from any address.Writing the Program Suspend command (B0h) during the Embedded Program operation immediately suspends the programming.The Program Suspend command mav also be issued during a programming operation while an erase is suspend.The bank addresses of sector being programed should be set when writing the Program Suspend command.

When the Program Suspend command is written during a programming process , the device halts the program operation within 1 µs and updates the status bits.

After the program operation has been suspended, the system can read data from any address.The data at program-suspend address is not valid. Normal read timing and command definitions apply.

After the Program Resume command (30h) is written, the device reverts to programming. The bank addresses of sector being suspended should be set when writing the Program Resume command. The system can determine the status of the program operation using the DQ_7 or DQ_6 status bits, just as in the standard program operation.See "Write Operation Status" for more information.

The system may also write the autoselect command sequence when the device in the Program Suspend mode.

The device allows reading autoselect codes at the addresses within programming sectors, since the codes are not stored in the memory. When the device exits the autoselect mode, the device reverts to the Program Suspend mode, and is ready for another valid operation. See"Autoselect Command" for more information.

The system must write the Program Resume command (address bits are "Bank Address") to exit the Program Suspend mode and continue the programming operation. Further writes of the Resume command are ignored. Another Program Suspend command can be written after the device has resume programming.

• Chip Erase

Chip erase is a six bus cycle operation. There are two "unlock" write cycles. These are followed by writing the "set-up" command. Two more "unlock" write cycles are then followed by the chip erase command.

Chip erase does not require the user to program the device prior to erase. Upon executing the Embedded Erase Algorithm command sequence the devices will automatically program and verify the entire memory for an all zero data pattern prior to electrical erase (Preprogram function). The system is not required to provide any controls or timings during these operations.

The system can determine the status of the erase operation by using DQ_7 ($\overline{Data}$ Polling), DQ_6 (Toggle Bit), or $RY/\overline{BY}$. The chip erase begins on the rising edge of the last $\overline{CE}$ or $\overline{WE}$, whichever happens first in the command sequence and terminates when the data on DQ_7 is "1" (See "Write Operation Status".) at which time the device returns to read the mode.

Chip Erase Time; Sector Erase Time $\times$ All sectors + Chip Program Time (Preprogramming)

"(2) Embedded Erase™ Algorithm" in ■FLOW CHART illustrates the Embedded Erase™ Algorithm using typical command strings and bus operations.

• Sector Erase

Sector erase is a six bus cycle operation. There are two "unlock" write cycles. These are followed by writing the "set-up" command. Two more "unlock" write cycles are then followed by the Sector Erase command. The sector address (any address location within the desired sector) is latched on the falling edge of $\overline{CE}$ or $\overline{WE}$ whichever happens later, while the command (Data = 30h) is latched on the rising edge of $\overline{CE}$ or $\overline{WE}$ which happens first. After time-out of "t_{TOW}" from the rising edge of the last sector erase command, the sector erase operation will begin.

Multiple sectors may be erased concurrently by writing the six bus cycle operations on "MBM29DL16XTE/BE Command Definitions Table" in ■DEVICE BUS OPERATION. This sequence is followed with writes of the Sector Erase command to addresses in other sectors desired to be concurrently erased. The time between writes must be less than "t_{TOW}" otherwise that command will not be accepted and erasure will start. It is recommended that processor interrupts be disabled during this time to guarantee this condition. The interrupts can be re-enabled after the last Sector Erase command is written. A time-out of "t_{TOW}" from the rising edge of last $\overline{CE}$ or $\overline{WE}$ whichever happens first will initiate the execution of the Sector Erase command(s). If another falling edge of $\overline{CE}$ or $\overline{WE}$, whichever happens first occurs within the "t_{TOW}" time-out window the timer is reset. (Monitor DQ_3 to determine if the sector erase timer window is still open, see section DQ_3, Sector Erase Timer.) Any command other than Sector Erase or Erase Suspend during this time-out period will reset the devices to the read mode, ignoring the previous command string. Resetting the devices once execution has begun will corrupt the data in the sector.

In that case, restart the erase on those sectors and allow them to complete. (Refer to the Write Operation Status section for Sector Erase Timer operation.) Loading the sector erase buffer may be done in any sequence and with any number of sectors (0 to 38).

Sector erase does not require the user to program the devices prior to erase. The devices automatically program all memory locations in the sector(s) to be erased prior to electrical erase (Preprogram function). When erasing a sector or sectors the remaining unselected sectors are not affected. The system is not required to provide any controls or timings during these operations.

The system can determine the status of the erase operation by using DQ_7 ($\overline{Data}$ Polling), DQ_6 (Toggle Bit), or RY/$\overline{BY}$.

The sector erase begins after the "t_{TOW}" time out from the rising edge of $\overline{CE}$ or $\overline{WE}$ whichever happens first for the last sector erase command pulse and terminates when the data on DQ_7 is "1" (See "Write Operation Status".) at which time the devices return to the read mode. $\overline{Data}$ polling and Toggle Bit must be performed at an address within any of the sectors being erased.

Multiple Sector Erase Time; [Sector Erase Time + Sector Program Time (Preprogramming)] × Number of Sector Erase

In case of multiple sector erase across bank boundaries, a read from bank (read-while-erase) can not performe.

"(2) Embedded Erase™ Algorithm" in ■FLOW CHART illustrates the Embedded Erase™ Algorithm using typical command strings and bus operations.

• **Erase Suspend/Resume**

The Erase Suspend command allows the user to interrupt a Sector Erase operation and then perform data reads from or programs to a sector not being erased. This command is applicable ONLY during the Sector Erase operation which includes the time-out period for sector erase. The Erase Suspend command will be ignored if written during the Chip Erase operation or Embedded Program Algorithm. Writting the Erase Suspend command (B0h) during the Sector Erase time-out results in immediate termination of the time-out period and suspension of the erase operation.

Writing the Erase Resume command (30h) resumes the erase operation. The bank addresses of sector being erasing or suspending should be set when writting the Erase Suspend or Erase Resume command.

When the Erase Suspend command is written during the Sector Erase operation, the device will take a maximum of "t_{SPD}" to suspend the erase operation. When the devices have entered the erase-suspended mode, the RY/$\overline{BY}$ output pin will be at High-Z and the DQ_7 bit will be at logic "1", and DQ_6 will stop toggling. The user must use the address of the erasing sector for reading DQ_6 and DQ_7 to determine if the erase operation has been suspended. Further writes of the Erase Suspend command are ignored.

When the erase operation has been suspended, the devices default to the erase-suspend-read mode. Reading data in this mode is the same as reading from the standard read mode except that the data must be read from sectors that have not been erase-suspended. Successively reading from the erase-suspended sector while the device is in the erase-suspend-read mode will cause DQ_2 to toggle. (See "DQ_2".)

After entering the erase-suspend-read mode, the user can program the device by writing the appropriate command sequence for Program. This program mode is known as the erase-suspend-program mode. Again, programming in this mode is the same as programming in the regular Program mode except that the data must be programmed to sectors that are not erase-suspended. Successively reading from the erase-suspended sector while the devices are in the erase-suspend-program mode will cause DQ_2 to toggle. The end of the erase-suspended Program operation is detected by the RY/$\overline{BY}$ output pin, $\overline{Data}$ polling of DQ_7 or by the Toggle Bit I (DQ_6) which is the same as the regular Program operation. Note that DQ_7 must be read from the Program address while DQ_6 can be read from any address within bank being erase-suspended.

To resume the operation of Sector Erase, the Resume command (30h) should be written to the bank being erase suspended. Any further writes of the Resume command at this point will be ignored. Another Erase Suspend command can be written after the chip has resumed erasing.

• Extended Command

(1) Fast Mode

MBM29DL16XTE/BE have Fast Mode function. This mode dispenses with the initial two unclock cycles required in the standard program command sequence by writing Fast Mode command into the command register. In this mode, the required bus cycle for programming is two cycles instead of four bus cycles in standard program command. (Do not write erase command in this mode.) The read operation is also executed after exiting this mode. To exit this mode, it is necessary to write Fast Mode Reset command into the command register. The first cycle must contain the bank address. (Refer to "(7) Embedded Program^{TM} Algorithm for Fast Mode" in ■FLOW CHART.) The V_{CC} active current is required even $\overline{CE} = V_{IH}$ during Fast Mode.

(2) Fast Programming

During Fast Mode, the programming can be executed with two bus cycles operation. The Embedded Program Algorithm is executed by writing program set-up command (A0h) and data write cycles (PA/PD). (Refer to "(7) Embedded Program^{TM} Algorithm for Fast Mode" in ■FLOW CHART.)

(3) Extended Sector Group Protection

In addition to normal sector group protection, the MBM29DL16XTE/BE have Extended Sector Group Protection as extended function. This function enables to protect sector group by forcing V_{ID} on $\overline{RESET}$ pin and write a command sequence. Unlike conventional procedure, it is not necessary to force V_{ID} and control timing for control pins. The extended sector group protection requires V_{ID} on $\overline{RESET}$ pin only. With this condition, the operation is initiated by writing the set-up command (60h) into the command register. Then, the sector group addresses pins (A_{20}, A_{19}, A_{18}, A_{17}, A_{16}, A_{15}, A_{14}, A_{13} and A_{12}) and (A_6, A_1, A_0) = (0, 1, 0) should be set to the sector group to be protected (recommend to set V_{IL} for the other addresses pins), and write extended sector group protection command (60h). A sector group is typically protected in 250 μs. To verify programming of the protection circuitry, the sector group addresses pins (A_{20}, A_{19}, A_{18}, A_{17}, A_{16}, A_{15}, A_{14}, A_{13} and A_{12}) and (A_6, A_1, A_0) = (0, 1, 0) should be set and write a command (40h). Following the command write, a logical "1" at device output DQ_0 will produce for protected sector in the read operation. If the output data is logical "0", please repeat to write extended sector group protection command (60h) again. To terminate the operation, it is necessary to set $\overline{RESET}$ pin to V_{IH}. (Refer to "(17) Extended Sector Group Protection Timing Diagram" in ■TIMING DIAGRAM and "(8) Extended Sector Group Protection Algorithm" in ■FLOW CHART.)

(4) CFI (Common Flash Memory Interface)

The CFI (Common Flash Memory Interface) specification outlines device and host system software interrogation handshake which allows specific vendor-specified software algorithms to be used for entire families of devices. This allows device-independent, JEDEC ID-independent, and forward-and backward-compatible software support for the specified flash device families. Refer to CFI specification in detail.

The operation is initiated by writing the query command (98h) into the command register. The bank address should be set when writing this command. Then the device information can be read from the bank, and an actual data of memory cell be read from the another bank. Following the command write, a read cycle from specific address retrives device information. Please note that output data of upper byte (DQ_{15} to DQ_8) is "0" in word mode (16 bit) read. Refer to "Common Flash Memory Interface Code Table" in ■FLEXBLE SECTOR-ERASE ARCHITECTURE. To terminate operation, it is necessary to write the read/reset command sequence into the register. (See "Common Flash Memory Interface Code Table" in ■FLEXIBLE SECTOR-ERASE ARCHITECTURE.)

• HiddenROM Region

The HiddenROM feature provides a Flash memory region that the system may access through a new command sequence. This is primarily intended for customers who wish to use an Electronic Serial Number (ESN) in the device with the ESN protected against modification. Once the HiddenROM region is protected, any further modification of that region is impossible. This ensures the security of the ESN once the product is shipped to the field.

The HiddenROM region is 64 Kbytes in length and is stored at the same address of the 8 KB ×8 sectors. The MBM29DL16XTE occupies the address of the byte mode 1F0000h to 1FFFFFh (word mode 0F8000h to 0FFFFFh) and the MBM29DL16XBE type occupies the address of the byte mode 000000h to 00FFFFh (word mode 000000h to 007FFFh). After the system has written the Enter HiddenROM command sequence, the system may read the HiddenROM region by using the addresses normally occupied by the boot sectors. That is, the device sends all commands that would normally be sent to the boot sectors to the HiddenROM region. This mode of operation continues until the system issues the Exit HiddenROM command sequence, or until power is removed from the device. On power-up, or following a hardware reset, the device reverts to sending commands to the boot sectors.

• HiddenROM Entry Command

MBM29DL16XTE/BE have a HiddenROM area with One Time Protect function. This area is to enter the security code and to unable the change of the code once set. Program/erase is possible in this area until it is protected. However, once it is protected, it is impossible to unprotect, so please use this with caution.

HiddenROM area is 64 Kbyte and in the same address area of 8 KB sectors. The address of top boot is 1F0000h to 1FFFFFh at byte mode (0F8000h to 0FFFFFh at word mode) and the bottom boot is 000000h to 00FFFFh at byte mode (000000h to 007FFFh at word mode). These areas are normally the boot block area (8 KB × 8 sectors). Therefore, write the HiddenROM entry command sequence to enter the HiddenROM area. It is called as HiddenROM mode when the HiddenROM area appears.

Sector other than the boot block area could be read during HiddenROM mode. Read/program/earse of the HiddenROM area is possible during HiddenROM mode. Write the HiddenROM reset command sequence to exit the HiddenROM mode. The bank address of the HiddenROM should be set on the third cycle of this reset command sequence.

In case of MBM29DL161TE/BE, whose Bank 1 size is 0.5 Mbit, the simultaneous operation cannot execute multi-function mode between the HiddenROM area and Bank 2 Region.

• HiddenROM Program Command

To program the data to the HiddenROM area, write the HiddenROM program command sequence during HiddenROM mode. This command is the same as the program command in the past except to write the command during HiddenROM mode. Therefore the detection of completion method is the same as in the past, using the DQ_7 data poling, DQ_6 toggle bit and RY/$\overline{BY}$ pin. Need to pay attention to the address to be programmed. If the address other than the HiddenROM area is selected to program, the data of the address will be changed.

• HiddenROM Erase Command

To erase the HiddenROM area, write the HiddenROM erase command sequence during HiddenROM mode. This command is the same as the sector erase command in the past except to write the command during HiddenROM mode. Therefore the detection of completion method is the same as in the past, using the DQ_7 data poling, DQ_6 toggle bit and RY/$\overline{BY}$ pin. Need to pay attention to the sector address to be erased. If the sector address other than the HiddenROM area is selected, the data of the sector will be changed.

• HiddenROM Protect Command

There are two methods to protect the HiddenROM area. One is to write the sector group protect setup command (60h), set the sector address in the HiddenROM area and (A_6, A_1, A_0) = (0,1,0), and write the sector group protect command (60h) during the HiddenROM mode. The same command sequence could be used because except that it is in the HiddenROM mode and that it does not apply high voltage to $\overline{RESET}$ pin, it is the same as the extension sector group protect in the past. Please refer to "Extended Command (3) Extended Sector Group Protection" for details of extention sector group protect setting.

The other is to apply high voltage (V_{ID}) to A_9 and $\overline{OE}$, set the sector address in the HiddenROM area and (A_6, A_1, A_0) = (0,1,0), and apply the write pulse during the HiddenROM mode. To verify the protect circuit, apply high voltage (V_{ID}) to A_9, specify (A_6, A_1, A_0) = (0,1,0) and the sector address in the HiddenROM area, and read. When "1" appears to DQ_0, the protect setting is completed. "0" will appear to DQ_0 if it is not protected. Please apply write pulse agian. The same command sequence could be used for the above method because other than the HiddenROM mode, it is the same as the sector group protect in the past. Please refer to "Sector Group Protection" in ■FUNCTIONAL DESCRIPTION for details of sector group protect setting

Other sector group will be effected if the address other than the HiddenROM area is selected for the sector group address, so please be carefull. Once it is protected, protection can not be cancelled, so please pay closest attention.

• Write Operation Status

Detailed in "Hardware Sequence Flags Table" are all the status flags that can determine the status of the bank for the current mode operation. The read operation from the bank where is not operate Embedded Algorithm returns a data of memory cell. These bits offer a method for determining whether a Embedded Algorithm is completed properly. Information on DQ_2 is address sensitive. This means that if an address from an erasing sector is consectively read, then the DQ_2 bit will toggle. However, DQ_2 will not toggle if an address from a non-erasing sector is consectively read. This allows the user to determine which sectors are erasing and which are not.

The status flag is not output from bank (non-busy bank) not executing Embedded Algorithm. For example, there is bank (busy bank) which is now executing Embedded Algorithm. When the read sequence is [1] <busy bank>, [2] <non-busy bank>, [3] <busy bank>, the DQ_6 is toggling in the case of [1] and [3]. In case of [2], the data of memory cell is outputted. In the erase-suspend read mode with the same read sequence, DQ_6 will not be toggled in the [1] and [3].

In the erase suspend read mode, DQ_2 is toggled in the [1] and [3]. In case of [2], the data of memory cell is outputted.

Hardware Sequence Flags Table

Status			DQ$_7$	DQ$_6$	DQ$_5$	DQ$_3$	DQ$_2$
In Progress	Embedded Program Algorithm		$\overline{DQ_7}$	Toggle	0	0	1
	Embedded Erase Algorithm		0	Toggle	0	1	Toggle*1
	Erase Suspended Mode	Erase Suspend Read (Erase Suspended Sector)	1	1	0	0	Toggle
		Erase Suspend Read (Non-Erase Suspended Sector)	Data	Data	Data	Data	Data
		Erase Suspend Program (Non-Erase Suspended Sector)	$\overline{DQ_7}$	Toggle	0	0	1 *2
	Program Suspended Mode	Program Suspend Read (Program Suspended Sector)	Data	Data	Data	Data	Data
		Program Suspend Read (Non-Program Suspended Sector)	Data	Data	Data	Data	Data
Exceeded Time Limits	Embedded Program Algorithm		$\overline{DQ_7}$	Toggle	1	0	1
	Embedded Erase Algorithm		0	Toggle	1	1	N/A
	Erase Suspended Mode	Erase Suspend Program (Non-Erase Suspended Sector)	$\overline{DQ_7}$	Toggle	1	0	N/A

*1 : Successive reads from the erasing or erase-suspend sector cause DQ$_2$ to toggle.

*2 : Reading from non-erase suspend sector address indicates logic "1" at the DQ$_2$ bit.

- **DQ$_7$**

$\overline{Data}$ Polling

   The MBM29DL16XTE/BE devices feature $\overline{Data}$ Polling as a method to indicate to the host that the Embedded Algorithms are in progress or completed. During the Embedded Program Algorithm an attempt to read the devices will produce the complement of the data last written to DQ$_7$. Upon completion of the Embedded Program Algorithm, an attempt to read the device will produce the true data last written to DQ$_7$. During the Embedded Erase Algorithm, an attempt to read the device will produce a "0" at the DQ$_7$ output. Upon completion of the Embedded Erase Algorithm an attempt to read the device will produce a "1" at the DQ$_7$ output. The flowchart for $\overline{Data}$ Polling (DQ$_7$) is shown in "(3) $\overline{Data}$ Polling Algorithm" in ■FLOW CHART.

   For programming, the $\overline{Data}$ Polling is valid after the rising edge of fourth write pulse in the four write pulse sequence.

   For chip erase and sector erase, the $\overline{Data}$ Polling is valid after the rising edge of the sixth write pulse in the six write pulse sequence. $\overline{Data}$ Polling must be performed at sector address within any of the sectors being erased and not a protected sector. Otherwise, the status may not be valid.

   If a program address falls within a protected sector, $\overline{Data}$ Polling on DQ$_7$ is active for approximately 1 μs, then that bank returns to the read mode. After an erase command sequence is written, if all sectors selected for erasing are protected, $\overline{Data}$ Polling on DQ$_7$ is active for approximately 400 μs, then the bank returns to read mode.

   Once the Embedded Algorithm operation is close to being completed, the MBM29DL16XTE/BE data pins (DQ$_7$) may change asynchronously while the output enable ($\overline{OE}$) is asserted low. This means that the devices are

driving status information on DQ_7 at one instant of time and then that byte's valid data at the next instant of time. Depending on when the system samples the DQ_7 output, it may read the status or valid data. Even if the device has completed the Embedded Algorithm operation and DQ_7 has a valid data, the data outputs on DQ_6 to DQ_0 may be still invalid. The valid data on DQ_7 to DQ_0 will be read on the successive read attempts.

The $\overline{\text{Data}}$ Polling feature is only active during the Embedded Programming Algorithm, Embedded Erase Algorithm or sector erase time-out. (See "Hardware Sequence Flags Table".)

See "(6) AC Waveforms for $\overline{\text{Data}}$ Polling during Embedded Algorithm Operations" in ■TIMING DIAGRAM for the $\overline{\text{Data}}$ Polling timing specifications and diagrams.

• DQ_6

Toggle Bit I

The MBM29DL16XTE/BE also feature the "Toggle Bit I" as a method to indicate to the host system that the Embedded Algorithms are in progress or completed.

During an Embedded Program or Erase Algorithm cycle, successive attempts to read ($\overline{\text{CE}}$ or $\overline{\text{OE}}$ toggling) data from the devices will result in DQ_6 toggling between "1" and "0". Once the Embedded Program or Erase Algorithm cycle is completed, DQ_6 will stop toggling and valid data will be read on the next successive attempts. During programming, the Toggle Bit I is valid after the rising edge of the fourth write pulse in the four write pulse sequence. For chip erase and sector erase, the Toggle Bit I is valid after the rising edge of the sixth write pulse in the six write pulse sequence. The Toggle Bit I is active during the sector time out.

In programming, if the sector being written to is protected, the toggle bit will toggle for about 1 µs and then stop toggling without the data having changed. In erase, the devices will erase all the selected sectors except for the ones that are protected. If all selected sectors are protected, the chip will toggle the toggle bit for about 400 µs and then drop back into read mode, having changed none of the data.

Either $\overline{\text{CE}}$ or $\overline{\text{OE}}$ toggling will cause the DQ_6 to toggle. In addition, an Erase Suspend/Resume command will cause the DQ_6 to toggle.

The system can use DQ_6 to determine whether a sector is actively erasing or is erase-suspended. When a bank is actively erasing (that is, the Embedded Erase Algorithm is in progress), DQ_6 toggles. When a bank enters the Erase Suspend mode, DQ_6 stops toggling. Successive read cycles during the erase-suspend-program cause DQ_6 to toggle.

To operate toggle bit function properly, $\overline{\text{CE}}$ or $\overline{\text{OE}}$ must be high when bank address is changed.

See "(7) AC Waveforms for Toggle Bit I during Embedded Algorithm Operations" in ■TIMING DIAGRAM for the Toggle Bit I timing specifications and diagrams.

• DQ_5

Exceeded Timing Limits

DQ_5 will indicate if the program or erase time has exceeded the specified limits (internal pulse count). Under these conditions DQ_5 will produce a "1". This is a failure condition which indicates that the program or erase cycle was not successfully completed. $\overline{\text{Data}}$ Polling is the only operating function of the devices under this condition. The $\overline{\text{CE}}$ circuit will partially power down the device under these conditions (to approximately 2 mA). The $\overline{\text{OE}}$ and $\overline{\text{WE}}$ pins will control the output disable functions as described in "MBM29DL16XTE/BE User Bus Operations Tables ($\overline{\text{BYTE}} = V_{IH}$ and $\overline{\text{BYTE}} = V_{IL}$)" in ■DEVICE BUS OPERATION.

The DQ_5 failure condition may also appear if a user tries to program a non blank location without erasing. In this case the devices lock out and never complete the Embedded Algorithm operation. Hence, the system never reads a valid data on DQ_7 bit and DQ_6 never stops toggling. Once the devices have exceeded timing limits, the

DQ_5 bit will indicate a "1." Please note that this is not a device failure condition since the devices were incorrectly used. If this occurs, reset the device with command sequence.

• DQ_3

Sector Erase Timer

After the completion of the initial sector erase command sequence the sector erase time-out will begin. DQ_3 will remain low until the time-out is complete. $\overline{Data}$ Polling and Toggle Bit are valid after the initial sector erase command sequence.

If $\overline{Data}$ Polling or the Toggle Bit I indicates the device has been written with a valid erase command, DQ_3 may be used to determine if the sector erase timer window is still open. If DQ_3 is high ("1") the internally controlled erase cycle has begun; attempts to write subsequent commands to the device will be ignored until the erase operation is completed as indicated by $\overline{Data}$ Polling or Toggle Bit I. If DQ_3 is low ("0"), the device will accept additional sector erase commands. To insure the command has been accepted, the system software should check the status of DQ_3 prior to and following each subsequent Sector Erase command. If DQ_3 were high on the second status check, the command may not have been accepted.

See "Hardware Sequence Flags Table".

• DQ_2

Toggle Bit II

This toggle bit II, along with DQ_6, can be used to determine whether the devices are in the Embedded Erase Algorithm or in Erase Suspend.

Successive reads from the erasing sector will cause DQ_2 to toggle during the Embedded Erase Algorithm. If the devices are in the erase-suspended-read mode, successive reads from the erase-suspended sector will cause DQ_2 to toggle. When the devices are in the erase-suspended-program mode, successive reads from the byte address of the non-erase suspended sector will indicate a logic "1" at the DQ_2 bit.

DQ_6 is different from DQ_2 in that DQ_6 toggles only when the standard program or Erase, or Erase Suspend Program operation is in progress. The behavior of these two status bits, along with that of DQ_7, is summarized as follows:

For example, DQ_2 and DQ_6 can be used together to determine if the erase-suspend-read mode is in progress. (DQ_2 toggles while DQ_6 does not.) See also "Toggle Bit Status Table" and "(9) DQ_2 vs. DQ_6" in ■TIMING DIAGRAM.

Furthermore, DQ_2 can also be used to determine which sector is being erased. When the device is in the erase mode, DQ_2 toggles if this bit is read from an erasing sector.

To operate toggle bit function properly, $\overline{CE}$ or $\overline{OE}$ must be high when bank address is changed.

• Reading Toggle Bits DQ_6/DQ_2

Whenever the system initially begins reading toggle bit status, it must read DQ_7 to DQ_0 at least twice in a row to determine whether a toggle bit is toggling. Typically a system would note and store the value of the toggle bit after the first read. After the second read, the system would compare the new value of the toggle bit with the first. If the toggle bit is not toggling, the device has completed the program or erase operation. The system can read array data on DQ_7 to DQ_0 on the following read cycle.

However, if, after the initial two read cycles, the system determines that the toggle bit is still toggling, the system also should note whether the value of DQ_5 is high (see the section on "DQ_5"). If it is, the system should then determine again whether the toggle bit is toggling, since the toggle bit may have stopped toggling just as DQ_5 went high. If the toggle bit is no longer toggling, the device has successfully completed the program or erase

operation. If it is still toggling, the device did not complete the operation successfully, and the system must write the reset command to return to reading array data.

The remaining scenario is that the system initially determines that the toggle bit is toggling and DQ_5 has not gone high. The system may continue to monitor the toggle bit and DQ_5 through successive read cycles, determining the status as described in the previous paragraph. Alternatively, it may choose to perform other system tasks. In this case, the system must start at the begining of the algorithm when it returns to determine the status of the operation. (Refer to "(4) Toggle Bit Algorithm" in ■FLOW CHART.)

Toggle Bit Status Table

Mode	DQ_7	DQ_6	DQ_2
Program	$\overline{DQ_7}$	Toggle	1
Erase	0	Toggle	Toggle*1
Erase-Suspend Read (Erase-Suspended Sector)	1	1	Toggle
Erase-Suspend Program	$\overline{DQ_7}$	Toggle	1*2

*1 : Successive reads from the erasing or erase-suspend sector cause DQ_2 to toggle.

*2 : Reading from the non-erase suspend sector address indicates logic "1" at the DQ_2 bit.

• **RY/$\overline{BY}$**

Ready/Busy

The MBM29DL16XTE/BE provide a RY/$\overline{BY}$ open-drain output pin as a way to indicate to the host system that the Embedded Algorithms are either in progress or has been completed. If the output is low, the devices are busy with either a program or erase operation. If the output is high, the devices are ready to accept any read/write or erase operation. When the RY/$\overline{BY}$ pin is low, the devices will not accept any additional program or erase commands. If the MBM29DL16XTE/BE are placed in an Erase Suspend mode, the RY/$\overline{BY}$ output will be high.

During programming, the RY/$\overline{BY}$ pin is driven low after the rising edge of the fourth write pulse. During an erase operation, the RY/$\overline{BY}$ pin is driven low after the rising edge of the sixth write pulse. The RY/$\overline{BY}$ pin will indicate a busy condition during the $\overline{RESET}$ pulse. Refer to "(10) RY/$\overline{BY}$ Timing Diagram during Program/Erase Operations" and "(11) $\overline{RESET}$, RY/$\overline{BY}$ Timing Diagram" in ■TIMING DIAGRAM for a detailed timing diagram. The RY/$\overline{BY}$ pin is pulled high in standby mode.

Since this is an open-drain output, the pull-up resistor needs to be connected to V_{CC} ; multiples of devices may be connected to the host system via more than one RY/$\overline{BY}$ pin in parallel.

• **Data Protection**

The MBM29DL16XTE/BE are designed to offer protection against accidental erasure or programming caused by spurious system level signals that may exist during power transitions. During power up the devices automatically reset the internal state machine in the Read mode. Also, with its control register architecture, alteration of the memory contents only occurs after successful completion of specific multi-bus cycle command sequences.

The devices also incorporate several features to prevent inadvertent write cycles resulting form V_{CC} power-up and power-down transitions or system noise.

• Low V_CC Write Inhibit

To avoid initiation of a write cycle during V_CC power-up and power-down, a write cycle is locked out for V_CC less than V_LKO (Min). If V_CC < V_LKO, the command register is disabled and all internal program/erase circuits are disabled. Under this condition the device will reset to the read mode. Subsequent writes will be ignored until the V_CC level is greater than V_LKO. It is the users responsibility to ensure that the control pins are logically correct to prevent unintentional writes when V_CC is above V_LKO (Min).

If Embedded Erase Algorithm is interrupted, there is possibility that the erasing sector(s) cannot be used.

• Write Pulse "Glitch" Protection

Noise pulses of less than 3 ns (typical) on $\overline{OE}$, $\overline{CE}$, or $\overline{WE}$ will not initiate a write cycle.

• Logical Inhibit

Writing is inhibited by holding any one of $\overline{OE}$ = V_IL, $\overline{CE}$ = V_IH, or $\overline{WE}$ = V_IH. To initiate a write cycle $\overline{CE}$ and $\overline{WE}$ must be a logic "0" while $\overline{OE}$ is a logic "1".

• Power-Up Write Inhibit

Power-up of the devices with $\overline{WE}$ = $\overline{CE}$ = V_IL and $\overline{OE}$ = V_IH will not accept commands on the rising edge of $\overline{WE}$. The internal state machine is automatically reset to the read mode on power-up.

• Sector Group Protection

Device user is able to protect each sector group individually to store and protect data. Protection circuit voids both program and erase commands that are addressed to protected sectors.

Any command to program or erase addressed to protected sector are ignored (see "Sector Group Protection" in ■ FUNCTIONAL DESCRIPTION).

■ ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rating		Unit
		Min	Max	
Storage Temperature	Tstg	–55	+125	°C
Ambient Temperature with Power Applied	T_A	–40	+85	°C
Voltage with Respect to Ground All Pins except A_9, $\overline{OE}$, $\overline{RESET}$ [*1, *2]	V_{IN}, V_{OUT}	–0.5	V_{CC}+0.5	V
Power Supply Voltage [*1]	V_{CC}	–0.5	+4.0	V
A_9, $\overline{OE}$, and $\overline{RESET}$ [*1, *3]	V_{IN}	–0.5	+13.0	V
$\overline{WP}$/ACC [*1, *4]	V_{ACC}	–0.5	+10.5	V

*1 : Voltage is defined on the basis of V_{SS} = GND = 0 V.

*2 : Minimum DC voltage on input or I/O pins is –0.5 V. During voltage transitions, input or I/O pins may undershoot V_{SS} to –2.0 V for periods of up to 20 ns. Maximum DC voltage on input or I/O pins is V_{CC} +0.5 V. During voltage transitions, input or I/O pins may overshoot to V_{CC} +2.0 V for periods of up to 20 ns.

*3 : Minimum DC input voltage on A_9, $\overline{OE}$ and $\overline{RESET}$ pins is –0.5 V. During voltage transitions, A_9, $\overline{OE}$ and $\overline{RESET}$ pins may undershoot V_{SS} to –2.0 V for periods of up to 20 ns. Voltage difference between input and supply voltage (V_{IN}–V_{CC}) does not exceed 9.0 V. Maximum DC input voltage on A_9, $\overline{OE}$ and $\overline{RESET}$ pins is +13.0 V which may overshoot to +14.0 V for periods of up to 20 ns.

*4 : Minimum DC input voltage on $\overline{WP}$/ACC pin is –0.5 V. During voltage transitions, $\overline{WP}$/ACC pin may undershoot V_{SS} to –2.0 V for periods of up to 20 ns. Maximum DC input voltage on $\overline{WP}$/ACC pin is +10.5 V which may overshoot to +12.0 V for periods of up to 20 ns when Vcc is applied.

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Conditions	Value		Unit
			Min	Max	
Ambient Temperature	T_A	MBM29DL16XTE/BE70/90	–40	+85	°C
Power Supply Voltage*	V_{CC}	MBM29DL16XTE/BE70/90	+2.7	+3.6	V

* : Voltage is defined on the basis of V_{SS} = GND = 0 V.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

■ **MAXIMUM OVERSHOOT/MAXIMUM UNDERSHOOT**

+0.6 V
−0.5 V
−2.0 V
20 ns
20 ns
20 ns
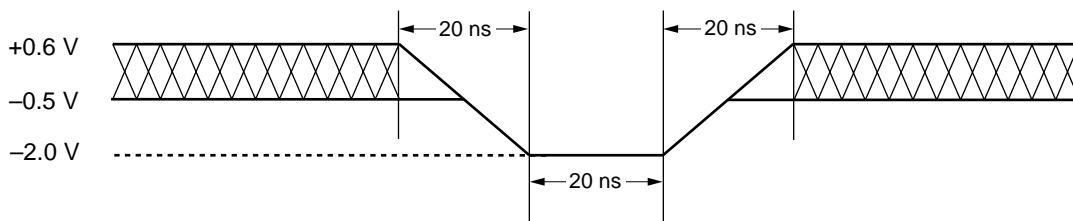
Maximum Undershoot Waveform

V_{CC} +2.0 V
V_{CC} +0.5 V
+2.0 V
20 ns
20 ns
20 ns

Maximum Overshoot Waveform 1

+14.0 V
+13.0 V
V_{CC} +0.5 V
20 ns
20 ns
20 ns
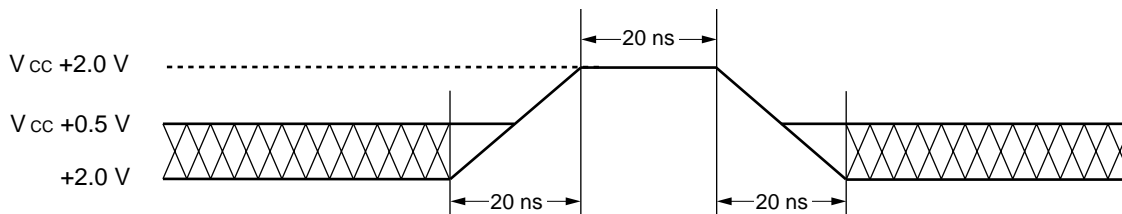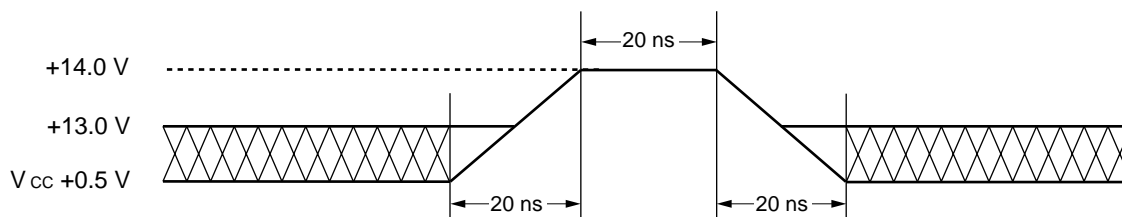
Note: This waveform is applied for A_9, $\overline{OE}$, and $\overline{RESET}$.

Maximum Overshoot Waveform 2

■ ELECTRICAL CHARACTERISTICS

1. DC Characteristics

Parameter	Symbol	Conditions		Value			Unit
				Min	Typ	Max	
Input Leakage Current	I_{LI}	$V_{IN} = V_{SS}$ to V_{CC}, $V_{CC} = V_{CC}$ Max		−1.0	—	+1.0	μA
Output Leakage Current	I_{LO}	$V_{OUT} = V_{SS}$ to V_{CC}, $V_{CC} = V_{CC}$ Max		−1.0	—	+1.0	μA
A_9, $\overline{OE}$, $\overline{RESET}$ Inputs Leakage Current	I_{LIT}	$V_{CC} = V_{CC}$ Max, A_9, $\overline{OE}$, $\overline{RESET}$ = 12.5 V		—	—	+35	μA
$\overline{WP}$/ACC Accelerated Program Current	I_{LIA}	$V_{CC} = V_{CC}$ Max, $\overline{WP}$/ACC = V_{ACC} Max		—	—	20	mA
V_{CC} Active Current *1	I_{CC1}	$\overline{CE} = V_{IL}$, $\overline{OE} = V_{IH}$, f = 5 MHz	Byte	—	—	13	mA
			Word	—	—	15	
		$\overline{CE} = V_{IL}$, $\overline{OE} = V_{IH}$, f = 1 MHz	Byte	—	—	7	mA
			Word	—	—	7	
V_{CC} Active Current *2	I_{CC2}	$\overline{CE} = V_{IL}$, $\overline{OE} = V_{IH}$		—	—	35	mA
V_{CC} Current (Standby)	I_{CC3}	$V_{CC} = V_{CC}$ Max, $\overline{CE} = V_{CC} \pm 0.3$ V, $\overline{RESET} = V_{CC} \pm 0.3$ V, $\overline{WP}$/ACC = $V_{CC} \pm 0.3$ V		—	1	5	μA
V_{CC} Current (Standby, Reset)	I_{CC4}	$V_{CC} = V_{CC}$ Max, $\overline{RESET} = V_{SS} \pm 0.3$ V		—	1	5	μA
V_{CC} Current (Automatic Sleep Mode) *5	I_{CC5}	$V_{CC} = V_{CC}$ Max, $\overline{CE} = V_{SS} \pm 0.3$ V, $\overline{RESET} = V_{CC} \pm 0.3$ V, $V_{IN} = V_{CC} \pm 0.3$ V or $V_{SS} \pm 0.3$ V		—	1	5	μA
V_{CC} Active Current *6 (Read-While-Program)	I_{CC6}	$\overline{CE} = V_{IL}$, $\overline{OE} = V_{IH}$	Byte	—	—	48	mA
			Word	—	—	50	
V_{CC} Active Current *6 (Read-While-Erase)	I_{CC7}	$\overline{CE} = V_{IL}$, $\overline{OE} = V_{IH}$	Byte	—	—	48	mA
			Word	—	—	50	
V_{CC} Active Current (Erase-Suspend-Program)	I_{CC8}	$\overline{CE} = V_{IL}$, $\overline{OE} = V_{IH}$		—	—	35	mA
Input Low Voltage	V_{IL}	—		−0.5	—	+0.6	V
Input High Voltage	V_{IH}	—		2.0	—	V_{CC}+0.3	V
Voltage for Autoselect and Sector Group Protection (A_9, $\overline{OE}$, $\overline{RESET}$) *3, *4	V_{ID}	—		11.5	12	12.5	V
Voltage for $\overline{WP}$/ACC Sector Group Protection/Unprotection and Program Acceleration *4	V_{ACC}	—		8.5	9.0	9.5	V
Output Low Voltage	V_{OL}	$I_{OL} = 4.0$ mA, $V_{CC} = V_{CC}$ Min		—	—	0.45	V
Output High Voltage	V_{OH1}	$I_{OH} = −2.0$ mA, $V_{CC} = V_{CC}$ Min		2.4	—	—	V
	V_{OH2}	$I_{OH} = −100$ μA		$V_{CC} − 0.4$	—	—	V
Low V_{CC} Lock-Out Voltage	V_{LKO}	—		2.3	2.4	2.5	V

(Continued)

(Continued)

*1 : The I_{CC} current listed includes both the DC operating current and the frequency dependent component.

*2 : I_{CC} active while Embedded Algorithm (program or erase) is in progress.

*3 : This timing is only for Sector Group Protection operation and Autoselect mode.

*4 : Applicable for only V_{CC}.

*5 : Automatic sleep mode enables the low power mode when address remains stable for 150 ns.

*6 : Embedded Algorithm (program or erase) is in progress. (@5 MHz)

2. AC Characteristics

• Read Only Operations Characteristics

Parameter	Symbol JEDEC	Symbol Standard	Conditions	70 Min	70 Max	90 Min	90 Max	Unit
Read Cycle Time	t_{AVAV}	t_{RC}	—	70	—	90	—	ns
Address to Output Delay	t_{AVQV}	t_{ACC}	$\overline{CE} = V_{IL}$ $\overline{OE} = V_{IL}$	—	70	—	90	ns
Chip Enable to Output Delay	t_{ELQV}	t_{CE}	$\overline{OE} = V_{IL}$	—	70	—	90	ns
Output Enable to Output Delay	t_{GLQV}	t_{OE}	—	—	30	—	35	ns
Chip Enable to Output High-Z	t_{EHQZ}	t_{DF}	—	—	25	—	30	ns
Output Enable to Output High-Z	t_{GHQZ}	t_{DF}	—	—	25	—	30	ns
Output Hold Time From Addresses, $\overline{CE}$ or $\overline{OE}$, Whichever Occurs First	t_{AXQX}	t_{OH}	—	0	—	0	—	ns
$\overline{RESET}$ Pin Low to Read Mode	—	t_{READY}	—	—	20	—	20	µs
$\overline{CE}$ to $\overline{BYTE}$ Switching Low or High	—	t_{ELFL} t_{ELFH}	—	—	5	—	5	ns

Note: Test Conditions:
Output Load: 1 TTL gate and 30 pF (MBM29DL16XTE/BE70)
               1 TTL gate and 100 pF (MBM29DL16XTE/BE90)
Input rise and fall times: 5 ns
Input pulse levels: 0.0 V or 3.0 V
Timing measurement reference level
      Input: 1.5 V
     Output:1.5 V

Note : C_L = 30 pF including jig capacitance (MBM29DL16XTE/BE70)
       C_L = 100 pF including jig capacitance (MBM29DL16XTE/BE90)

Test Conditions
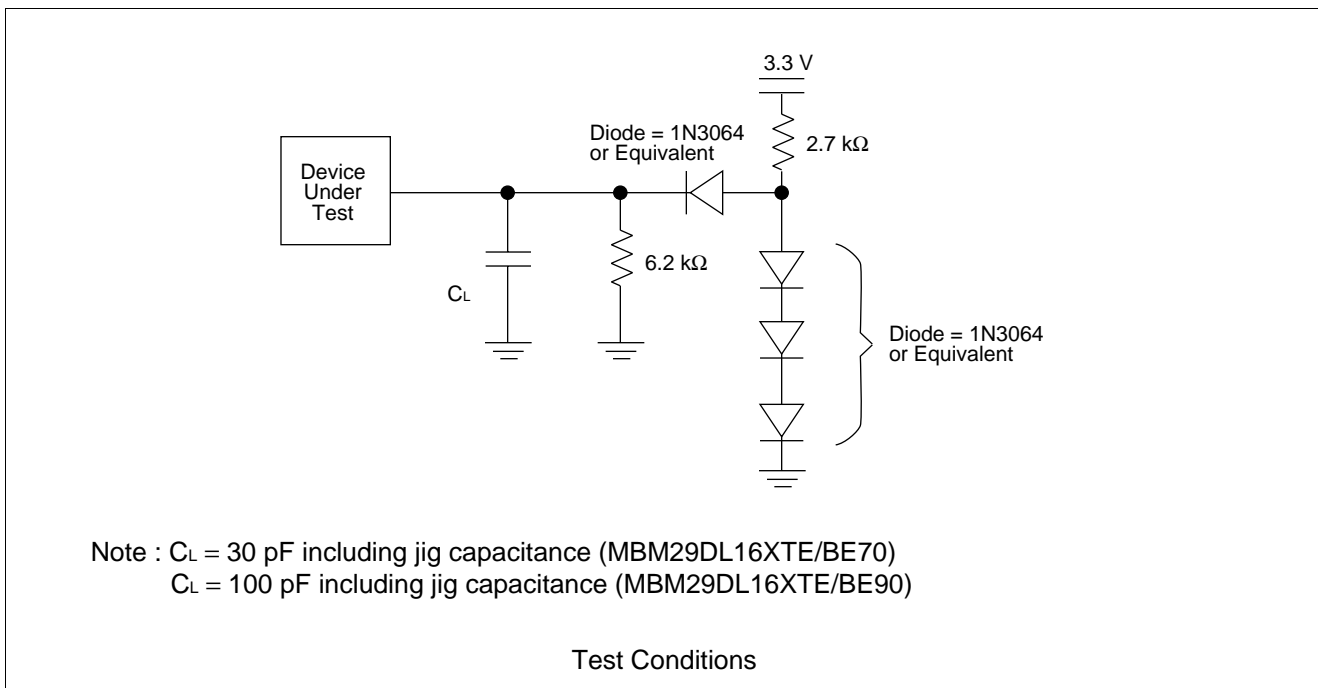
• **Write/Erase/Program Operations**

Parameter		Symbol		70			90			Unit
		JEDEC	Standard	Min	Typ	Max	Min	Typ	Max	
Write Cycle Time		t_{AVAV}	t_{WC}	70	—	—	90	—	—	ns
Address Setup Time		t_{AVWL}	t_{AS}	0	—	—	0	—	—	ns
Address Setup Time to $\overline{OE}$ Low During Toggle Bit Polling		—	t_{ASO}	12	—	—	15	—	—	ns
Address Hold Time		t_{WLAX}	t_{AH}	45	—	—	45	—	—	ns
Address Hold Time from $\overline{CE}$ or $\overline{OE}$ High During Toggle Bit Polling		—	t_{AHT}	0	—	—	0	—	—	ns
Data Setup Time		t_{DVWH}	t_{DS}	30	—	—	35	—	—	ns
Data Hold Time		t_{WHDX}	t_{DH}	0	—	—	0	—	—	ns
Output Enable Hold Time	Read	—	t_{OEH}	0	—	—	0	—	—	ns
	Toggle and $\overline{Data}$ Polling			10	—	—	10	—	—	ns
$\overline{CE}$ High During Toggle Bit Polling		—	t_{CEPH}	20	—	—	20	—	—	ns
$\overline{OE}$ High During Toggle Bit Polling		—	t_{OEPH}	20	—	—	20	—	—	ns
Read Recover Time Before Write		t_{GHWL}	t_{GHWL}	0	—	—	0	—	—	ns
Read Recover Time Before Write		t_{GHEL}	t_{GHEL}	0	—	—	0	—	—	ns
$\overline{CE}$ Setup Time		t_{ELWL}	t_{CS}	0	—	—	0	—	—	ns
$\overline{WE}$ Setup Time		t_{WLEL}	t_{WS}	0	—	—	0	—	—	ns
$\overline{CE}$ Hold Time		t_{WHEH}	t_{CH}	0	—	—	0	—	—	ns
$\overline{WE}$ Hold Time		t_{EHWH}	t_{WH}	0	—	—	0	—	—	ns
Write Pulse Width		t_{WLWH}	t_{WP}	35	—	—	35	—	—	ns
$\overline{CE}$ Pulse Width		t_{ELEH}	t_{CP}	35	—	—	35	—	—	ns
Write Pulse Width High		t_{WHWL}	t_{WPH}	25	—	—	30	—	—	ns
$\overline{CE}$ Pulse Width High		t_{EHEL}	t_{CPH}	25	—	—	30	—	—	ns
Programming Operation	Byte	t_{WHWH1}	t_{WHWH1}	—	8	—	—	8	—	µs
	Word			—	16	—	—	16	—	µs
Sector Erase Operation*[1]		t_{WHWH2}	t_{WHWH2}	—	1	—	—	1	—	s
V_{CC} Setup Time		—	t_{VCS}	50	—	—	50	—	—	µs
Rise Time to V_{ID} *[2]		—	t_{VIDR}	500	—	—	500	—	—	ns
Rise Time to V_{ACC}*[3]		—	t_{VACCR}	500	—	—	500	—	—	ns
Voltage Transition Time*[2]		—	t_{VLHT}	4	—	—	4	—	—	µs
Write Pulse Width*[2]		—	t_{WPP}	100	—	—	100	—	—	µs
$\overline{OE}$ Setup Time to $\overline{WE}$ Active*[2]		—	t_{OESP}	4	—	—	4	—	—	µs
$\overline{CE}$ Setup Time to $\overline{WE}$ Active *[2]		—	t_{CSP}	4	—	—	4	—	—	µs
Recover Time From RY/$\overline{BY}$		—	t_{RB}	0	—	—	0	—	—	ns

(Continued)

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(Continued)

Parameter	Symbol		70			90			Unit
	JEDEC	Standard	Min	Typ	Max	Min	Typ	Max	
$\overline{RESET}$ Pulse Width	—	t_{RP}	500	—	—	500	—	—	ns
$\overline{RESET}$ High Level Period Before Read	—	t_{RH}	200	—	—	200	—	—	ns
$\overline{BYTE}$ Switching Low to Output High-Z	—	t_{FLQZ}	—	—	25	—	—	30	ns
$\overline{BYTE}$ Switching High to Output Active	—	t_{FHQV}	—	—	70	—	—	90	ns
Program/Erase Valid to RY/$\overline{BY}$ Delay	—	t_{BUSY}	—	—	90	—	—	90	ns
Delay Time from Embedded Output Enable	—	t_{EOE}	—	—	70	—	—	90	ns
Erase Time-out Time	—	t_{TOW}	—	—	50	—	—	50	µs
Erase Suspend Transition Time	—	t_{SPD}	—	—	20	—	—	20	µs

*1 : This does not include preprogramming time.

*2 : This timing is for Sector Group Protection operation.

*3 : This timing is limited for Accelerated Protection operation.

■ ERASE AND PROGRAMMING PERFORMANCE

Parameter	Value			Unit	Comments
	Min	Typ	Max		
Sector Erase Time	—	1	10	s	Excludes programming time prior to erasure
Word Programming Time	—	16	360	µs	Excludes system-level overhead
Byte Programming Time	—	8	300	µs	Excludes system-level overhead
Chip Programming Time	—	—	50	s	Excludes system-level overhead
Program/Erase Cycle	100,000	—	—	cycle	

■ PIN CAPACITANCE

1. TSOP(1) pin capacitance

Parameter	Symbol	Condition	Value			Unit
			Min	Typ	Max	
Input Capacitance	C_{IN}	$V_{IN} = 0$	—	6.0	7.5	pF
Output Capacitance	C_{OUT}	$V_{OUT} = 0$	—	8.5	12.0	pF
Control Pin Capacitance	C_{IN2}	$V_{IN} = 0$	—	8.0	10.0	pF
$\overline{WP}$/ACC Pin Capacitance	C_{IN3}	$V_{IN} = 0$	—	17.0	18.0	pF

Notes : • Test conditions T_A = +25°C, f = 1.0 MHz
        • DQ_{15}/A_{-1} pin capacitance is stipulated by output capacitance.

2. FBGA pin capacitance
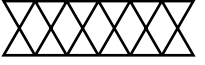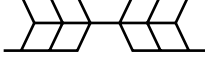
Parameter	Symbol	Condition	Value			Unit
			Min	Typ	Max	
Input Capacitance	C_{IN}	$V_{IN} = 0$	—	7.0	9.0	pF
Output Capacitance	C_{OUT}	$V_{OUT} = 0$	—	9.5	13.0	pF
Control Pin Capacitance	C_{IN2}	$V_{IN} = 0$	—	9.0	11.0	pF
$\overline{WP}$/ACC Pin Capacitance	C_{IN3}	$V_{IN} = 0$	—	17.0	18.0	pF

Notes : • Test conditions T_A = +25°C, f = 1.0 MHz
        • DQ_{15}/A_{-1} pin capacitance is stipulated by output capacitance.

■ TIMING DIAGRAM

• Key to Switching Waveforms

WAVEFORM	INPUTS	OUTPUTS
	Must Be Steady	Will Be Steady
	May Change from H to L	Will Be Changing from H to L
	May Change from L to H	Will Be Changing from L to H
	"H" or "L" Any Change Permitted	Changing State Unknown
	Does Not Apply	Center Line is High-Impedance "Off" State

(1) AC Waveforms for Read Operations

Address — Address Stable — t_{RC}

t_{ACC}

$\overline{CE}$

t_{OE} t_{DF}

$\overline{OE}$

t_{OEH}

$\overline{WE}$

t_{CE} t_{OH}

Outputs — High-Z — Output Valid — High-Z
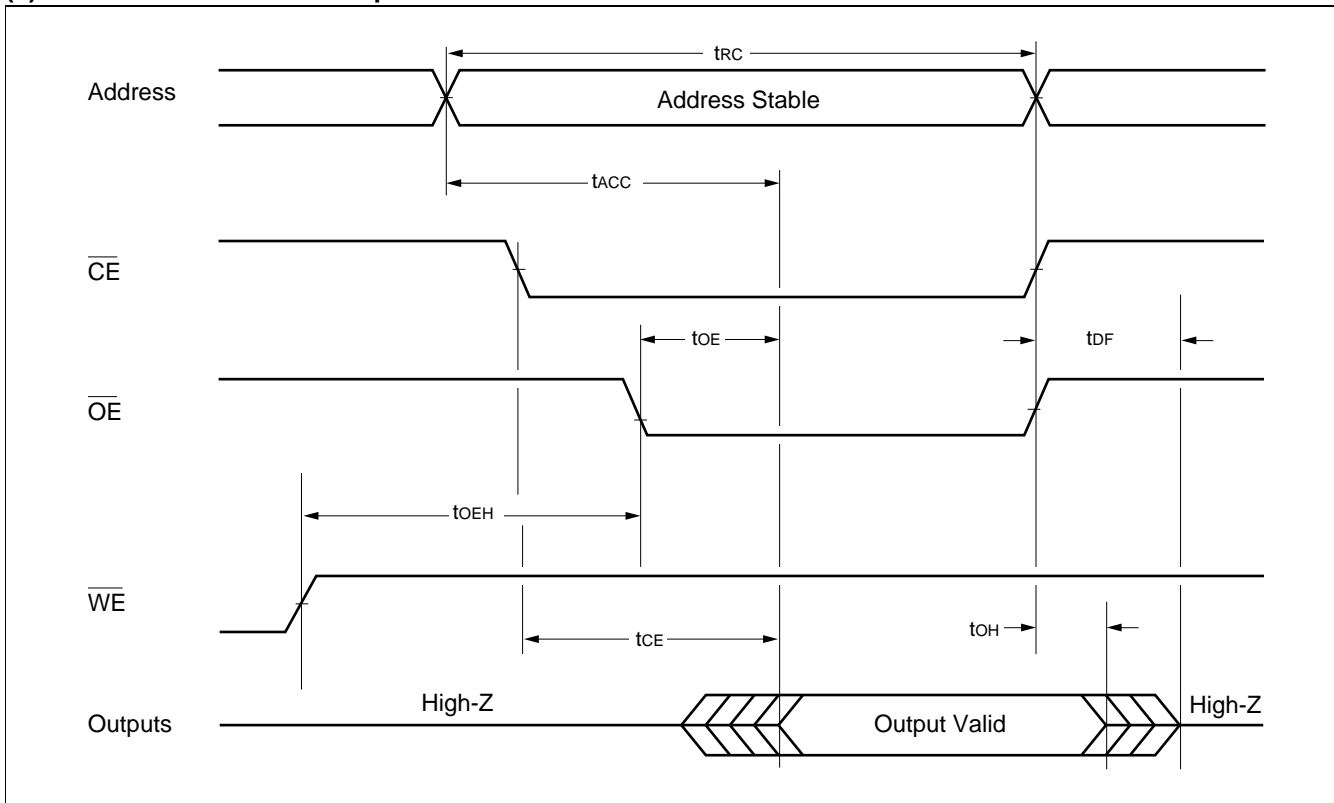
(2) AC Waveforms for Hardware Reset/Read Operations
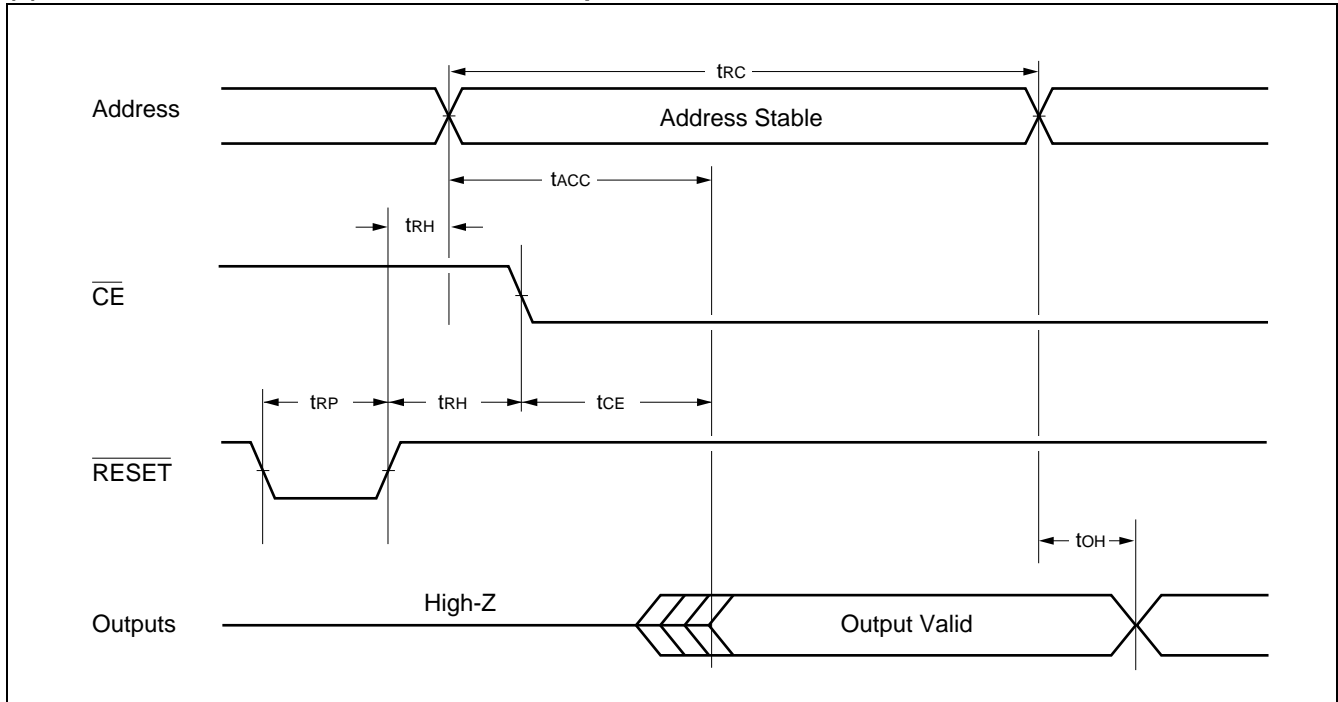
(3) AC Waveforms for Alternate $\overline{WE}$ Controlled Program Operations
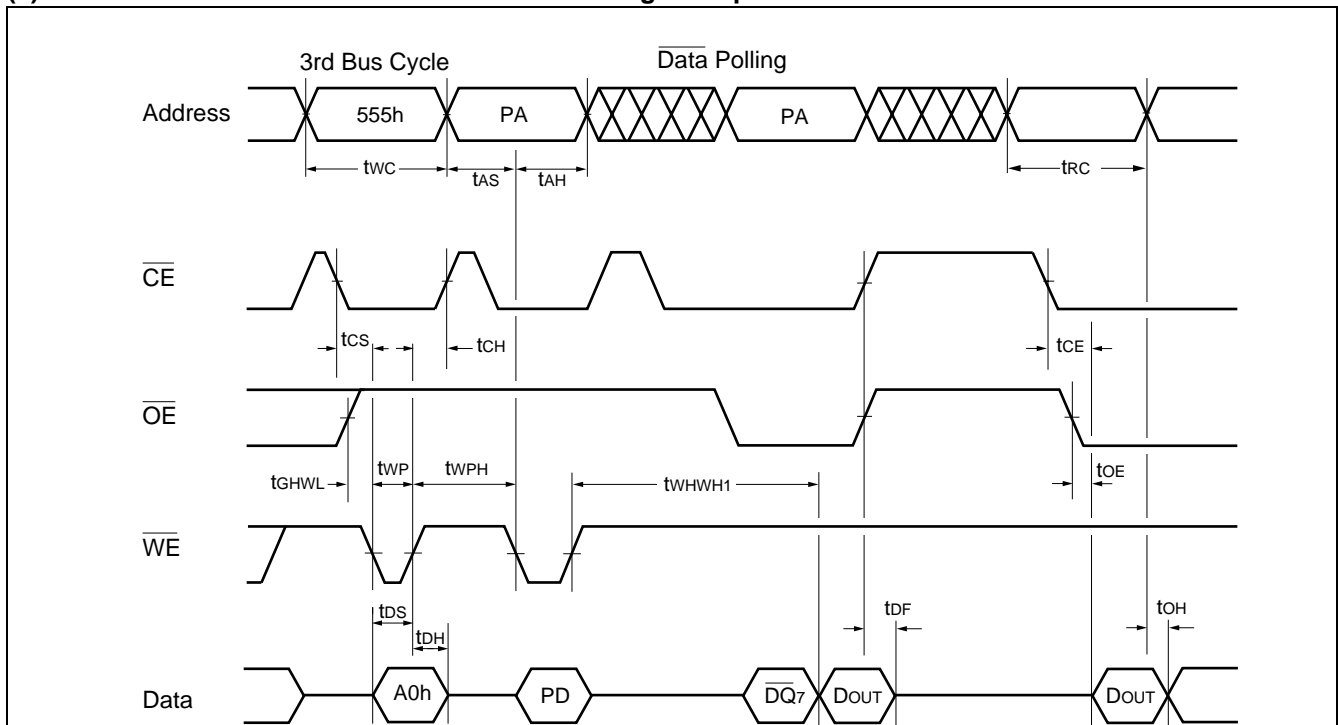
Notes : • PA is address of the memory location to be programmed.
  • PD is data to be programmed at byte address.
  • $\overline{DQ_7}$ is the output of the complement of the data written to the device.
  • D_{OUT} is the output of the data written to the device.
  • Figure indicates the last two bus cycles out of four bus cycle sequence.
  • These waveforms are for the × 16 mode. These address differ from × 8 mode.

(4) AC Waveforms for Alternate $\overline{CE}$ Controlled Program Operations
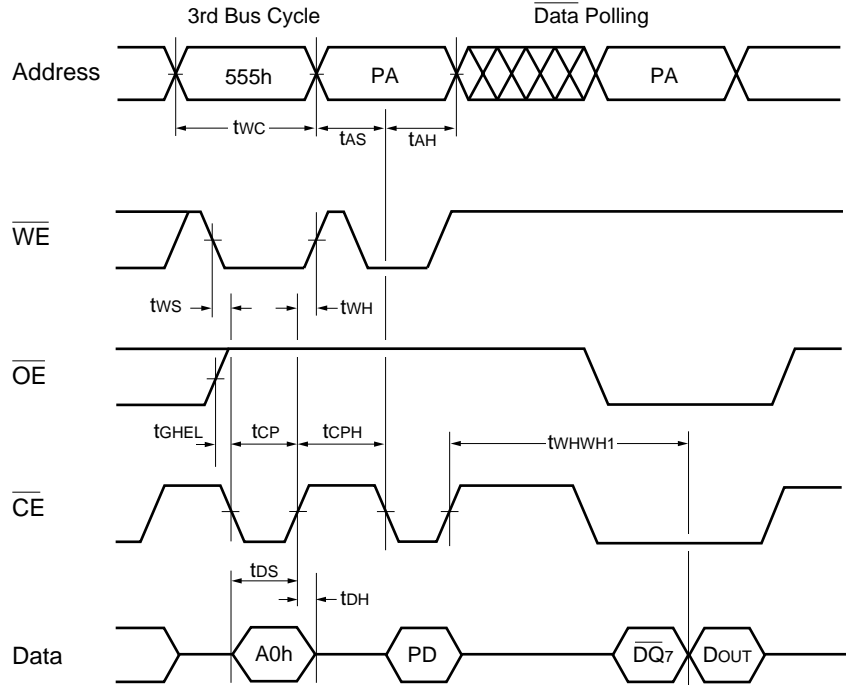
Notes : • PA is address of the memory location to be programmed.
   • PD is data to be programmed at byte address.
   • $\overline{DQ_7}$ is the output of the complement of the data written to the device.
   • D$_{OUT}$ is the output of the data written to the device.
   • Figure indicates the last two bus cycles out of four bus cycle sequence.
   • These waveforms are for the × 16 mode. These address differ from × 8 mode.

(5) AC Waveforms for Chip/Sector Erase Operations
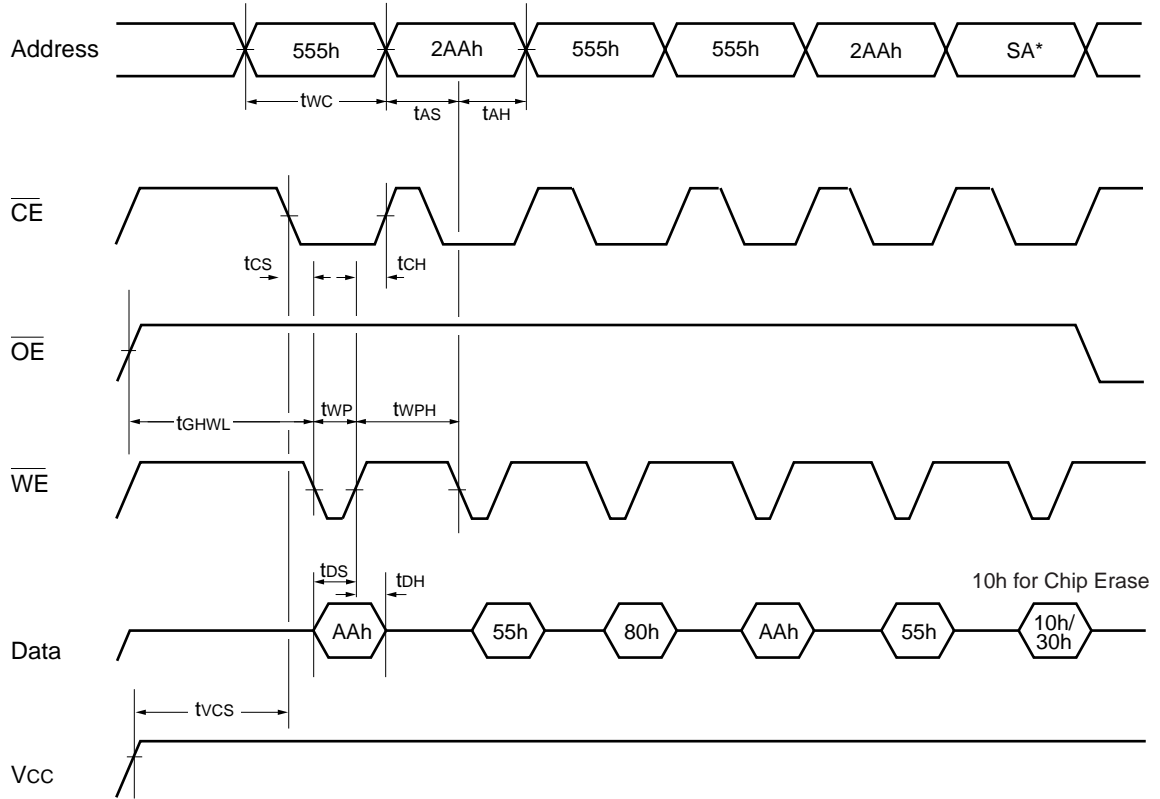
* : SA is the sector address for Sector Erase. Addresses = 555h (Word) for Chip Erase.

Note : These waveforms are for the ×16 mode. The addresses differ from ×8 mode.

(6) AC Waveforms for $\overline{\text{Data}}$ Polling during Embedded Algorithm Operations
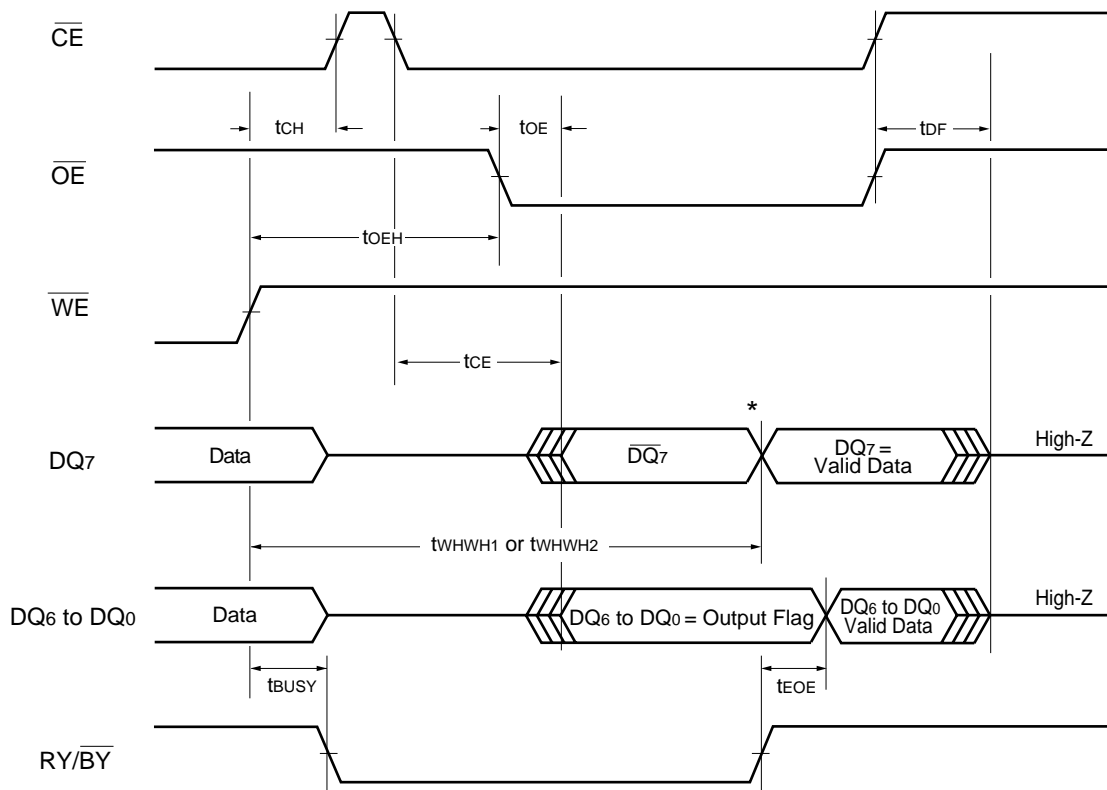
* : DQ$_7$ = Valid Data (The device has completed the Embedded operation).

(7) AC Waveforms for Toggle Bit I during Embedded Algorithm Operations
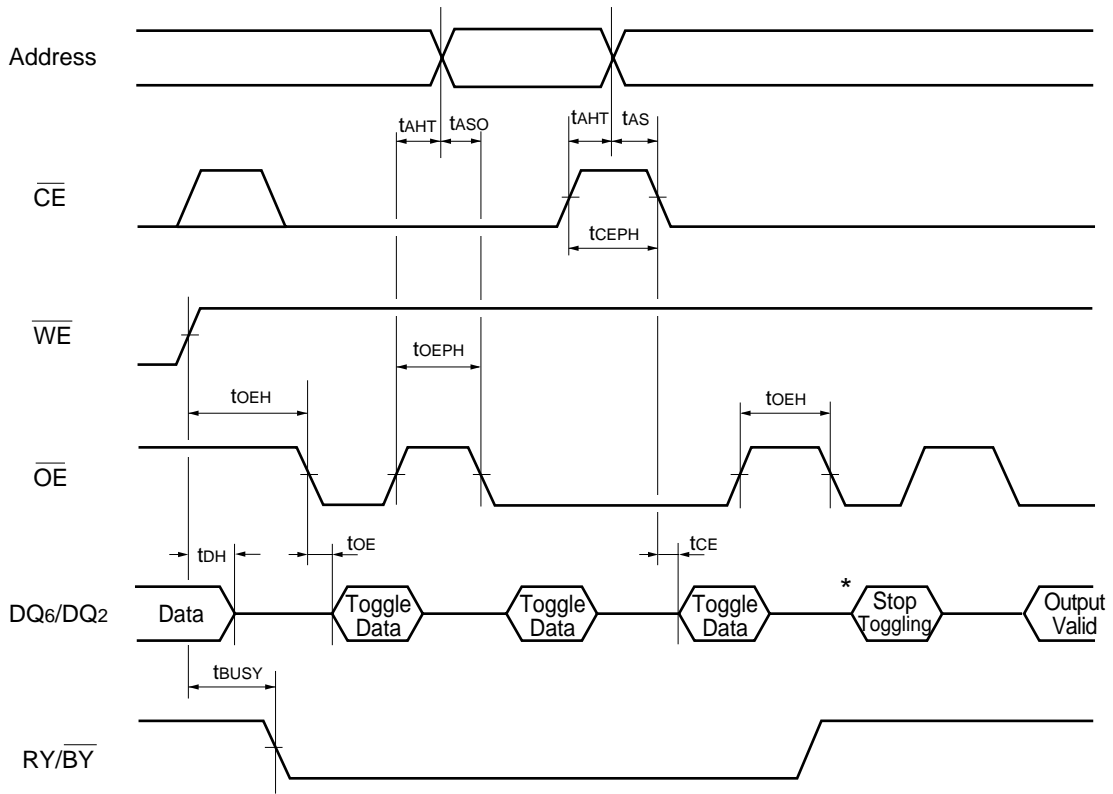
* : DQ6 stops toggling (The device has completed the Embedded operation).

(8) Bank-to-bank Read/Write Timing Diagram

	Read	Command	Read	Command	Read	Read
	t_{RC}	t_{WC}	t_{RC}	t_{WC}	t_{RC}	t_{RC}

Address: BA1 | BA2 (555h) | BA1 | BA2 (PA) | BA1 | BA2 (PA)

t_{AS} t_{AH} t_{ACC} t_{CE} t_{AHT} t_{AS}

$\overline{CE}$

t_{OE} t_{CEPH}

$\overline{OE}$

t_{GHWL} t_{OEH} t_{DF}

$\overline{WE}$

t_{WP}

t_{DS} t_{DH} t_{DF}

DQ: Valid Output | Valid Intput (A0h) | Valid Output | Valid Intput (PD) | Valid Output | Status
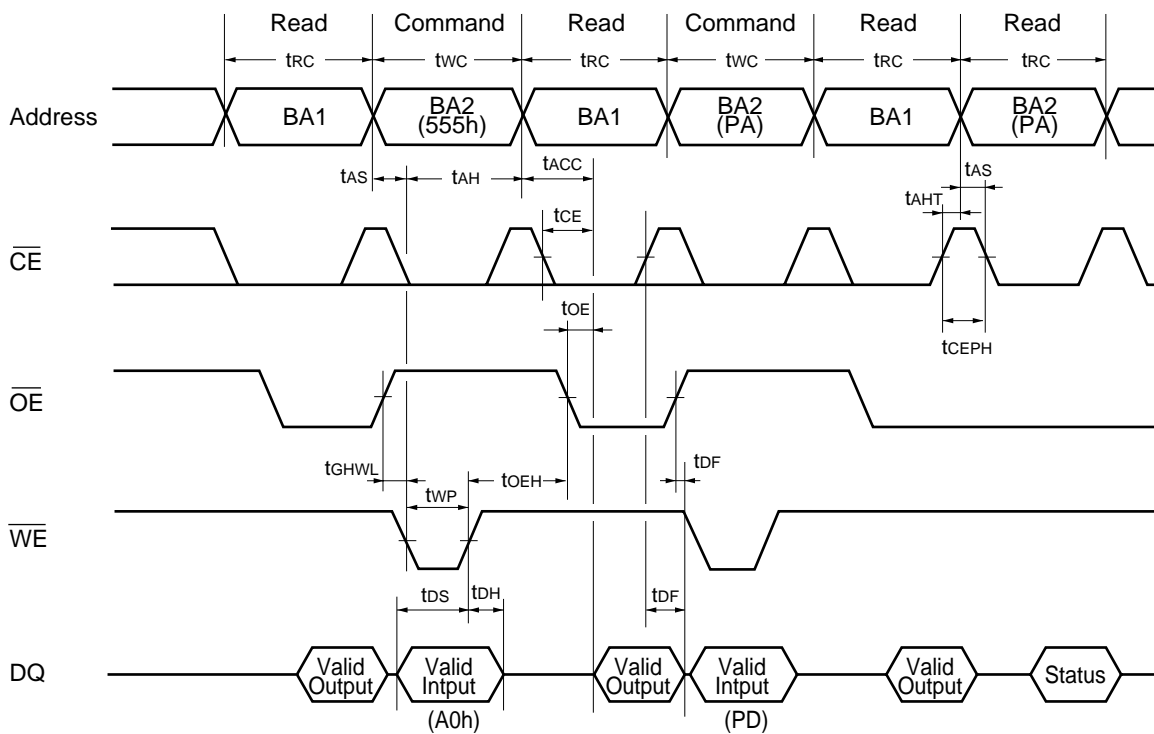
Note: This is the example of Read for Bank 1 and Embedded Algorithm (program) for Bank 2.
BA1: Address corresponding to Bank 1.
BA2: Address corresponding to Bank 2.

(9) DQ_2 vs. DQ_6

$\overline{WE}$

Enter Embedded Erasing — Erase — Erase Suspend — Erase Suspend Read — Enter Erase Suspend Program — Erase Suspend Program — Erase Suspend Read — Erase Resume — Erase — Erase Complete

DQ_6

DQ_2*

Toggle DQ_2 and DQ_6 with $\overline{OE}$ or $\overline{CE}$

* : DQ_2 is read from the erase-suspended sector.

(10) RY/$\overline{BY}$ Timing Diagram during Program/Erase Operations

$\overline{CE}$

$\overline{WE}$

Rising edge of the last write pulse

Entire programming
or erase operations

RY/$\overline{BY}$

t_{BUSY}

(11) $\overline{RESET}$, RY/$\overline{BY}$ Timing Diagram

$\overline{WE}$

$\overline{RESET}$

t_{RP}

t_{RB}

RY/$\overline{BY}$

t_{READY}

(12) Timing Diagram for Word Mode Configuration

$\overline{CE}$

t_{CE}

$\overline{BYTE}$

DQ_{14} to DQ_0

Data Output
(DQ_7 to DQ_0)

Data Output
(DQ_{14} to DQ_0)

t_{ELFH}

t_{FHQV}

DQ_{15}/A_{-1}

A_{-1}

DQ_{15}
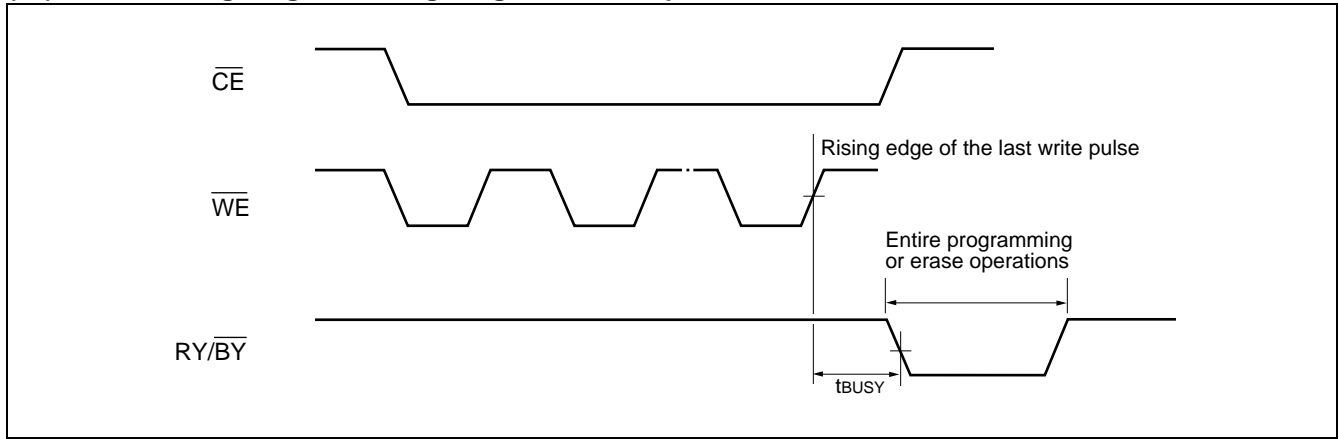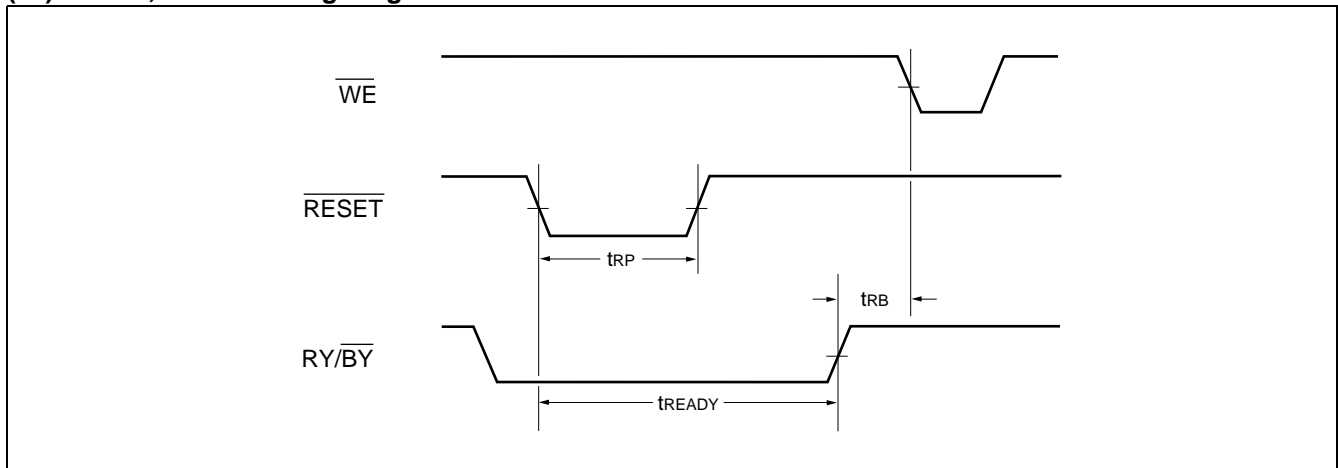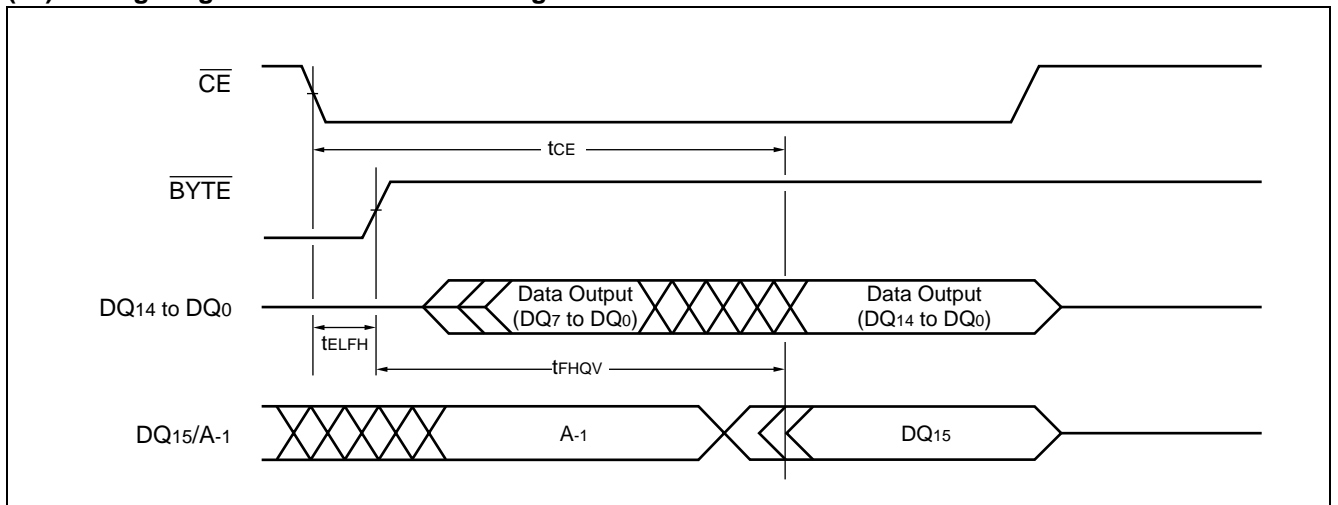
(13) Timing Diagram for Byte Mode Configuration

(14) $\overline{\text{BYTE}}$ Timing Diagram for Write Operations
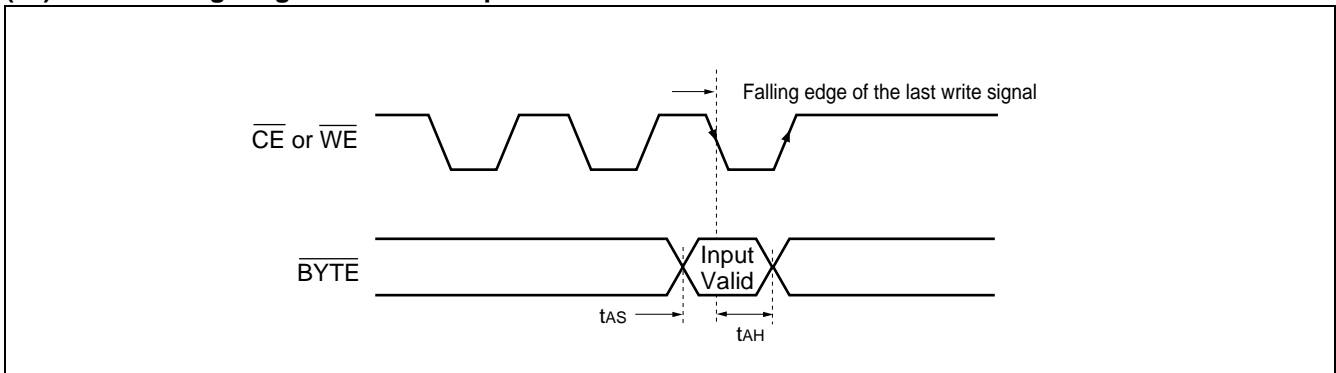
(15) AC Waveforms for Sector Group Protection

SPAX : Sector Group Address to be protected
SPAY : Next Sector Group Address to be protected
Note: A_{-1} is V_{IL} on byte mode.

(16) Temporary Sector Group Unprotection Timing Diagram

(17) Extended Sector Group Protection Timing Diagram

VCC
VID
RESET
tVCS
tVLHT
tVIDR
twc
twc

Address   SPAX   SPAX   SPAY

A6, A0

A1

CE

OE

WE   twP   TIME-OUT

Data   60h   60h   40h   01h   60h   tOE
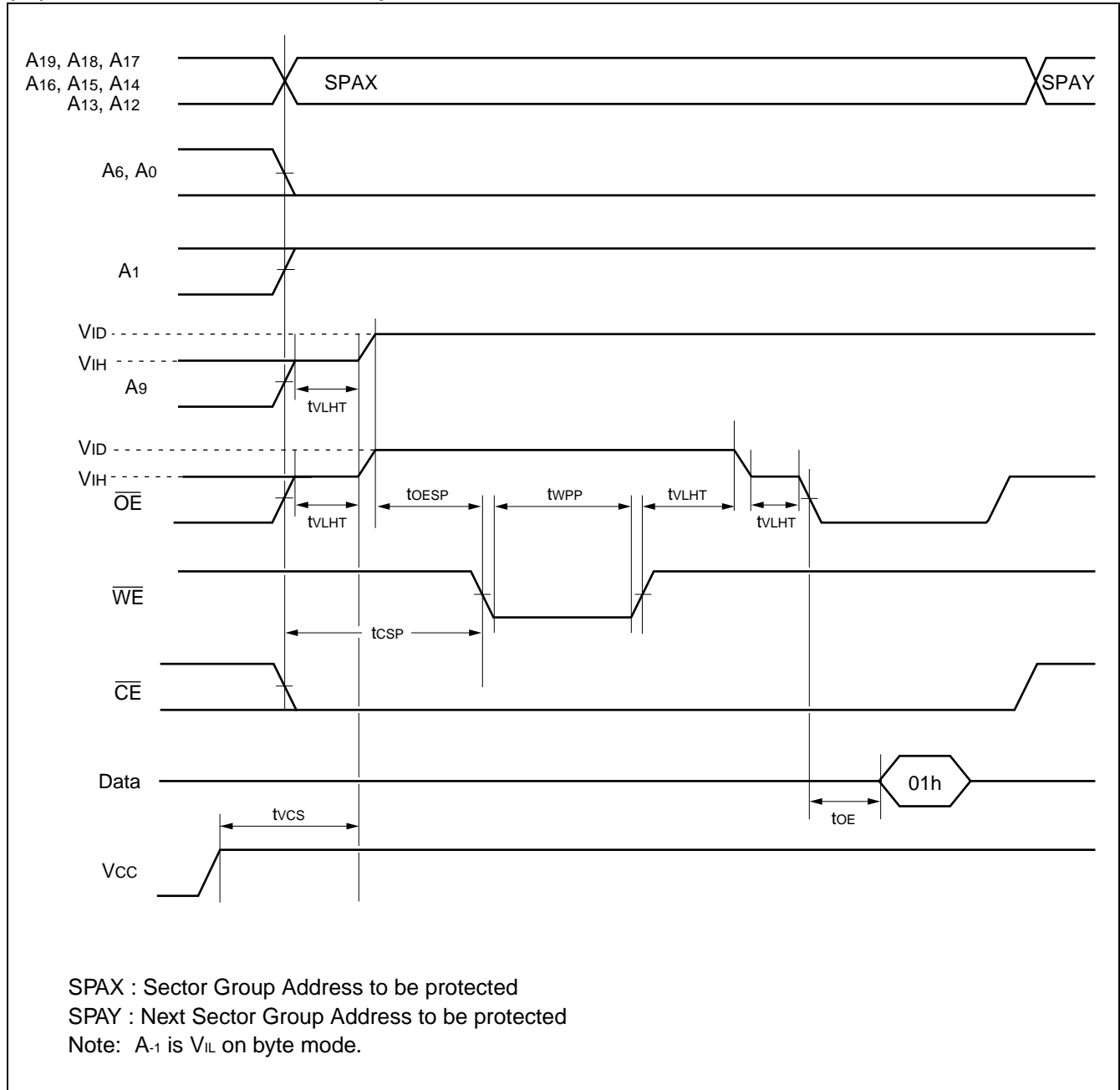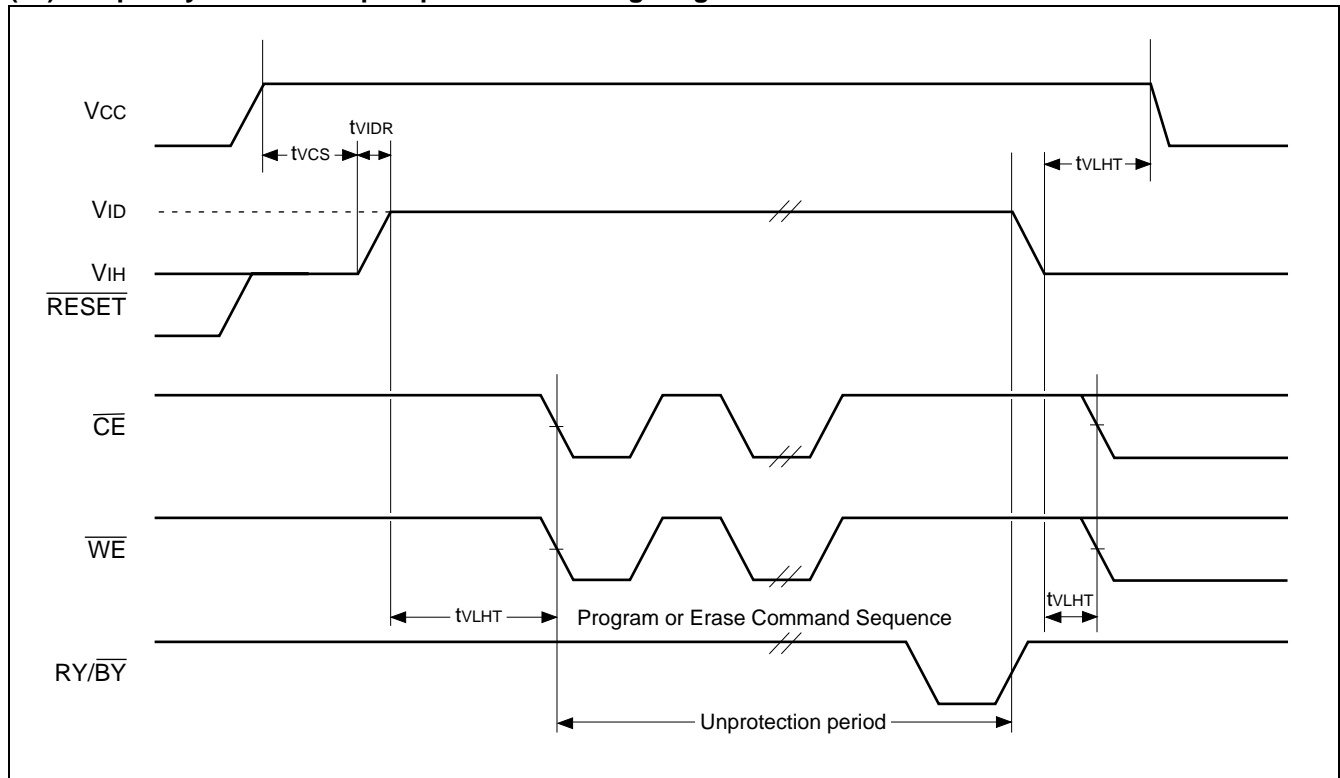
SPAX : Sector Group Address to be protected
SPAY : Next Sector Group Address to be protected
TIME-OUT : Time-Out window = 250 μs (Min)

Note : A-1 is VIL on byte mode.

(18) Accelerated Program Timing Diagram

Timing diagram showing signals V_{CC}, V_{ACC}, V_{IH} $\overline{WP}$/ACC, $\overline{CE}$, $\overline{WE}$, and RY/$\overline{BY}$ with timing parameters t_{VCS}, t_{VACCR}, t_{VLHT}. Labels include "Program Command Sequence" and "Acceleration period".
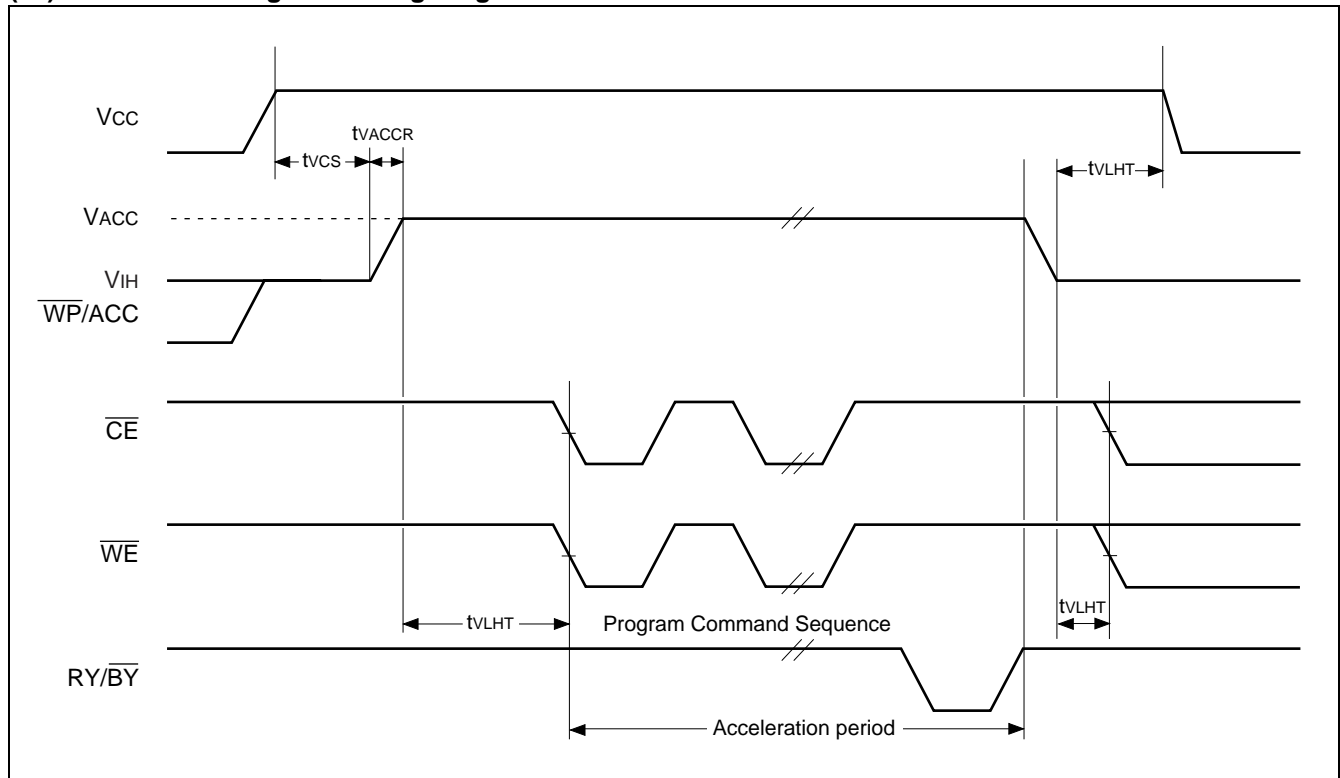
■ FLOW CHART

(1) Embedded Program™ Algorithm

EMBEDDED ALGORITHMS
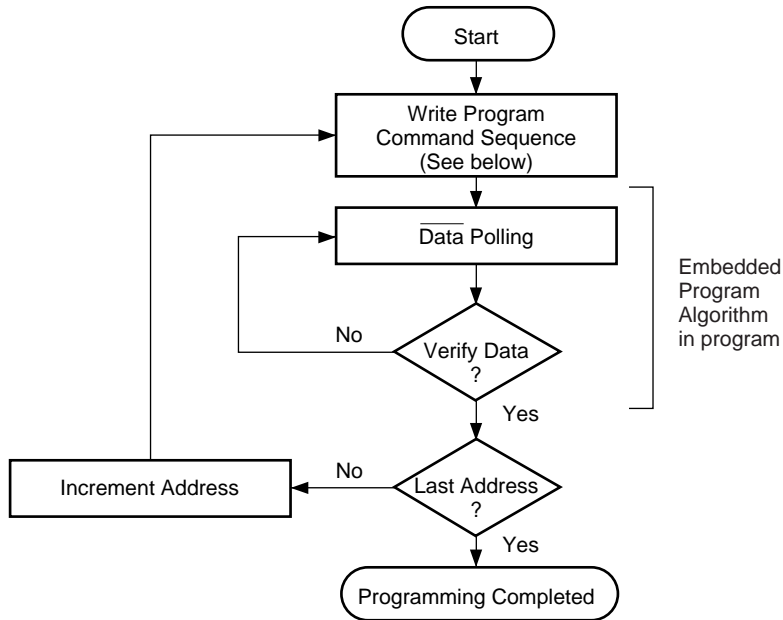
```
                            ┌─────────┐
                            │  Start  │
                            └─────────┘
                                 │
                                 ▼
                    ┌────────────────────────┐
          ┌────────▶│    Write Program       │
          │         │  Command Sequence      │
          │         │     (See below)        │
          │         └────────────────────────┘
          │                    │
          │                    ▼
          │         ┌────────────────────────┐   ┐
          │    ┌───▶│     Data Polling       │   │
          │    │    └────────────────────────┘   │  Embedded
          │    │               │                 │  Program
          │    │               ▼                 │  Algorithm
          │    │    No      ◇ Verify Data ◇      │  in program
          │    └──────────    ?                  │
          │                    │ Yes             ┘
          │                    ▼
          │            No   ◇ Last Address ◇
   ┌──────────────┐◀──────     ?
   │  Increment   │
   │   Address    │            │ Yes
   └──────────────┘            ▼
                       ┌─────────────────────────┐
                       │ Programming Completed   │
                       └─────────────────────────┘
```

Program Command Sequence (Address/Command):

```
                    ┌──────────────┐
                    │  555h/AAh    │
                    └──────────────┘
                           │
                           ▼
                    ┌──────────────┐
                    │  2AAh/55h    │
                    └──────────────┘
                           │
                           ▼
                    ┌──────────────┐
                    │  555h/A0h    │
                    └──────────────┘
                           │
                           ▼
          ┌──────────────────────────────────┐
          │   Program Address/Program Data    │
          └──────────────────────────────────┘
```
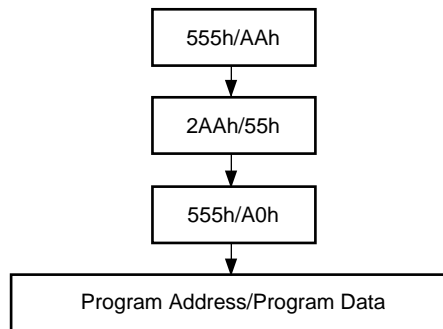
Notes : • The sequence is applied for $\times$ 16 mode.
           • The addresses differ from $\times$ 8 mode.

(2) Embedded Erase™ Algorithm

EMBEDDED ALGORITHMS

Start

↓

Write Erase
Command Sequence
(See below)

↓

Data Polling ◄─┐

↓   │ No

Data = FFh ? ──┘

↓ Yes

Erasure Completed

Embedded
Program
Algorithm
in program

**Chip Erase Command Sequence
(Address/Command):**

555h/AAh

↓

2AAh/55h

↓

555h/80h

↓

555h/AAh

↓

2AAh/55h

↓

555h/10h
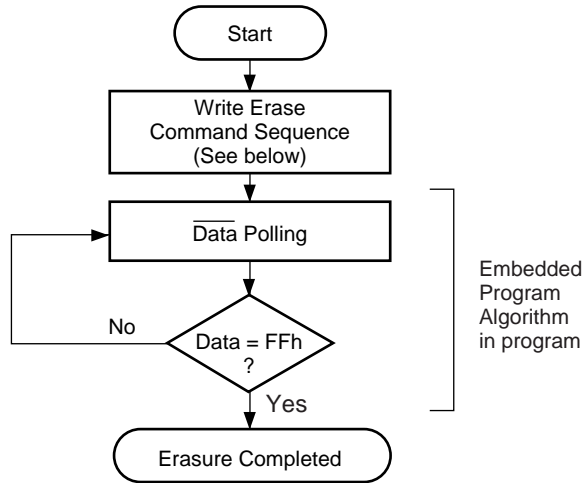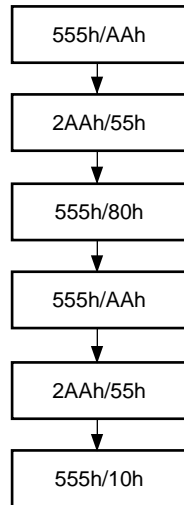
**Individual Sector/Multiple Sector
Erase Command Sequence
(Address/Command):**

555h/AAh

↓

2AAh/55h

↓

555h/80h

↓

555h/AAh

↓

2AAh/55h

↓

Sector Address/30h

↓

Sector Address/30h
⋮
Sector Address/30h

Additional sector
erase commands
are optional.
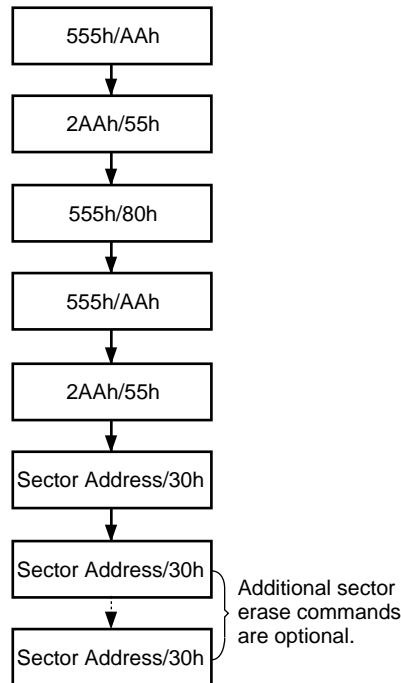
Notes : • The sequence is applied for × 16 mode.
• The addresses differ from × 8 mode.

(3) $\overline{Data}$ Polling Algorithm
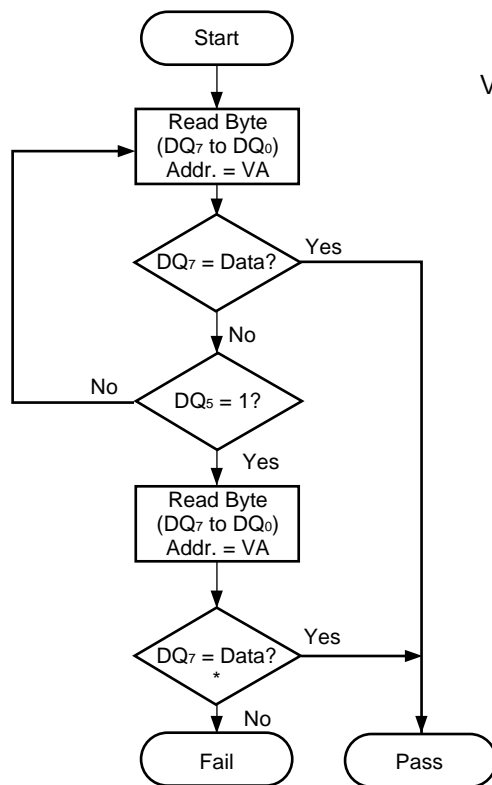
VA = Address for programming
  = Any of the sector addresses within the sector being erased during sector erase or multiple sector erases operation.
  = Any of the sector addresses within the sector not being protected during chip erase operation.

Start

Read Byte
(DQ_7 to DQ_0)
Addr. = VA

DQ_7 = Data? — Yes

No

DQ_5 = 1? — No

Yes

Read Byte
(DQ_7 to DQ_0)
Addr. = VA

DQ_7 = Data?
* — Yes

No

Fail

Pass

* : DQ_7 is rechecked even if DQ_5 = "1" because DQ_7 may change simultaneously with DQ_5.

(4) Toggle Bit Algorithm

```
                        ┌─────────┐
                        │  Start  │
                        └────┬────┘
                             │
                    ┌────────────────┐
                    │     Read       │  *1
                    │ DQ7 to DQ0     │
                    │  Addr. = VA    │
                    └────────┬───────┘
                             │
                    ┌────────────────┐
                    │     Read       │  *1
                    │ DQ7 to DQ0     │
                    │  Addr. = VA    │
                    └────────┬───────┘
                             │
                         ╱───┴───╲        No
                        ╱  DQ6    ╲─────────────┐
                        ╲ = Toggle ╱            │
                         ╲   ?   ╱              │
                          ╲──┬──╱               │
                             │ Yes             │
                         ╱───┴───╲              │
              No        ╱         ╲             │
         ┌─────────────╲ DQ5 = 1? ╱            │
         │              ╲         ╱             │
         │               ╲──┬───╱              │
         │                  │ Yes             │
         │         ┌────────────────┐          │
         │         │ Read DQ7 to DQ0│ *1, *2   │
         │         │  Addr. = VA    │          │
         │         └────────┬───────┘          │
         │                  │                  │
         │         ┌────────────────┐          │
         │         │ Read DQ7 to DQ0│ *1, *2   │
         │         │  Addr. = VA    │          │
         │         └────────┬───────┘          │
         │                  │                  │
         │              ╱───┴───╲    No         │
         │             ╱  DQ6    ╲──────────┐   │
         │             ╲ = Toggle ╱         │   │
         │              ╲   ?   ╱           │   │
         │               ╲──┬──╱            │   │
         │                  │ Yes           │   │
         │         ┌────────────────┐  ┌─────────────┐
         │         │ Program/Erase  │  │Program/Erase│
         │         │ Operation Not  │  │ Operation   │
         │         │Complete. Write │  │  Complete   │
         │         │Reset Command   │  └─────────────┘
         │         └────────────────┘
```
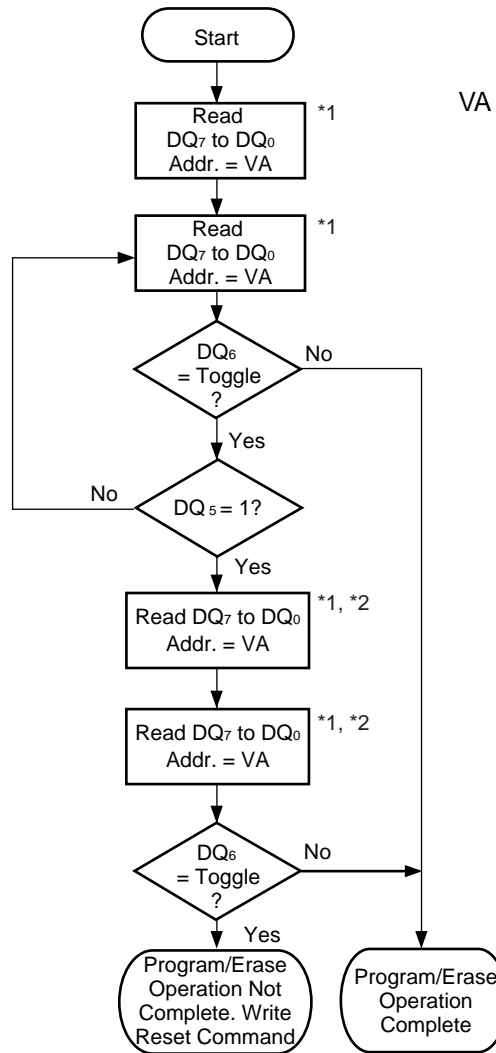
VA = Bank address being executed
        Embedded Algorithm.

*1 : Read toggle bit twice to determine whether it is toggling.

*2 : Recheck toggle bit because it may stop toggling as DQ_5 changing to "1".

(5) Sector Group Protection Algorithm

```
                                    ┌─────────────┐
                                    │    Start    │
                                    └──────┬──────┘
                                           ▼
                            ┌──────────────────────────────┐
                            │  Setup Sector Group Addr.     │◄────────┐
                            │ (A19, A18, A17, A16, A15,     │         │
                            │      A14, A13, A12)           │         │
                            └──────────────┬────────────────┘         │
                                           ▼                          │
                            ┌──────────────────────────────┐          │
                            │         PLSCNT = 1            │          │
                            └──────────────┬────────────────┘          │
                                           ▼                          │
                            ┌──────────────────────────────┐          │
                  ┌────────►│  OE = VID, A9 = VID,          │          │
                  │         │  CE = VIL, RESET = VIH        │          │
                  │         │  A6 = A0 = VIL, A1 = VIH      │          │
                  │         └──────────────┬────────────────┘          │
                  │                        ▼                          │
                  │         ┌──────────────────────────────┐          │
                  │         │      Activate WE Pulse        │          │
                  │         └──────────────┬────────────────┘          │
   ┌──────────────────┐                    ▼                          │
   │ Increment PLSCNT │   ┌──────────────────────────────┐           │
   └────────▲─────────┘   │       Time out 100 μs         │           │
            │             └──────────────┬────────────────┘           │
            │                            ▼                            │
            │             ┌──────────────────────────────┐            │
            │             │ WE = V IH, CE = OE = V IL     │            │
            │             │ (A 9 should remain V ID)      │            │
            │             └──────────────┬────────────────┘            │
            │                            ▼                            │
            │             ┌──────────────────────────────┐            │
            │             │   Read from Sector Group      │            │
            │             │   (Addr. = SPA, A1 = VIH,     │            │
            │             │    A6 = V0 = VIL) *           │            │
            │             └──────────────┬────────────────┘            │
     No     │                            ▼                            │
            │        No         ◇─────────────────◇                   │
       ◇─────────◇ ◄────────────│    Data = 01h?  │                   │
       │ PLSCNT = 25? │         ◇─────────┬───────◇                   │
       ◇─────┬────────◇                   │ Yes                       │
             │ Yes                        ▼           Yes             │
             ▼                 ◇──────────────────◇───────────────────┘
   ┌──────────────────┐        │ Protect Another Sector │
   │ Remove VID from A9│       │       Group ?         │
   │Write Reset Command│       ◇──────────┬───────────◇
   └────────┬─────────┘                   │ No
            ▼                             ▼
   ┌──────────────────┐        ┌──────────────────┐
   │  Device Failed   │        │ Remove VID from A9│
   └──────────────────┘        │Write Reset Command│
                               └────────┬─────────┘
                                        ▼
                               ┌──────────────────┐
                               │ Sector Group     │
                               │ Protection       │
                               │ Completed        │
                               └──────────────────┘
```

* : A$_{-1}$ is V$_{IL}$ on byte mode.

(6) Temporary Sector Group Unprotection Algorithm

```
                    ┌──────────────────┐
                    │      Start       │
                    └──────────────────┘
                             │
                             ▼
                    ┌──────────────────┐
                    │  RESET = V_ID *1 │
                    └──────────────────┘
                             │
                             ▼
                    ┌──────────────────┐
                    │  Perform Erase or │
                    │ Program Operations│
                    └──────────────────┘
                             │
                             ▼
                    ┌──────────────────┐
                    │  RESET = V_IH    │
                    └──────────────────┘
                             │
                             ▼
                ┌────────────────────────┐
                │ Temporary Sector Group │
                │ Unprotection Completed*2│
                └────────────────────────┘
```
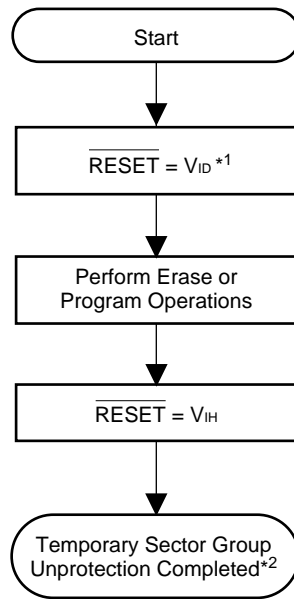
*1 : All protected sector groups are unprotected.

*2 : All previously protected sector groups are protected once again.

(7) Extended Sector Group Protection Algorithm

```
                              ╭─────────────╮
                              │    Start    │
                              ╰─────────────╯
                                     │
                         ┌───────────────────────┐
                         │     RESET = VID       │
                         └───────────────────────┘
                                     │
                         ┌───────────────────────┐
                         │     Wait to 4 μs      │
                         └───────────────────────┘
                                     │
 ┌──────────────────────┐   No   ◇─────────────────◇
 │ Device is Operating in │◄───────  Extended Sector Group
 │ Temporary Sector Group │        ◇ Protection Entry?  ◇
 │   Unprotection Mode    │         ◇─────────────────◇
 └──────────────────────┘                  │ Yes
                              ┌───────────────────────┐
                              │ To Setup Sector Group  │
                              │ Protection Write XXXh/60h │
                              └───────────────────────┘
                                     │
                              ┌───────────────────────┐
                              │      PLSCNT = 1       │◄──────────┐
                              └───────────────────────┘           │
                                     │                            │
                              ┌───────────────────────┐           │
                ┌────────────►│ To Sector Group Protection │       │
                │             │ Write 60h to Sector Address │      │
                │             │ (A6 = A0 = VIL, A1 = VIH)  │       │
                │             └───────────────────────┘           │
 ┌──────────────────────┐     ┌───────────────────────┐    ┌─────────────────────┐
 │   Increment PLSCNT   │     │    Time out 250 μs    │    │ Setup Next Sector Group│
 └──────────────────────┘     └───────────────────────┘    │      Address          │
                │                    │                      └─────────────────────┘
                │             ┌───────────────────────┐           │
                │             │To Verify Sector Group Protection│  │
                │             │ Write 40h to Sector Address │      │
                │             │ (A6 = A0 = VIL, A1 = VIH)  │       │
                │             └───────────────────────┘           │
                │                    │                            │
                │             ┌───────────────────────┐           │
                │             │ Read from Sector Group │           │
                │             │ Address (Addr. = SPA,  │           │
                │             │ A6 = A0 = VIL, A1 = VIH) │         │
                │             └───────────────────────┘           │
         No     │                    │                            │
  ◇─────────────◇    No   ◇─────────────────◇                     │
  ◇ PLSCNT = 25? ◇◄───────◇    Data = 01h?  ◇                     │
  ◇─────────────◇         ◇─────────────────◇                     │
         │ Yes                   │ Yes                            │
 ┌──────────────────────┐  ◇─────────────────◇    Yes            │
 │ Remove VID from RESET │  ◇ Protection Other Sector ◇───────────┘
 │  Write Reset Command  │  ◇      Group?      ◇
 └──────────────────────┘   ◇─────────────────◇
                │                    │ No
      ╭─────────────╮        ┌───────────────────────┐
      │ Device Failed│        │ Remove VID from RESET │
      ╰─────────────╯        │  Write Reset Command  │
                             └───────────────────────┘
                                     │
                              ╭─────────────────────╮
                              │ Sector Group Protection │
                              │      Completed        │
                              ╰─────────────────────╯
```
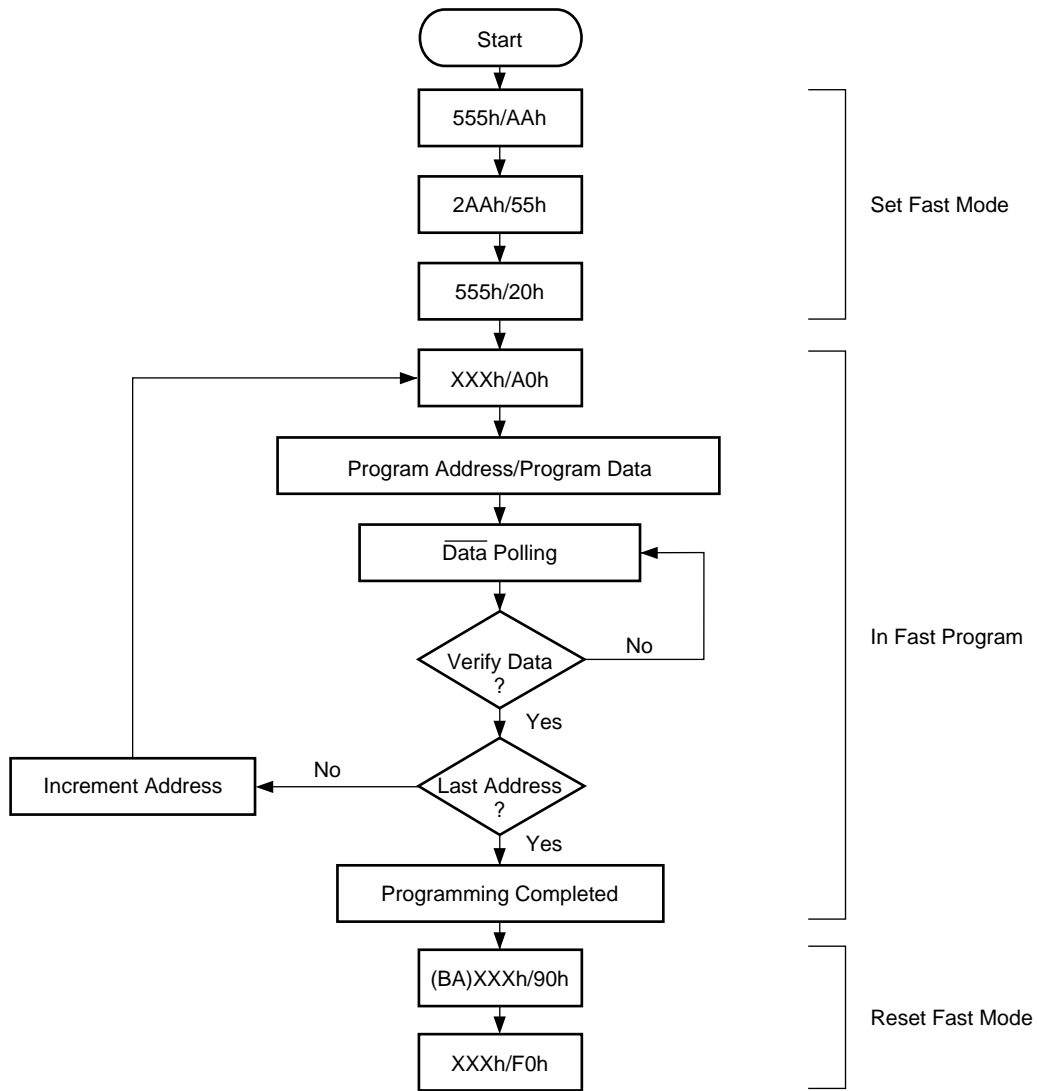
70

(8) Embedded Program™ Algorithm for Fast Mode

FAST MODE ALGORITHM

```
                    Start
                      │
                  555h/AAh            ┐
                      │               │
                  2AAh/55h            ├ Set Fast Mode
                      │               │
                  555h/20h            ┘
                      │
   ┌────────────► XXXh/A0h            ┐
   │                  │               │
   │      Program Address/Program Data│
   │                  │               │
   │            Data Polling ◄──┐     │
   │                  │         │     │
   │             Verify Data ──No─────┤ In Fast Program
   │                  ? │             │
   │                  Yes             │
   │                  │               │
Increment ◄─No─ Last Address          │
 Address            ? │               │
   │                  Yes             │
              Programming Completed    ┘
                      │
                 (BA)XXXh/90h          ┐
                      │                ├ Reset Fast Mode
                  XXXh/F0h             ┘
```

Notes: • The sequence is applied for × 16 mode.
       • The addresses differ from × 8 mode.

■ **ORDERING INFORMATION**

Part No.	Package	Access Tome	Remarks
MBM29DL161TE-70TN MBM29DL161TE-90TN	48-pin plastic TSOP (1) (FPT-48P-M19) Normal Bend	70 90	Top Sector
MBM29DL162TE-70TN MBM29DL162TE-90TN		70 90	
MBM29DL163TE-70TN MBM29DL163TE-90TN		70 90	
MBM29DL164TE-70TN MBM29DL164TE-90TN		70 90	
MBM29DL161TE-70TR MBM29DL161TE-90TR	48-pin plastic TSOP (1) (FPT-48P-M20) Reverse Bend	70 90	
MBM29DL162TE-70TR MBM29DL162TE-90TR		70 90	
MBM29DL163TE-70TR MBM29DL163TE-90TR		70 90	
MBM29DL164TE-70TR MBM29DL164TE-90TR		70 90	
MBM29DL161TE-70PBT MBM29DL161TE-90PBT	48-pin plastic FBGA (BGA-48P-M11)	70 90	
MBM29DL162TE-70PBT MBM29DL162TE-90PBT		70 90	
MBM29DL163TE-70PBT MBM29DL163TE-90PBT		70 90	
MBM29DL164TE-70PBT MBM29DL164TE-90PBT		70 90	
MBM29DL161BE-70TN MBM29DL161BE-90TN	48-pin plastic TSOP (1) (FPT-48P-M19) Normal Bend	70 90	Bottom Sector
MBM29DL162BE-70TN MBM29DL162BE-90TN		70 90	
MBM29DL163BE-70TN MBM29DL163BE-90TN		70 90	
MBM29DL164BE-70TN MBM29DL164BE-90TN		70 90	
MBM29DL161BE-70TR MBM29DL161BE-90TR	48-pin plastic TSOP (1) (FPT-48P-M20) Reverse Bend	70 90	
MBM29DL162BE-70TR MBM29DL162BE-90TR		70 90	
MBM29DL163BE-70TR MBM29DL163BE-90TR		70 90	
MBM29DL164BE-70TR MBM29DL164BE-90TR		70 90	
MBM29DL161BE-70PBT MBM29DL161BE-90PBT	48-pin plastic FBGA (BGA-48P-M11)	70 90	
MBM29DL162BE-70PBT MBM29DL162BE-90PBT		70 90	
MBM29DL163BE-70PBT MBM29DL163BE-90PBT		70 90	
MBM29DL164BE-70PBT MBM29DL164BE-90PBT		70 90	

MBM29DL16X   T   E   70   TN

PACKAGE TYPE
TN = 48-Pin Thin Small Outline Package
   (TSOP) Standard Pinout
TR = 48-Pin Thin Small Outline Package
   (TSOP) Reverse Pinout
PBT = 48-Pin Fine pitch Ball Grid Array
   Package (FBGA)

SPEED OPTION
See Product Selector Guide

DEVICE REVISION

BOOT CODE SECTOR ARCHITECTURE
T = Top sector
B = Bottom sector

DEVICE NUMBER/DESCRIPTION
MBM29DL16X
16 Mega-bit (2 M × 8-Bit or 1 M × 16-Bit) CMOS Flash Memory
3.0 V-only Read, Program, and Erase
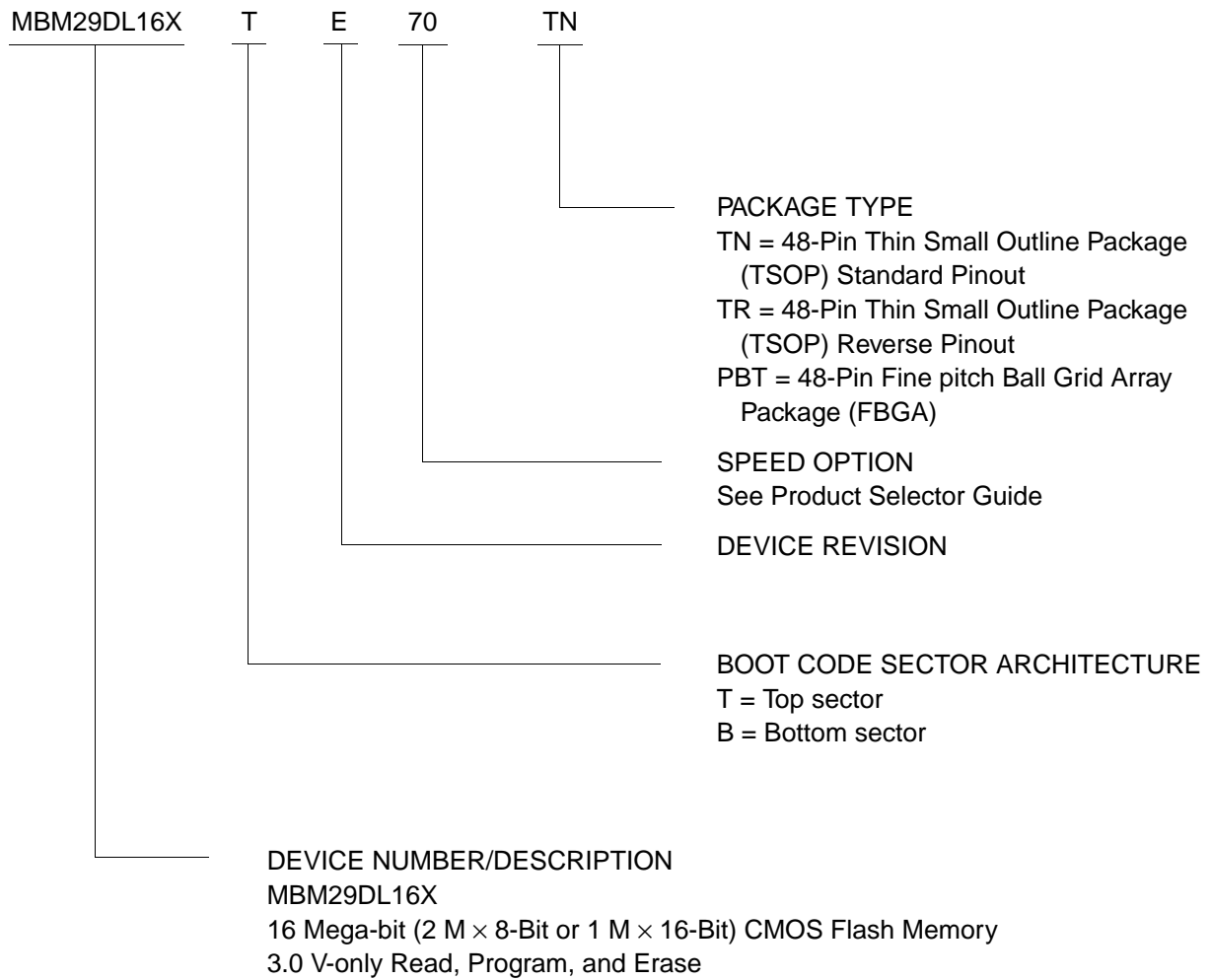
■ PACKAGE DIMENSIONS

48-pin plastic TSOP(1)
(FPT-48P-M19)

Note 1) * : Values do not include resin protrusion.
Resin protrusion and gate protrusion are +0.15 (.006) Max (each side) .
Note 2) Pins width and pins thickness include plating thickness.
Note 3) Pins width do not include tie bar cutting remainder.

LEAD No.

INDEX

Details of "A" part

0.25(.010)

0~8°

0.60±0.15
(.024±.006)

20.00±0.20
(.787±.008)

* 18.40±0.20
(.724±.008)

"A"

0.10(.004)

* 12.00±0.20
(.472±.008)

$1.10^{+0.10}_{-0.05}$
$\left(.043^{+.004}_{-.002}\right)$
(Mounting height)

0.50(.020)

0.10±0.05
(.004±.002)
(Stand off height)

$0.17^{+0.03}_{-0.08}$
$\left(.007^{+.001}_{-.003}\right)$

0.22±0.05
(.009±.002)

⊕ 0.10(.004) Ⓜ
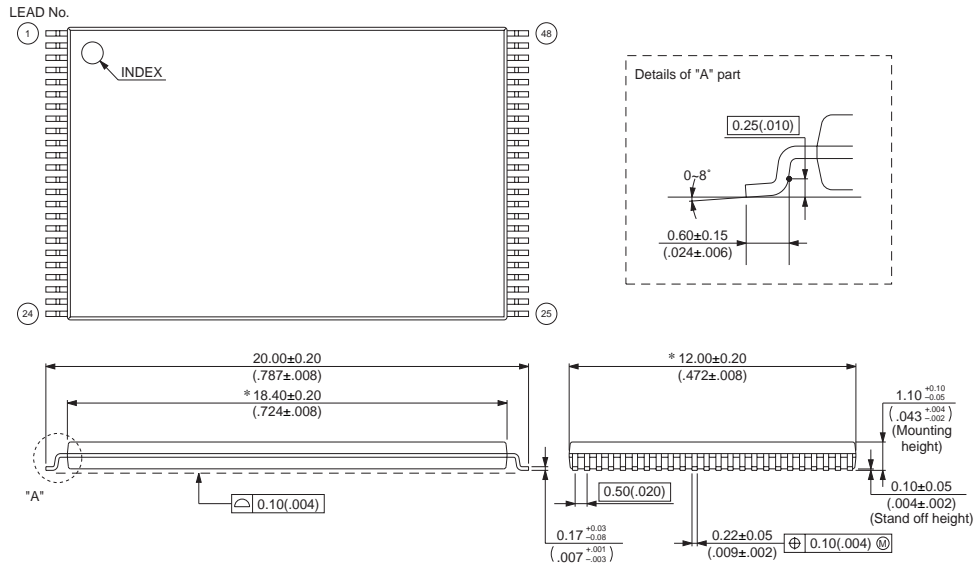
© 2003 FUJITSU LIMITED F48029S-c-6-7

Dimensions in mm (inches).
Note : The values in parentheses are reference values.

48-pin plastic TSOP(1)
(FPT-48P-M20)

Note 1) * : Values do not include resin protrusion.
Resin protrusion and gate protrusion are +0.15 (.006) Max (each side) .
Note 2) Pins width and pins thickness include plating thickness.
Note 3) Pins width do not include tie bar cutting remainder.

LEAD No.

INDEX

Details of "A" part

0.60±0.15
(.024±.006)

0~8°

0.25(.010)

$0.17^{+0.03}_{-0.08}$
$\left(.007^{+.001}_{-.003}\right)$

0.22±0.05
(.009±.002)

⊕ 0.10(.004) Ⓜ

0.50(.020)

0.10±0.05
(.004±.002)
(Stand off height)

0.10(.004)

"A"

* 18.40±0.20
(.724±.008)

20.00±0.20
(.787±.008)

* 12.00±0.20(.472±.008)

$1.10^{+0.10}_{-0.05}$
$\left(.043^{+.004}_{-.002}\right)$
(Mounting height)
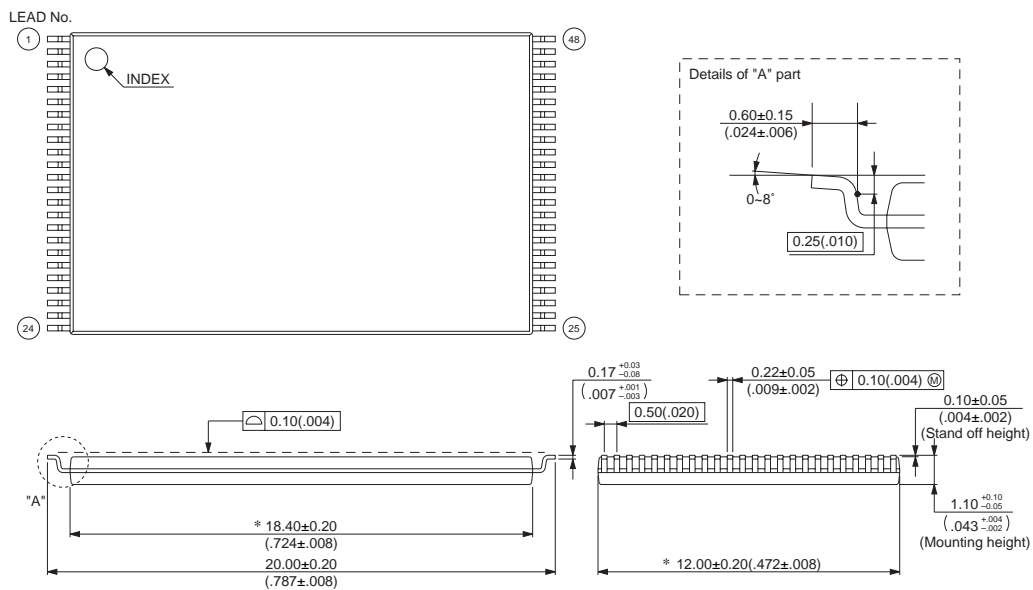
© 2003 FUJITSU LIMITED F48030S-c-6-7

Dimensions in mm (inches).
Note : The values in parentheses are reference values.

(Continued)

(Continued)

48-pin plastic FBGA
(BGA-48P-M11)

8.00±0.20(.315±.008)

INDEX

6.00±0.20
(.236±.008)

C0.25(.010)

0.10(.004)

$1.05\,^{+0.15}_{-0.10}\,(.041\,^{+.006}_{-.004})$
(Mounting height)
0.38±0.10(.015±.004)
(Stand off)

(5.60(.220))

0.80(.031)TYP

(4.00(.157))

6
5
4
3
2
1

H G F E D C B A

48-ø0.45±0.10
(48-ø.018±.004)   ø0.08(.003) Ⓜ
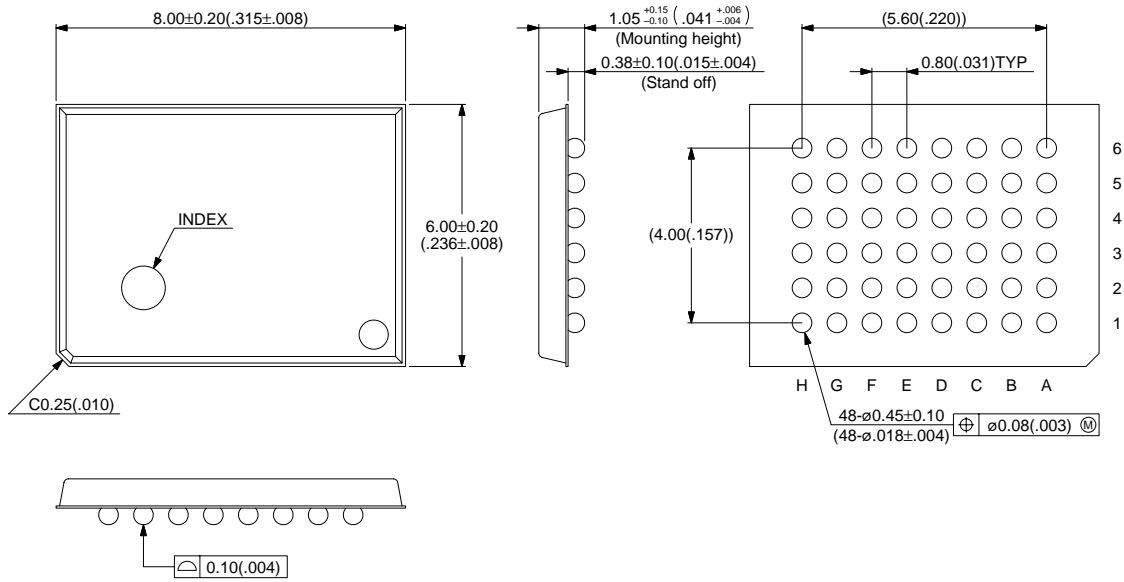
© 2001 FUJITSU LIMITED B48011S-c-5-3

Dimensions in mm (inches).
Note : The values in parentheses are reference values.

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